DSP56301 Rev. 10, 7/2006

# **DSP56301**

### 24-Bit Digital Signal Processor

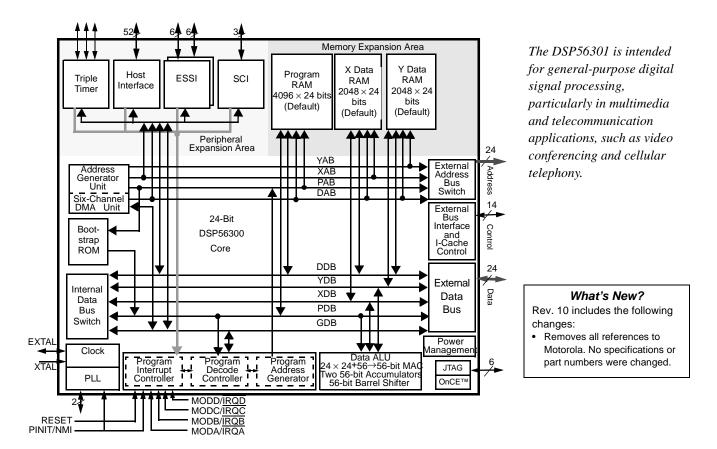


Figure 1. DSP56301 Block Diagram

The DSP56301 is a member of the DSP56300 core family of programmable CMOS Digital Signal Processors (DSPs). This family uses a high-performance, single clock cycle per instruction engine. Significant architectural features of the DSP56300 core family include a barrel shifter, 24-bit addressing, instruction cache, and DMA. The DSP56301 offers 80/100 MIPS using an internal 80/100 MHz clock at 3.0–3.6 volts. The DSP56300 core family offers a rich instruction set and low power dissipation, as well as increasing levels of speed and power, enabling wireless, telecommunications, and multimedia products.



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| OVERBAR      | Indicates a signal that is active when pulled low (For example, the RESET pin is active when low.) |   |                                    |                   |  |
|--------------|--|---|------------------------------------|-------------------|--|
| "asserted"   | Means that a high true   | e (active high) signal is l                 | nigh or that a low true (active lo | ow) signal is low |  |
| "deasserted" | Means that a high true   | e (active high) signal is l                 | low or that a low true (active lo  | w) signal is high |  |
| Examples:    | Signal/Symbol  | mal/Symbol Logic State Signal State Voltage |                                    |                   |  |
|              | PIN  | True  | Asserted                           | $V_{IL}/V_{OL}$   |  |
|              | PIN  | False                                       | Deasserted                         | $V_{IH}/V_{OH}$   |  |
|              | PIN  | True  | Asserted                           | $V_{IH}/V_{OH}$   |  |
|              | PIN  | False                                       | Deasserted                         | $V_{IL}/V_{OL}$   |  |

Note: Values for  $V_{IL}$ ,  $V_{OL}$ ,  $V_{IH}$ , and  $V_{OH}$  are defined by individual product specifications.

## **DSP56301 Features**

#### **High-Performance DSP56300 Core**

- 80/100 million instructions per second (MIPS) with a 80/100 MHz clock at 3.0-3.6 V
- Object code compatible with the DSP56000 core with highly parallel instruction set
- Data Arithmetic Logic Unit (Data ALU) with fully pipelined 24 × 24-bit parallel Multiplier-Accumulator (MAC), 56-bit parallel barrel shifter (fast shift and normalization; bit stream generation and parsing), conditional ALU instructions, and 24-bit or 16-bit arithmetic support under software control
- Program Control Unit (PCU) with Position Independent Code (PIC) support, addressing modes
  optimized for DSP applications (including immediate offsets), internal instruction cache
  controller, internal memory-expandable hardware stack, nested hardware DO loops, and fast
  auto-return interrupts
- Direct Memory Access (DMA) with six DMA channels supporting internal and external accesses; one-, two-, and three-dimensional transfers (including circular buffering); end-of-block-transfer interrupts; and triggering from interrupt lines and all peripherals
- Phase Lock Loop (PLL) allows change of low-power Divide Factor (DF) without loss of lock and output clock with skew elimination
- Hardware debugging support including On-Chip Emulation (OnCE™) module, Joint Test Action Group (JTAG) Test Access Port (TAP)

#### **Internal Peripherals**

- 32-bit parallel PCI/Universal Host Interface (HI32), PCI Rev. 2.1 compliant with glueless interface to other DSP563xx buses or ISA interface requiring only 74LS45-style buffers
- Two enhanced synchronous serial interfaces (ESSI), each with one receiver and three transmitters (allows six-channel home theater)
- Serial communications interface (SCI) with baud rate generator
- Triple timer module
- Up to forty-two programmable general-purpose input/output (GPIO) pins, depending on which peripherals are enabled

#### **Internal Memories**

- 3 K × 24-bit bootstrap ROM
- 8 K × 24-bit internal RAM total
- Program RAM, Instruction Cache, X data RAM, and Y data RAM sizes are programmable:

| Program RAM<br>Size           | Instruction Cache<br>Size | X Data RAM Size               | Y Data RAM Size               | Instruction<br>Cache | Switch<br>Mode |
|-------------------------------|---------------------------|-------------------------------|-------------------------------|----------------------|----------------|
| $4096 \times 24 \text{ bits}$ | 0                         | $2048 \times 24 \text{ bits}$ | $2048 \times 24 \text{ bits}$ | disabled             | disabled       |
| $3072 \times 24 \text{ bits}$ | $1024 \times 24$ -bit     | $2048 \times 24 \text{ bits}$ | $2048 \times 24 \text{ bits}$ | enabled              | disabled       |
| $2048 \times 24 \text{ bits}$ | 0                         | $3072 \times 24 \text{ bits}$ | $3072 \times 24 \text{ bits}$ | disabled             | enabled        |
| 1024 × 24 bits                | 1024 × 24-bit             | 3072 × 24 bits                | 3072 × 24 bits                | enabled              | enabled        |

#### **External Memory Expansion**

- Data memory expansion to two 16 M × 24-bit word memory spaces in 24-Bit mode or two 64 K × 16-bit memory spaces in 16-Bit Compatibility mode
- Program memory expansion to one 16 M  $\times$  24-bit words memory space in 24-Bit mode or 64 K  $\times$  16-bit in 16-Bit Compatibility mode
- · External memory expansion port
- Chip Select Logic for glueless interface to SRAMs
- Internal DRAM Controller for glueless interface to dynamic random access memory (DRAMs)

#### **Reduced Power Dissipation**

- Very low-power CMOS design
- Wait and Stop low-power standby modes
- Fully static design specified to operate down to 0 Hz (dc)
- Optimized power management circuitry (instruction-dependent, peripheral-dependent, and mode-dependent)

#### **Packaging**

The DSP56301 is available in a 208-pin thin quad flat pack (TQFP) or a 252-pin molded array process-ball grid array (MAP-BGA) package. Both packages are available in lead-bearing and lead-free versions.

## **Target Applications**

Examples of target applications include:

- · Wireless and wireline infrastructure applications
- Multi-channel wireless local loop systems
- · DSP resource boards
- · High-speed modem banks
- · Packet telephony

### **Product Documentation**

The three documents listed in the following table are required for a complete description of the DSP56301 and are necessary to design properly with the part. Documentation is available from the following sources. (See the back cover for detailed information.)

- A local Freescale distributor
- · A Freescale semiconductor sales office
- A Freescale Literature Distribution Center
- The World Wide Web (WWW)

Table 1. DSP56301 Documentation

| Name                       | Description   | Order Number  |
|----------------------------|---|---------------|
| DSP56300 Family<br>Manual  | Detailed description of the DSP56300 family processor core and instruction set                            | DSP56300FM/AD |
| DSP56301 User's<br>Manual  | Detailed functional description of the DSP56301 memory configuration, operation, and register programming | DSP56301UM/D  |
| DSP56301<br>Technical Data | DSP56301 features list and physical, electrical, timing, and package specifications                       | DSP56301      |

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# Signals/Connections

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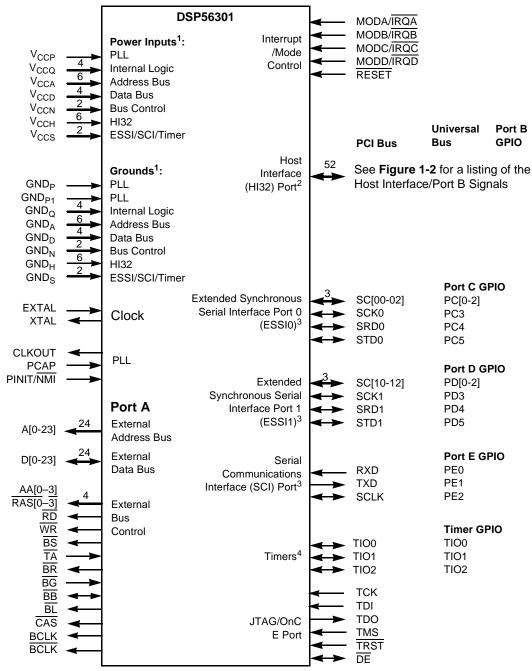
The DSP56301 input and output signals are organized into functional groups, as shown in **Table 1-1** and illustrated in **Figure 1-1**. The DSP56301 operates from a 3 V supply; however, some of the inputs can tolerate 5 V. A special notice for this feature is added to the signal descriptions of those inputs.

Table 1-1. DSP56301 Functional Signal Groupings

| Functional Group                             |                            | Signa | ber of<br>als by<br>ge Type | Detailed Description         |
|--|----------------------------|-------|-----------------------------|------------------------------|
|  |                            | TQFP  | MAP-<br>BGA                 |                              |
| Power (V <sub>CC</sub> ) <sup>1</sup>        |                            | 25    | 45                          | Table 1-2                    |
| Ground (GND) <sup>1</sup>                    |                            | 26    | 38                          | Table 1-3                    |
| Clock  |                            | 2     | 2                           | Table 1-4                    |
| PLL  |                            | 3     | 3                           | Table 1-5                    |
| Address Bus                                  | D                          | 24    | 24                          | Table 1-6                    |
| Data Bus                                     | - Port A <sup>2</sup>      | 24    | 24                          | Table 1-7                    |
| Bus Control                                  | 1                          | 15    | 15                          | Table 1-8                    |
| Interrupt and Mode Control                   | 1                          | 5     | 5                           | Table 1-9                    |
| Host Interface (HI32)                        | Port B <sup>3</sup>        | 52    | 52                          | Table 1-11                   |
| Enhanced Synchronous Serial Interface (ESSI) | Ports C and D <sup>4</sup> | 12    | 12                          | Table 1-12 and<br>Table 1-13 |
| Serial Communication Interface (SCI)         | Port E <sup>5</sup>        | 3     | 3                           | Table 1-14                   |
| Timer  |                            |       | 3                           | Table 1-15                   |
| JTAG/OnCE Port                               |                            |       | 6                           | Table 1-16                   |

#### Notes:

- The number of available power and ground signals is package-dependent. In the TQFP package specific pins are dedicated internally to device subsystems. In the MAP-BGA package, power and ground connections (except those providing PLL power) connect to internal power and ground planes, respectively.
- 2. Port A signals define the external memory interface port, including the external address bus, data bus, and control signals.
- 3. Port B signals are the HI32 port signals multiplexed with the GPIO signals.
- 4. Port C and D signals are the two ESSI port signals multiplexed with the GPIO signals.
- 5. Port E signals are the SCI port signals multiplexed with the GPIO signals.
- **6.** Each device also includes several no connect (NC) pins. The number of NC connections is package-dependent: the TQFP has 9 NCs and the MAP-BGA has 20 NCs. Do not connect any line, component, trace, or via to these pins. See **Chapter 3** for details.



- Notes: 1. Power and ground connections are shown for the TQFP package. The MAP-BGA package uses one V<sub>CCP</sub> for the PLL power input and 44 V<sub>CC</sub> pins that connect to an internal power plane. The MAP-BGA package uses two ground connections for the PLL (GND<sub>P</sub> and GND<sub>P1</sub>) and 36 GND pins that connect to an internal ground plane.
  - 2. The HI32 port supports PCI and non-PCI bus configurations. Twenty-four HI32 signals can also be configured as GPIO signals (PB[0–23]).
  - The ESSI0, ESSI1, and SCI signals are multiplexed with the Port C GPIO signals (PC[0-5]), Port D GPIO signals (PD[0-5]), and Port E GPIO signals (PE[0-2]), respectively.
  - 4. TIO[0-2] can be configured as GPIO signals.

Figure 1-1. Signals Identified by Functional Group

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|                        |          |                                   |                     | Host Port (HP) |
|------------------------|----------|-----------------------------------|---------------------|----------------|
| DSP56301               | PCI Bus  | Universal Bus                     | Port B GPIO         | Reference      |
|                        | HAD0     | HA3                               | PB0                 | HP0            |
|                        | HAD1     | HA4                               | PB1                 | HP1            |
|                        | HAD2     | HA5                               | PB2                 | HP2            |
|                        | HAD3     | HA6                               | PB3                 | HP3            |
|                        | HAD4     | HA7                               | PB4                 | HP4            |
|                        | HAD5     | HA8                               | PB5                 | HP5            |
|                        | HAD6     | HA9                               | PB6                 | HP6            |
|                        | HAD7     | HA10                              | PB7                 | HP7            |
|                        | HAD8     | HD0                               | PB8                 | HP8            |
|                        | HAD9     | HD1                               | PB9                 | HP9            |
|                        | HAD10    | HD2                               | PB10                | HP10           |
|                        | HAD11    | HD3                               | PB11                | HP11           |
|                        | HAD12    | HD4                               | PB12                | HP12           |
|                        | HAD13    | HD5                               | PB13                | HP13           |
|                        | HAD14    | HD6                               | PB14                | HP14           |
|                        | HAD15    | HD7                               | PB15                | HP15           |
|                        | HC0/HBE0 | HA0                               | PB16                | HP16           |
|                        | HC1/HBE1 | HA1                               | PB17                | HP17           |
|                        | HC2/HBE2 | HA2                               | PB18                | HP18           |
|                        | HC3/HBE3 | Tie to pull-up or V <sub>CC</sub> | PB19                | HP19           |
| Host Interface (HI32)/ | HTRDY    | HDBEN                             | PB20                | HP20           |
|                        | HIRDY    | HDBDR                             | PB21                | HP21           |
| Port B Signals         | HDEVSEL  | HSAK                              | PB22                | HP22           |
|                        | HLOCK    | HBS                               | PB23                | HP23           |
|                        | HPAR     | HDAK                              | Internal disconnect | HP24           |
|                        | HPERR    | HDRQ                              | Internal disconnect | HP25           |
|                        | HGNT     | HAEN                              | Internal disconnect | HP26           |
|                        | HREQ     | HTA                               | Internal disconnect | HP27           |
|                        | HSERR    | HIRQ                              | Internal disconnect | HP28           |
|                        | HSTOP    | HWR/HRW                           | Internal disconnect | HP29           |
|                        | HIDSEL   | HRD/HDS                           | Internal disconnect | HP30           |
|                        | HFRAME   | Tie to pull-up or V <sub>CC</sub> | Internal disconnect | HP31           |
|                        | HCLK     | Tie to pull-up or V <sub>CC</sub> | Internal disconnect | HP32           |
|                        | HAD16    | HD8                               | Internal disconnect | HP33           |
|                        | HAD17    | HD9                               | Internal disconnect | HP34           |
|                        | HAD18    | HD10                              | Internal disconnect | HP35           |
|                        | HAD19    | HD11                              | Internal disconnect | HP36           |
|                        | HAD20    | HD12                              | Internal disconnect | HP37           |
|                        | HAD21    | HD13                              | Internal disconnect | HP38           |
|                        | HAD22    | HD14                              | Internal disconnect | HP39           |
|                        | HAD23    | HD15                              | Internal disconnect | HP40           |
|                        | HAD24    | HD16                              | Internal disconnect | HP41           |
|                        | HAD25    | HD17                              | Internal disconnect | HP42           |
|                        | HAD26    | HD18                              | Internal disconnect | HP43           |
|                        | HAD27    | HD19                              | Internal disconnect | HP44           |
|                        | HAD28    | HD20                              | Internal disconnect | HP45           |
|                        | HAD29    | HD21                              | Internal disconnect | HP46           |
|                        | HAD30    | HD22                              | Internal disconnect | HP47           |
|                        | HAD31    | HD23                              | Internal disconnect | HP48           |
|                        | HRST     | HRST                              | Internal disconnect | HP49           |
| 1                      | HINTA    | HINTA                             | Internal disconnect | HP50           |
|                        | PVCL     | Leave unconnected                 | Leave unconnected   | PVCL           |

**Note:** HPxx is a reference only and is not a signal name. GPIO references formerly designated as HIOxx have been renamed PBxx for consistency with other Freescale DSPs.

Figure 1-2. Host Interface/Port B Detail Signal Diagram

1-3

# 1.1 Power

Table 1-2. Power Inputs

| Power Name       | Description   |
|------------------|---|
| V <sub>CCP</sub> | PLL Power Isolated power for the Phase Lock Loop (PLL). The voltage should be well-regulated and the input should be provided with an extremely low impedance path to the V <sub>CC</sub> power rail.                 |
| Vccq             | Quiet Power Isolated power for the internal processing logic. This input must be tied externally to all other chip power inputs. The user must provide adequate external decoupling capacitors.                       |
| V <sub>CCA</sub> | Address Bus Power Isolated power for sections of the address bus I/O drivers. This input must be tied externally to all other chip power inputs. The user must provide adequate external decoupling capacitors.       |
| V <sub>CCD</sub> | Data Bus Power Isolated power for sections of the data bus I/O drivers. This input must be tied externally to all other chip power inputs. The user must provide adequate external decoupling capacitors.             |
| V <sub>CCN</sub> | Bus Control Power Isolated power for the bus control I/O drivers. This input must be tied externally to all other chip power inputs. The user must provide adequate external decoupling capacitors.                   |
| V <sub>ССН</sub> | Host Power Isolated power for the HI32 I/O drivers. This input must be tied externally to all other chip power inputs. The user must provide adequate external decoupling capacitors.                                 |
| V <sub>ccs</sub> | ESSI, SCI, and Timer Power Isolated power for the ESSI, SCI, and timer I/O drivers. This input must be tied externally to all other chip power inputs. The user must provide adequate external decoupling capacitors. |
|                  | lesignations are package-dependent. Some packages connect all $V_{CC}$ inputs except $V_{CCP}$ to each other internally. On ackages, all power input except $V_{CCP}$ are labeled $V_{CC}$ .                          |

## 1.2 Ground

Table 1-3. Grounds

| Ground Name       | Description   |  |  |  |  |
|-------------------|---|--|--|--|--|
| GND <sub>P</sub>  | PLL Ground Ground dedicated for PLL use. The connection should be provided with an extremely low-impedance path to ground. $V_{CCP}$ should be bypassed to GND <sub>P</sub> by a 0.47 $\mu$ F capacitor located as close as possible to the chip package. |  |  |  |  |
| GND <sub>P1</sub> | PLL Ground 1 Ground dedicated for PLL use. The connection should be provided with an extremely low-impedance path to ground.  |  |  |  |  |
| GND <sub>Q</sub>  | Quiet Ground Isolated ground for the internal processing logic. This connection must be tied externally to all other chip ground connections. The user must provide adequate external decoupling capacitors.  |  |  |  |  |
| GND <sub>A</sub>  | Address Bus Ground Isolated ground for sections of the address bus I/O drivers. This connection must be tied externally to all other chip ground connections. The user must provide adequate external decoupling capacitors.                              |  |  |  |  |
| GND <sub>D</sub>  | Data Bus Ground Isolated ground for sections of the data bus I/O drivers. This connection must be tied externally to all other chip ground connections. The user must provide adequate external decoupling capacitors.                                    |  |  |  |  |

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Table 1-3. Grounds

| Ground Name      | Description   |  |  |  |  |
|------------------|---|--|--|--|--|
| GND <sub>N</sub> | Bus Control Ground Isolated ground for the bus control I/O drivers. This connection must be tied externally to all other chip ground connections. The user must provide adequate external decoupling capacitors.  |  |  |  |  |
| GND <sub>H</sub> | Host Ground Isolated ground for the HI32 I/O drivers. This connection must be tied externally to all other chip ground connections. The user must provide adequate external decoupling capacitors.  |  |  |  |  |
| GND <sub>S</sub> | ESSI, SCI, and Timer Ground Isolated ground for the ESSI, SCI, and timer I/O drivers. This connection must be tied externally to all other chip ground connections. The user must provide adequate external decoupling capacitors.                                    |  |  |  |  |
|                  | Note: These designations are package-dependent. Some packages connect all GND inputs except GND <sub>P</sub> and GND <sub>P1</sub> to each other internally. On those packages, all ground connections except GND <sub>P</sub> and GND <sub>P1</sub> are labeled GND. |  |  |  |  |

## 1.3 Clock

Table 1-4. Clock Signals

| Signal Name | Туре   | State During<br>Reset | Signal Description   |
|-------------|--------|-----------------------|--|
| EXTAL       | Input  | Input                 | External Clock/Crystal Input Interfaces the internal crystal oscillator input to an external crystal or an external clock.                   |
| XTAL        | Output | Chip-driven           | Crystal Output Connects the internal crystal oscillator output to an external crystal. If an external clock is used, leave XTAL unconnected. |

# 1.4 Phase Lock Loop (PLL)

Table 1-5.Phase Lock Loop Signals

| Signal Name | Туре   | State During<br>Reset | Signal Description   |
|-------------|--------|-----------------------|--|
| CLKOUT      | Output | Chip-driven           | Clock Output Provides an output clock synchronized to the internal core clock phase.  If the PLL is enabled and both the multiplication and division factors equal one, then CLKOUT is also synchronized to EXTAL.  If the PLL is disabled, the CLKOUT frequency is half the frequency of EXTAL. |
| PCAP        | Input  | Input                 | $ \begin{array}{c} \textbf{PLL Capacitor} \\ \textbf{Connects an off-chip capacitor to the PLL filter. Connect one capacitor terminal to PCAP and the other terminal to V_{CCP}. \\ \textbf{If the PLL is not used, PCAP can be tied to V_{CC}, GND, or left floating.} \end{array} $            |

**Table 1-5.** Phase Lock Loop Signals (Continued)

| Signal Name | Туре  | State During<br>Reset | Signal Description  |
|-------------|-------|-----------------------|---|
| PINIT/NMI   | Input | Input                 | PLL Initial/Non-Maskable Interrupt  During assertion of RESET, the value of PINIT/NMI is written into the PLL Enable (PEN) bit of the PLL control register, determining whether the PLL is enabled or disabled. After RESET deassertion and during normal instruction processing, the PINIT/NMI Schmitt-trigger input is a negative-edge-triggered Non-Maskable Interrupt (NMI) request internally synchronized to CLKOUT.  PINIT/NMI can tolerate 5 V. |

# 1.5 External Memory Expansion Port (Port A)

Note: When the DSP56301 enters a low-power stand-by mode (Stop or Wait), it releases bus mastership and tristates the relevant Port A signals: A[0–23], D[0–23], AA0/RAS0–AA3/RAS3, RD, WR, BB, CAS, BCLK, and BCLK. If hardware refresh of external DRAM is enabled, Port A exits the Wait mode to allow the refresh to occur and then returns to the Wait mode.

### 1.5.1 External Address Bus

Table 1-6. External Address Bus Signals

| Signal Name | Туре   | State During<br>Reset | Signal Description   |
|-------------|--------|-----------------------|--|
| A[0-23]     | Output | Tri-stated            | Address Bus When the DSP is the bus master, A[0–23] specify the address for external program and data memory accesses. Otherwise, the signals are tri-stated. To minimize power dissipation, A[0–23] do not change state when external memory spaces are not being accessed. |

### 1.5.2 External Data Bus

Table 1-7. External Data Bus Signals

| Signal Name | Туре         | State During<br>Reset | Signal Description  |
|-------------|--------------|-----------------------|---|
| D[0-23]     | Input/Output | Tri-stated            | <b>Data Bus</b> When the DSP is the bus master, D[0–23] provide the bidirectional data bus for external program and data memory accesses. Otherwise, D[0–23] are tristated. |

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## 1.5.3 External Bus Control

 Table 1-8.
 External Bus Control Signals

| Signal Name           | Туре   | State During<br>Reset  | Signal Description   |
|-----------------------|--------|------------------------|--|
| AA0/RAS0-<br>AA3/RAS3 | Output | Tri-stated             | Address Attribute or Row Address Strobe  As AA, these signals function as chip selects or additional address lines.  Unlike address lines, however, the AA lines do not hold their state after a read or write operation. As RAS, these signals can be used for Dynamic Random Access Memory (DRAM) interface. These signals have programmable polarity.   |
| RD                    | Output | Tri-stated             | Read Enable When the DSP is the bus master, RD is asserted to read external memory on the data bus (D[0–23]). Otherwise, RD is tri-stated.   |
| WR                    | Output | Tri-stated             | Write Enable When the DSP is the bus master, WR is asserted to write external memory on the data bus (D[0–23]). Otherwise, WR is tri-stated.   |
| TĀ                    | Input  | Ignored Input          | Transfer Acknowledge  If the DSP56301 is the bus master and there is no external bus activity, or the DSP56301 is not the bus master, the TA input is ignored. The TA input is a Data Transfer Acknowledge (DTACK) function that can extend an external bus cycle indefinitely. Any number of wait states (1, 2,, infinity) can be added to the wait states inserted by the BCR by keeping TA deasserted. In typical operation, TA is deasserted at the start of a bus cycle, asserted to enable completion of the bus cycle, and deasserted before the next bus cycle. The current bus cycle completes one clock period after TA is asserted synchronous to CLKOUT. The number of wait states is determined by the TA input or by the Bus Control Register (BCR), whichever is longer. The BCR can set the minimum number of wait states in external bus cycles.  To use the TA functionality, the BCR must be programmed to at least one wait state. A zero wait state access cannot be extended by TA deassertion; otherwise improper operation may result. TA can operate synchronously or asynchronously, depending on the setting of the TAS bit in the Operating Mode Register (OMR).  TA functionality cannot be used during DRAM-type accesses; otherwise |
| BR                    | Output | Output<br>(deasserted) | Bus Request Asserted when the DSP requests bus mastership and deasserted when the DSP no longer needs the bus. \$\overline{BR}\$ can be asserted or deasserted independently of whether the DSP56301 is a bus master or a bus slave. Bus "parking" allows \$\overline{BR}\$ to be deasserted even though the DSP56301 is the bus master (see the description of bus "parking" in the \$\overline{BB}\$ signal description). The Bus Request Hole (BRH) bit in the BCR allows \$\overline{BR}\$ to be asserted under software control, even though the DSP does not need the bus. \$\overline{BR}\$ is typically sent to an external bus arbitrator that controls the priority, parking and tenure of each master on the same external bus. \$\overline{BR}\$ is affected only by DSP requests for the external bus, never for the internal bus. During hardware reset, \$\overline{BR}\$ is deasserted and the arbitration is reset to the bus slave state.  |
| BG                    | Input  | Ignored Input          | Bus Grant Must be asserted/deasserted synchronous to CLKOUT for proper operation. An external bus arbitration circuit asserts $\overline{BG}$ when the DSP56301 becomes the next bus master. When $\overline{BG}$ is asserted, the DSP56301 must wait until $\overline{BB}$ is deasserted before taking bus mastership. When $\overline{BG}$ is deasserted, bus mastership is typically given up at the end of the current bus cycle. This may occur in the middle of an instruction that requires more than one external bus cycle for execution.   |

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#### Signals/Connections

 Table 1-8.
 External Bus Control Signals (Continued)

| Signal Name | Туре             | State During<br>Reset       | Signal Description  |
|-------------|------------------|-----------------------------|---|
| BB          | Input/<br>Output | Input                       | Bus Busy Indicates that the bus is active and must be asserted and deasserted synchronous to CLKOUT. Only after BB is deasserted can the pending bus master become the bus master (and then assert the signal again). The bus master can keep BB asserted after ceasing bus activity, regardless of whether BR is asserted or deasserted. This is called "bus parking" and allows the current bus master to reuse the bus without re-arbitration until another device requires the bus. BB is deasserted by an "active pull-up" method (that is, BB is driven high and then released and held high by an external pull-up resistor).  BB requires an external pull-up resistor.   |
| BL          | Output           | Driven high<br>(deasserted) | Bus Lock—BL is asserted at the start of an external divisible Read-Modify-Write (RMW) bus cycle, remains asserted between the read and write cycles, and is deasserted at the end of the write bus cycle. This provides an "early bus start" signal for the bus controller. BL may be used to "resource lock" an external multi-port memory for secure semaphore updates. Early deassertion provides an "early bus end" signal useful for external bus control. If the external bus is not used during an instruction cycle, BL remains deasserted until the next external indivisible RMW cycle. The only instructions that assert BL automatically are the BSET, CLR, and BCHG instructions when they are used to modify external memory. An operation can also assert BL by setting the BLH bit in the Bus Control Register. |
| CAS         | Output           | Tri-stated                  | Column Address Strobe  When the DSP is the bus master, DRAM uses CAS to strobe the column address. Otherwise, if the Bus Mastership Enable (BME) bit in the DRAM Control Register is cleared, the signal is tri-stated.   |
| BCLK        | Output           | Tri-stated                  | Bus Clock When the DSP is the bus master, BCLK is active when the OMR[ATE] is set. When BCLK is active and synchronized to CLKOUT by the internal PLL, BCLK precedes CLKOUT by one-fourth of a clock cycle.   |
| BCLK        | Output           | Tri-stated                  | Bus Clock Not When the DSP is the bus master, BCLK is the inverse of the BCLK signal. Otherwise, the signal is tri-stated.  |

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# 1.6 Interrupt and Mode Control

The interrupt and mode control signals select the chip's operating mode as it comes out of hardware reset. After RESET is deasserted, these inputs are hardware interrupt request lines.

Table 1-9. Interrupt and Mode Control

| Signal Name | Туре  | State During<br>Reset | Signal Description   |
|-------------|-------|-----------------------|--|
| MODA        | Input | Input                 | Mode Select A Selects the initial chip operating mode during hardware reset and becomes a level-sensitive or negative-edge-triggered, maskable interrupt request input IRQA during normal instruction processing. MODA, MODB, MODC, and MODD select one of sixteen initial chip operating modes, latched into the OMR when the RESET signal is deasserted.           |
| ĪRQĀ        | Input |                       | External Interrupt Request A Internally synchronized to CLKOUT. If IRQA is asserted synchronous to CLKOUT, multiple processors can be re-synchronized using the WAIT instruction and asserting IRQA to exit the Wait state. If the processor is in the Stop stand-by state and IRQA is asserted, the processor exits the Stop state.  These inputs are 5 V tolerant. |
| MODB        | Input | Input                 | Mode Select B  Selects the initial chip operating mode during hardware reset and becomes a level-sensitive or negative-edge-triggered, maskable interrupt request input IRQB during normal instruction processing. MODA, MODB, MODC, and MODD select one of sixteen initial chip operating modes, latched into the OMR when the RESET signal is deasserted.          |
| ĪRQB        | Input |                       | External Interrupt Request B Internally synchronized to CLKOUT. If IRQB is asserted synchronous to CLKOUT, multiple processors can be re-synchronized using the WAIT instruction and asserting IRQB to exit the Wait state. If the processor is in the Stop stand-by state and IRQC is asserted, the processor will exit the Stop state.                             |
|             |       |                       | These inputs are 5 V tolerant.   |
| MODC        | Input | Input                 | Mode Select C Selects the initial chip operating mode during hardware reset and becomes a level-sensitive or negative-edge-triggered, maskable interrupt request input IRQC during normal instruction processing. MODA, MODB, MODC, and MODD select one of sixteen initial chip operating modes, latched into the OMR when the RESET signal is deasserted.           |
| ĪRQC        | Input |                       | External Interrupt Request C Internally synchronized to CLKOUT. If IRQC is asserted synchronous to CLKOUT, multiple processors can be re-synchronized using the WAIT instruction and asserting IRQC to exit the Wait state. If the processor is in the Stop stand-by state and IRQC is asserted, the processor exits the Stop state.  These inputs are 5 V tolerant. |

Table 1-9. Interrupt and Mode Control (Continued)

| Signal Name | Туре  | State During<br>Reset | Signal Description   |
|-------------|-------|-----------------------|--|
| MODD        | Input | Input                 | Mode Select D Selects the initial chip operating mode during hardware reset and becomes a level-sensitive or negative-edge-triggered, maskable interrupt request input IRQD during normal instruction processing. MODA, MODB, MODC, and MODD select one of sixteen initial chip operating modes, latched into the OMR when the RESET signal is deasserted.   |
| ĪRQD        | Input |                       | External Interrupt Request D Internally synchronized to CLKOUT. If IRQD is asserted synchronous to CLKOUT, multiple processors can be re-synchronized using the WAIT instruction and asserting IRQD to exit the Wait state. If the processor is in the Stop stand-by state and IRQD is asserted, the processor exits the Stop state.  These inputs are 5 V tolerant.   |
| RESET       | Input | Input                 | Reset  Deassertion of RESET is internally synchronized to the clock out (CLKOUT). When asserted, the chip is placed in the Reset state and the internal phase generator is reset. The Schmitt-trigger input allows a slowly rising input (such as a capacitor charging) to reset the chip reliably. If RESET is deasserted synchronous to CLKOUT, exact start-up timing is guaranteed, allowing multiple processors to start synchronously and operate together in "lock-step." When the RESET signal is deasserted, the initial chip operating mode is latched from the MODA, MODB, MODC, and MODD inputs. The RESET signal must be asserted after power-up.  This input is 5 V tolerant. |

# 1.7 Host Interface (HI32)

The Host Interface (HI32) provides fast parallel data to a 32-bit port directly connected to the host bus. The HI32 supports a variety of standard buses and directly connects to a PCI bus and a number of industry-standard microcomputers, microprocessors, DSPs, and DMA hardware.

### 1.7.1 Host Port Usage Considerations

Careful synchronization is required when the system reads multiple-bit registers that are written by another asynchronous system. This is a common problem when two asynchronous systems are connected (as they are in the Host port). The considerations for proper operation are discussed in **Table 1-10**.

Table 1-10. Host Port Usage Considerations

| Action  | Description   |
|---|---|
| Asynchronous read of receive byte registers   | When reading the receive byte registers, Receive register High (RXH), Receive register Middle (RXM), or Receive register Low (RXL), use interrupts or poll the Receive register Data Full (RXDF) flag that indicates data is available. This assures that the data in the receive byte registers is valid.  |
| Asynchronous write to transmit byte registers | Do not write to the transmit byte registers, Transmit register High (TXH), Transmit register Middle (TXM), or Transmit register Low (TXL), unless the Transmit register Data Empty (TXDE) bit is set, indicating that the transmit byte registers are empty. This guarantees that the transmit byte registers transfer valid data to the Host Receive (HRX) register. |

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Table 1-10. Host Port Usage Considerations (Continued)

| Action                            | Description  |
|-----------------------------------|--|
| Asynchronous write to host vector | Change the Host Vector (HV) register only when the Host Command bit (HC) is clear. This practice guarantees that the DSP interrupt control logic receives a stable vector. |

## 1.7.2 Host Port Configuration

HI32 signal functions vary according to the programmed configuration of the interface as determined by the 24-bit DSP Control Register (DCTR). Refer to the DSP56301 User's Manual for details on HI32 configuration registers.

Table 1-11. Host Interface

| Signal Name          | Туре            | State During<br>Reset | Signal Description   |
|----------------------|-----------------|-----------------------|--|
| HAD[0-7]             | Input/Output    | Tri-stated            | Host Address/Data 0–7 When the HI32 is programmed to interface with a PCI bus and the HI function is selected, these signals are lines 0–7 of the Address/Data bus.        |
| HA[3–10]             | Input           |                       | Host Address 3–10 When HI32 is programmed to interface with a universal, non-PCI bus and the HI function is selected, these signals are lines 3–10 of the Address bus.     |
| PB[0-7]              | Input or Output |                       | Port B 0–7 When the HI32 is configured as GPIO through the DCTR, these signals are individually programmed through the HI32 Data Direction Register (DIRH).                |
| 1                    |                 |                       | These inputs are 5 V tolerant.   |
| HAD[8–15]            | Input/Output    | Tri-stated            | Host Address/Data 8–15 When the HI32 is programmed to interface with a PCI bus and the HI function is selected, these signals are lines 8–15 of the Address/Data bus.      |
| HD[0-7]              | Input/Output    |                       | Host Data 0–7 When HI32 is programmed to interface with a universal non-PCI bus and the HI function is selected, these signals are lines 0–7 of the Data bus.              |
| PB[8–15]             | Input or Output |                       | Port B 8–15 When the Hl32 is configured as GPIO through the DCTR, these signals are individually programmed through the Hl32 DIRH.   |
|                      |                 |                       | These inputs are 5 V tolerant.   |
| HC[0-3]/<br>HBE[0-3] | Input/Output    | Tri-stated            | Command 0-3/Byte Enable 0-3  When the HI32 is programmed to interface with a PCI bus and the HI function is selected, these signals are lines 0-7 of the Address/Data bus. |
| HA[0-2]              | Input           |                       | Host Address 0–2 When HI32 is programmed to interface with a universal, non-PCI bus and the HI function is selected, these signals are lines 0–2 of the Address bus.       |
|                      |                 |                       | The fourth signal in this set should connect to a pull-up resistor or directly to $V_{CC}$ when a non-PCI bus is used.   |
| PB[16–19]            | Input or Output |                       | Port B 16–19 When the Hl32 is configured as GPIO through the DCTR, these signals are individually programmed through the Hl32 DIRH.  |
|                      |                 |                       | These inputs are 5 V tolerant.   |

Table 1-11. Host Interface (Continued)

| Signal Name | Туре             | State During<br>Reset | Signal Description  |
|-------------|------------------|-----------------------|---|
| HTRDY       | Input/<br>Output | Tri-stated            | Host Target Ready When the HI32 is programmed to interface with a PCI bus and the HI function is selected, this is the Host Target Ready signal.                        |
| HDBEN       | Output           |                       | Host Data Bus Enable When HI32 is programmed to interface with a universal, non-PCI bus and the HI function is selected, this is the Host Data Bus Enable signal.       |
| PB20        | Input or Output  |                       | Port B 20 When the HI32 is configured as GPIO through the DCTR, this signal is individually programmed through the HI32 DIRH.   |
|             |                  |                       | This input is 5 V tolerant.   |
| HIRDY       | Input/<br>Output | Tri-stated            | Host Initiator Ready When the HI32 is programmed to interface with a PCI bus and the HI function is selected, this is the Host Initiator Ready signal.                  |
| HDBDR       | Output           |                       | Host Data Bus Direction When HI32 is programmed to interface with a universal, non-PCI bus and the HI function is selected, this is the Host Data Bus Direction signal. |
| PB21        | Input or Output  |                       | Port B 21 When the HI32 is configured as GPIO through the DCTR, this signal is individually programmed through the HI32 DIRH.   |
|             |                  |                       | This input is 5 V tolerant.   |
| HDEVSEL     | Input/<br>Output | Tri-stated            | Host Device Select When the HI32 is programmed to interface with a PCI bus and the HI function is selected, this is the Host Device Select signal.                      |
| HSAK        | Output           |                       | Host Select Acknowledge When HI32 is programmed to interface with a universal, non-PCI bus and the HI function is selected, this is the Host Select Acknowledge signal. |
| PB22        | Input or Output  |                       | Port B 22 When the HI32 is configured as GPIO through the DCTR, this signal is individually programmed through the HI32 DIRH.   |
|             |                  |                       | This input is 5 V tolerant.   |
| HLOCK       | Input            | Tri-stated            | Host Lock When the HI32 is programmed to interface with a PCI bus and the HI function is selected, this is the Host Lock signal.  |
| HBS         | Input            |                       | Host Bus Strobe When Hl32 is programmed to interface with a universal, non-PCI bus and the HI function is selected, this is the Host Bus Strobe Schmitt-trigger signal. |
| PB23        | Input or Output  |                       | Port B 23  When the Hl32 is configured as GPIO through the DCTR, this signal is individually programmed through the Hl32 DIRH.  |
|             |                  |                       | This input is 5 V tolerant.   |

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Table 1-11. Host Interface (Continued)

| Signal Name | Туре             | State During<br>Reset | Signal Description   |
|-------------|------------------|-----------------------|--|
| HPAR        | Input/<br>Output | Tri-stated            | Host Parity When the HI32 is programmed to interface with a PCI bus and the HI function is selected, this is the Host Parity signal.   |
| HDAK        | Input            |                       | Host DMA Acknowledge When HI32 is programmed to interface with a universal, non-PCI bus and the HI function is selected, this is the Host DMA Acknowledge Schmitt-trigger signal.  |
|             |                  |                       | Port B When the HI32 is configured as GPIO through the DCTR, this signal is internally disconnected.   |
|             |                  |                       | This input is 5 V tolerant.  |
| HPERR       | Input/<br>Output | Tri-stated            | Host Parity Error When the Hl32 is programmed to interface with a PCI bus and the HI function is selected, this is the Host Parity Error signal.   |
| HDRQ        | Output           |                       | Host DMA Request When HI32 is programmed to interface with a universal, non-PCI bus and the HI function is selected, this is the Host DMA Request output.  |
|             |                  |                       | Port B When the HI32 is configured as GPIO through the DCTR, this signal is internally disconnected.   |
|             |                  |                       | This input is 5 V tolerant.  |
| HGNT        | Input            | Input                 | Host Bus Grant When the HI32 is programmed to interface with a PCI bus and the HI function is selected, this is the Host Bus Grant signal.   |
| HAEN        | Input            |                       | Host Address Enable When HI32 is programmed to interface with a universal, non-PCI bus and the HI function is selected, this is the Host Address Enable output signal.   |
|             |                  |                       | Port B When the HI32 is configured as GPIO through the DCTR, this signal is internally disconnected.   |
|             |                  |                       | This input is 5 V tolerant.  |
| HREQ        | Output           | Tri-stated            | Host Bus Request When the Hl32 is programmed to interface with a PCI bus and the HI function is selected, this is the Host Bus Request signal.   |
| HTA         | Output           |                       | Host Transfer Acknowledge—When HI32 is programmed to interface with a universal, non-PCI bus and the HI function is selected, this is the Host Data Bus Enable signal. HTA can be programmed as active high or active low. |
|             |                  |                       | Port B When the HI32 is configured as GPIO through the DCTR, this signal is internally disconnected.   |
|             |                  |                       | This input is 5 V tolerant.  |

Table 1-11. Host Interface (Continued)

| Signal Name | Туре                  | State During<br>Reset | Signal Description   |
|-------------|-----------------------|-----------------------|--|
| HSERR       | Output, open drain    | Tri-stated            | Host System Error When the HI32 is programmed to interface with a PCI bus and the HI function is selected, this is the Host System Error signal.   |
| HIRQ        | Output, open<br>drain |                       | Host Interrupt Request When HI32 is programmed to interface with a universal, non-PCI bus and the HI function is selected, this is the Host Interrupt Request signal.                                |
|             |                       |                       | Port B When the HI32 is configured as GPIO through the DCTR, this signal is internally disconnected.   |
|             |                       |                       | This input is 5 V tolerant.  |
| HSTOP       | Input/<br>Output      | Tri-stated            | Host Stop When the HI32 is programmed to interface with a PCI bus and the HI function is selected, this is the Host Stop signal.   |
| HWR/HRW     | Input                 |                       | Host Write/Host Read-Write When HI32 is programmed to interface with a universal, non-PCI bus and the HI function is selected, this is the Host Write/Host Read-Write Schmitt-trigger signal.        |
|             |                       |                       | Port B When the HI32 is configured as GPIO through the DCTR, this signal is internally disconnected.   |
|             |                       |                       | This input is 5 V tolerant.  |
| HIDSEL      | Input                 | Input                 | Host Initialization Device Select When the HI32 is programmed to interface with a PCI bus and the HI function is selected, this is the Host Initialization Device Select signal.                     |
| HRD/HDS     | Input                 |                       | Host Read/Host Data Strobe When HI32 is programmed to interface with a universal, non-PCI bus and the HI function is selected, this is the Host Data Read/Host Data Strobe Schmitt-trigger signal.   |
|             |                       |                       | Port B When the HI32 is configured as GPIO through the DCTR, this signal is internally disconnected.   |
|             |                       |                       | This input is 5 V tolerant.  |
| HFRAME      | Input/<br>Output      | Tri-stated            | Host Frame When the HI32 is programmed to interface with a PCI bus and the HI function is selected, this is the Host cycle Frame signal.   |
|             |                       |                       | Non-PCI bus When HI32 is programmed to interface with a universal, non-PCI bus and the HI function is selected, this signal must be connected to a pull-up resistor or directly to V <sub>CC</sub> . |
|             |                       |                       | Port B When the HI32 is configured as GPIO through the DCTR, this signal is internally disconnected.   |
|             |                       |                       | This input is 5 V tolerant.  |

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Table 1-11. Host Interface (Continued)

| Signal Name | Туре               | State During<br>Reset | Signal Description   |
|-------------|--------------------|-----------------------|--|
| HCLK        | Input              | Input                 | Host Clock When the HI32 is programmed to interface with a PCI bus and the HI function is selected, this is the Host Bus Clock input.  |
|             |                    |                       | Non-PCI bus When HI32 is programmed to interface a universal non-PCI bus and the HI function is selected, this signal must be connected to a pull-up resistor or directly to V <sub>CC</sub> .   |
|             |                    |                       | Port B When the HI32 is configured as GPIO through the DCTR, this signal is internally disconnected.   |
|             |                    |                       | This input is 5 V tolerant.  |
| HAD[16-31]  | Input/Output       | Tri-stated            | Host Address/Data 16–31 When the HI32 is programmed to interface with a PCI bus and the HI function is selected, these signals are lines 16–31 of the Address/Data bus.  |
| HD[8-23]    | Input/Output       |                       | Host Data 8–23 When HI32 is programmed to interface with a universal, non-PCI bus and the HI function is selected, these signals are lines 8–23 of the Data bus.   |
|             |                    |                       | Port B When the HI32 is configured as GPIO through the DCTR, these signals are internally disconnected.  |
|             |                    |                       | These inputs are 5 V tolerant.   |
| HRST        | Input              | Tri-stated            | Hardware Reset When the HI32 is programmed to interface with a PCI bus and the HI function is selected, this is the Hardware Reset input.  |
| HRST        | Input              |                       | Hardware Reset When HI32 is programmed to interface with a universal, non-PCI bus and the HI function is selected, this is the Hardware Reset Schmitt-trigger signal.  |
|             |                    |                       | Port B When the HI32 is configured as GPIO through the DCTR, this signal is internally disconnected.   |
|             |                    |                       | This input is 5 V tolerant.  |
| HINTA       | Output, open drain | Tri-stated            | Host Interrupt A When the HI function is selected, this signal is the Interrupt A open-drain output.   |
|             |                    |                       | Port B When the HI32 is configured as GPIO through the DCTR, this signal is internally disconnected.   |
|             |                    |                       | This input is 5 V tolerant.  |
| PVCL        | Input              | Input                 | PCI Voltage Clamp When the HI32 is programmed to interface with a PCI bus and the HI function is selected and the PCI bus uses a 3 V signal environment, connect this pin to $V_{CC}$ (3.3 V) to enable the high voltage clamping required by the PCI specifications. In all other cases, including a 5 V PCI signal environment, leave the input unconnected. |

# 1.8 Enhanced Synchronous Serial Interface 0 (ESSI0)

Two synchronous serial interfaces (ESSI0 and ESSI1) provide a full-duplex serial port for serial communication with a variety of serial devices, including one or more industry-standard codecs, other DSPs, microprocessors, and peripherals that implement the Serial Peripheral Interface (SPI).

 Table 1-12.
 Enhanced Synchronous Serial Interface 0 (ESSI0)

| Signal Name | Туре            | State During<br>Reset | Signal Description   |  |  |  |
|-------------|-----------------|-----------------------|--|--|--|--|
| SC00        | Input or Output | Input                 | Serial Control 0 Functions in either Synchronous or Asynchronous mode. For Asynchronous mode, this signal is the receive clock I/O (Schmitt-trigger input). For Synchronous mode, this signal is either for Transmitter 1 output or Serial I/O Flag 0.   |  |  |  |
| PC0         |                 |                       | Port C 0 The default configuration following reset is GPIO. For PC0, signal direction is controlled through the Port Directions Register (PRR0). The signal can be configured as ESSI signal SC00 through the Port Control Register (PCR0).  This input is 5 V tolerant.   |  |  |  |
| SC01        | Input/Output    | Input                 | Serial Control 1 Functions in either Synchronous or Asynchronous mode. For Asynchronous mode, this signal is the receiver frame sync I/O. For Synchronous mode, this signal is either Transmitter 2 output or Serial I/O Flag 1.   |  |  |  |
| PC1         | Input or Output |                       | Port C 1 The default configuration following reset is GPIO. For PC1, signal direction is controlled through PRR0. The signal can be configured as an ESSI signal SC01 through PCR0.  This input is 5 V tolerant.   |  |  |  |
| SC02        | Input/Output    | Input                 | Serial Control Signal 2 The frame sync for both the transmitter and receiver in Synchronous mode, and for the transmitter only in Asynchronous mode. When configured as an output, this signal is the internally generated frame sync signal. When configured as an input, this signal receives an external frame sync signal for the transmitter (and the receiver in synchronous operation). |  |  |  |
| PC2         | Input or Output |                       | Port C 2 The default configuration following reset is GPIO. For PC2, signal direction is controlled through PRR0. The signal can be configured as an ESSI signal SC02 through PCR0.  |  |  |  |
|             |                 |                       | This input is 5 V tolerant.  |  |  |  |

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#### Enhanced Synchronous Serial Interface 0 (ESSI0)

 Table 1-12.
 Enhanced Synchronous Serial Interface 0 (ESSI0) (Continued)

| Signal Name | Туре            | State During<br>Reset | Signal Description  |
|-------------|-----------------|-----------------------|---|
| SCK0        | Input/Output    | Input                 | Serial Clock Provides the serial bit rate clock for the ESSI interface for both the transmitter and receiver in Synchronous modes, or the transmitter only in Asynchronous modes.   |
|             |                 |                       | Although an external serial clock can be independent of and asynchronous to the DSP system clock, it must exceed the minimum clock cycle time of 6 T (that is, the system clock frequency must be at least three times the external ESSI clock frequency). The ESSI needs at least three DSP phases inside each half of the serial clock. |
| PC3         | Input or Output |                       | Port C 3 The default configuration following reset is GPIO. For PC3, signal direction is controlled through PRR0. The signal can be configured as an ESSI signal SCK0 through PCR0.   |
|             |                 |                       | This input is 5 V tolerant.   |
| SRD0        | Input/Output    | Input                 | Serial Receive Data Receives serial data and transfers the data to the ESSI receive shift register. SRD0 is an input when data is being received.   |
| PC4         | Input or Output |                       | Port C 4 The default configuration following reset is GPIO. For PC4, signal direction is controlled through PRR0. The signal can be configured as an ESSI signal SRD0 through PCR0.   |
|             |                 |                       | This input is 5 V tolerant.   |
| STD0        | Input/Output    | Input                 | Serial Transmit Data Transmits data from the serial transmit shift register. STD0 is an output when data is being transmitted.  |
| PC5         | Input or Output |                       | Port C 5 The default configuration following reset is GPIO. For PC5, signal direction is controlled through PRR0. The signal can be configured as an ESSI signal STD0 through PCR0.   |
|             |                 |                       | This input is 5 V tolerant.   |

# 1.9 Enhanced Synchronous Serial Interface 1 (ESSI1)

Table 1-13. Enhanced Synchronous Serial Interface 1 (ESSI1)

| Signal Name | Туре            | State During<br>Reset | Signal Description   |  |  |  |
|-------------|-----------------|-----------------------|--|--|--|--|
| SC10        | Input or Output | Input                 | Serial Control 0 Selection of Synchronous or Asynchronous mode determines function. For Asynchronous mode, this signal is the receive clock I/O (Schmitt-trigger input). For Synchronous mode, this signal is either Transmitter 1 output or Serial I/O Flag 0.  |  |  |  |
| PD0         |                 |                       | Port D 0  The default configuration following reset is GPIO. For PD0, signal direction is controlled through the Port Directions Register (PRR1). The signal can be configured as an ESSI signal SC10 through the Port Control Register (PCR1).  |  |  |  |
|             |                 |                       | This input is 5 V tolerant.  |  |  |  |
| SC11        | Input/Output    | Input                 | Serial Control 1 Selection of Synchronous or Asynchronous mode determines function. For Asynchronous mode, this signal is the receiver frame sync I/O. For Synchronous mode, this signal is either Transmitter 2 output or Serial I/O Flag 1.  |  |  |  |
| PD1         | Input or Output |                       | Port D 1  The default configuration following reset is GPIO. For PD1, signal direction is controlled through PRR1. The signal can be configured as an ESSI signal SC11 through PCR1.   |  |  |  |
|             |                 |                       | This input is 5 V tolerant.  |  |  |  |
| SC12        | Input/Output    | Input                 | Serial Control Signal 2 Frame sync for both the transmitter and receiver in Synchronous mode, for the transmitter only in Asynchronous mode. When configured as an output, this signal is the internally generated frame sync signal. When configured as an input, this signal receives an external frame sync signal for the transmitter (and the receiver in Synchronous operation). |  |  |  |
| PD2         | Input or Output |                       | Port D 2 The default configuration following reset is GPIO. For PD2, signal direction is controlled through PRR1. The signal can be configured as an ESSI signal SC12 through PCR1.  This input is 5 V tolerant.   |  |  |  |
| SCK1        | Input/Output    | Input                 | Serial Clock Provides the serial bit rate clock for the ESSI interface. Clock input or output can be used by the transmitter and receiver in Synchronous modes, by the transmitter only in Asynchronous modes.   |  |  |  |
|             |                 |                       | Although an external serial clock can be independent of and asynchronous to the DSP system clock, it must exceed the minimum clock cycle time of 6T (that is, the system clock frequency must be at least three times the external ESSI clock frequency). The ESSI needs at least three DSP phases inside each half of the serial clock.   |  |  |  |
| PD3         | Input or Output |                       | Port D 3 The default configuration following reset is GPIO. For PD3, signal direction is controlled through PRR1. The signal can be configured as an ESSI signal SCK1 through PCR1.  |  |  |  |
|             |                 |                       | This input is 5 V tolerant.  |  |  |  |

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Table 1-13. Enhanced Synchronous Serial Interface 1 (ESSI1) (Continued)

| Туре            | State During<br>Reset                     | Signal Description   |  |  |  |
|-----------------|---|--|--|--|--|
| Input/Output    | Input                                     | Serial Receive Data  Receives serial data and transfers it to the ESSI receive shift register. SRD1 is an input when data is being received.   |  |  |  |
| Input or Output |   | Port D 4 The default configuration following reset is GPIO. For PD4, signal direction is controlled through PRR1. The signal can be configured as an ESSI signal SRD1 through PCR1.  This input is 5 V tolerant. |  |  |  |
| Input/Output    | Input                                     | Serial Transmit Data Transmits data from the serial transmit shift register. STD1 is an output when data is being transmitted.   |  |  |  |
| Input or Output |   | Port D 5 The default configuration following reset is GPIO. For PD5, signal direction is controlled through PRR1. The signal can be configured as an ESSI signal STD1 through PCR1.  This input is 5 V tolerant. |  |  |  |
|                 | Input/Output Input or Output Input/Output | Input/Output Input Input or Output Input/Output Input  |  |  |  |

# 1.10 Serial Communication Interface (SCI)

The Serial Communication interface (SCI) provides a full duplex port for serial communication with other DSPs, microprocessors, or peripherals such as modems.

Table 1-14. Serial Communication Interface (SCI)

| Signal Name | Туре            | State During<br>Reset | Signal Description   |
|-------------|-----------------|-----------------------|--|
| RXD         | Input           | Input                 | Serial Receive Data Receives byte-oriented serial data and transfers it to the SCI receive shift register.   |
| PE0         | Input or Output |                       | Port E 0 The default configuration following reset is GPIO. When configured as PEO, signal direction is controlled through the SCI Port Directions Register (PRR). The signal can be configured as an SCI signal RXD through the SCI Port Control Register (PCR).  This input is 5 V tolerant. |
| TXD         | Output          | Input                 | Serial Transmit Data Transmits data from SCI transmit data register.   |
| PE1         | Input or Output |                       | Port E 1 The default configuration following reset is GPIO. When configured as PE1, signal direction is controlled through the SCI PRR. The signal can be configured as an SCI signal TXD through the SCI PCR.   |
|             |                 |                       | This input is 5 V tolerant.  |

Table 1-14. Serial Communication Interface (SCI) (Continued)

| Signal Name | Туре            | State During<br>Reset | Signal Description  |  |
|-------------|-----------------|-----------------------|---|--|
| SCLK        | Input/Output    | Input                 | Serial Clock Provides the input or output clock used by the transmitter and/or the receiver.  |  |
| PE2         | Input or Output |                       | Port E 2 The default configuration following reset is GPIO. For PE2, signal direction is controlled through the SCI PRR. The signal can be configured as an SCI signal SCLK through the SCI PCR.  This input is 5 V tolerant. |  |

## 1.11 Timers

The DSP56301 has three identical and independent timers. Each can use internal or external clocking, interrupt the DSP56301 after a specified number of events (clocks), or signal an external device after counting a specific number of internal events.

 Table 1-15.
 Triple Timer Signals

| Signal Name | Туре            | State During<br>Reset | Signal Description  |
|-------------|-----------------|-----------------------|---|
| TIO0        | Input or Output | Input                 | Timer 0 Schmitt-Trigger Input/Output As an external event counter or in Measurement mode, TIO0 is input. In Watchdog, Timer, or Pulse Modulation mode, TIO0 is output.  The default mode after reset is GPIO input. This can be changed to output or configured as a Timer Input/Output through the Timer 0 Control/Status Register (TCSR0).  This input is 5 V tolerant. |
| TIO1        | Input or Output | Input                 | Timer 1 Schmitt-Trigger Input/Output As an external event counter or in Measurement mode, TIO1 is input. In Watchdog, Timer, or Pulse Modulation mode, TIO1 is output.  The default mode after reset is GPIO input. This can be changed to output or configured as a Timer Input/Output through the Timer 1 Control/Status Register (TCSR1).  This input is 5 V tolerant. |
| TIO2        | Input or Output | Input                 | Timer 2 Schmitt-Trigger Input/Output As an external event counter or in Measurement mode, TIO2 is input. In Watchdog, Timer, or Pulse Modulation mode, TIO2 is output.  The default mode after reset is GPIO input. This can be changed to output or configured as a Timer Input/Output through the Timer 2 Control/Status Register (TCSR2).  This input is 5 V tolerant. |

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# 1.12 JTAG/OnCE Interface

Table 1-16. JTAG/OnCE Interface

| Signal Name | Туре         | State During<br>Reset | Signal Description   |  |  |  |  |
|-------------|--------------|-----------------------|--|--|--|--|--|
| TCK         | Input        | Input                 | Test Clock A test clock signal for synchronizing JTAG test logic. This input is 5 V tolerant.  |  |  |  |  |
| TDI         | Input        | Input                 | Test Data Input A test data serial signal for test instructions and data. TDI is sampled on the rising edge of TCK and has an internal pull-up resistor.  This input is 5 V tolerant.  |  |  |  |  |
| TDO         | Output       | Tri-stated            | Test Data Output A test data serial signal for test instructions and data. TDO can be tri-stated. The signal is actively driven in the shift-IR and shift-DR controller states and changes on the falling edge of TCK.  This input is 5 V tolerant.  |  |  |  |  |
| TMS         | Input        | Input                 | Test Mode Select Sequences the test controller's state machine, is sampled on the rising edge of TCK, and has an internal pull-up resistor.  This input is 5 V tolerant.   |  |  |  |  |
| TRST        | Input        | Input                 | Test Reset Asynchronously initializes the test controller, has an internal pull-up resistor, and must be asserted after power up. This input is 5 V tolerant.  |  |  |  |  |
| DE          | Input/Output | Input                 | Debug Event Provides a way to enter Debug mode from an external command controller (as input) or to acknowledge that the chip has entered Debug mode (as output). When asserted as an input, DE causes the DSP56300 core to finish the current instruction, save the instruction pipeline information, enter Debug mode, and wait for commands from the debug serial input line. When a debug request or a breakpoint condition causes the <a href="chip">chip</a> to enter Debug mode, DE is asserted as an output for three clock cycles. DE has an internal pull-up resistor. |  |  |  |  |
|             |              |                       | DE is not a standard part of the JTAG Test Access Port (TAP) Controller. It connects to the OnCE module to initiate Debug mode directly or to provide a direct external indication that the chip has entered the Debug mode. All other interface with the OnCE module must occur through the JTAG port.  |  |  |  |  |
|             |              |                       | This input is 5 V tolerant.  |  |  |  |  |

Signals/Connections

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Specifications 2

The DSP56301 is fabricated in high-density CMOS with Transistor-Transistor Logic (TTL) compatible inputs and outputs.

# 2.1 Maximum Ratings

#### **CAUTION**

This device contains circuitry protecting against damage due to high static voltage or electrical fields; however, normal precautions should be taken to avoid exceeding maximum voltage ratings. Reliability is enhanced if unused inputs are tied to an appropriate logic voltage level (for example, either GND or V<sub>CC</sub>).

**Note:** In the calculation of timing requirements, adding a maximum value of one specification to a minimum value of another specification does not yield a reasonable sum. A maximum specification is calculated using a worst case variation of process parameter values in one direction. The minimum specification is calculated using the worst case for the same parameters in the opposite direction. Therefore, a "maximum" value for a specification never occurs in the same device that has a "minimum" value for another specification; adding a maximum to a minimum represents a condition that can never exist.

## 2.2 Absolute Maximum Ratings

Table 2-1. Maximum Ratings

| Rating <sup>1</sup>   | Symbol           | Value <sup>1, 2</sup>               | Unit |
|---|------------------|-------------------------------------|------|
| Supply Voltage  | V <sub>CC</sub>  | -0.3 to +4.0                        | V    |
| All input voltages excluding "5 V tolerant" inputs <sup>3</sup> | V <sub>IN</sub>  | GND – 0.3 to V <sub>CC</sub> + 0.3  | V    |
| All "5 V tolerant" input voltages <sup>3</sup>                  | V <sub>IN5</sub> | GND – 0.3 to V <sub>CC</sub> + 3.95 | V    |
| Current drain per pin excluding V <sub>CC</sub> and GND         | I                | 10                                  | mA   |
| Operating temperature range                                     | TJ               | -40 to +100                         | °C   |
| Storage temperature   | T <sub>STG</sub> | -55 to +150                         | °C   |

Notes:

- 1. GND = 0 V,  $V_{CC}$  = 3.3 V ± 0.3 V,  $T_{J}$  = -40°C to +100°C, CL = 50 pF
- 2. Absolute maximum ratings are stress ratings only, and functional operation at the maximum is not guaranteed. Stress beyond the maximum rating may affect device reliability or cause permanent damage to the device.
- 3. CAUTION: All "5 V Tolerant" input voltages cannot be more than 3.95 V greater than the supply voltage; this restriction applies to "power on," as well as during normal operation. In any case, the input voltages must not be higher than 5.75 V. "5 V Tolerant" inputs are inputs that tolerate 5 V.

### 2.3 Thermal Characteristics

Table 2-2. Thermal Characteristics

| Characteristic                                      | Symbol                           | TQFP<br>Value | PBGA <sup>3</sup><br>Value | PBGA <sup>4</sup><br>Value | Unit |
|---|----------------------------------|---------------|----------------------------|----------------------------|------|
| Junction-to-ambient thermal resistance <sup>1</sup> | $R_{\theta JA}$ or $\theta_{JA}$ | 49.5          | 48.4                       | 25.2                       | °C/W |
| Junction-to-case thermal resistance <sup>2</sup>    | $R_{\theta JC}$ or $\theta_{JC}$ | 7.2           | 9                          | _                          | °C/W |
| Thermal characterization parameter                  | $\Psi_{JT}$                      | 4.7           | 5                          | _                          | °C/W |

Notes:

- Junction-to-ambient thermal resistance is based on measurements on a horizontal single-sided printed circuit board per JEDEC Specification JESD51-3.
- 2. Junction-to-case thermal resistance is based on measurements using a cold plate per SEMI G30-88, with the exception that the cold plate temperature is used for the case temperature.
- 3. These are simulated values. See note 1 for test board conditions.
- 4. These are simulated values. The test board has two 2-ounce signal layers and two 1-ounce solid ground planes internal to the test board.

## 2.4 DC Electrical Characteristics

**Table 2-3.** DC Electrical Characteristics<sup>6</sup>

| Characteristics | Symbol          | Min | Тур | Max | Unit |
|-----------------|-----------------|-----|-----|-----|------|
| Supply voltage  | V <sub>CC</sub> | 3.0 | 3.3 | 3.6 | V    |

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**Table 2-3.** DC Electrical Characteristics<sup>6</sup> (Continued)

| Characteristics   | Symbol  | Min                           | Т  | ур          | Max                                 | Unit           |        |  |        |  |                         |        |
|---|---|-------------------------------|--|-------------|-------------------------------------|----------------|--------|--|--------|--|-------------------------|--------|
| Input high voltage  • D[0–23], BG, BB, TA  • MOD¹/IRQ¹, RESET, PINIT/NMI and all JTAG/ESSI/SCI/Timer/HI32 pins                                | V <sub>IH</sub><br>V <sub>IHP</sub>                     | 2.0<br>2.0                    | _<br>_   |             | _<br>_                              |                | _<br>_ |  | _<br>_ |  | V <sub>CC</sub><br>5.25 | V<br>V |
| • EXTAL <sup>8</sup>  | $V_{IHX}$   | $0.8 \times V_{CC}$           | -  | _           | V <sub>CC</sub>                     | V              |        |  |        |  |                         |        |
| Input low voltage  • D[0–23], BG, BB, TA, MOD¹/IRQ¹, RESET, PINIT  • All JTAG/ESSI/SCI/Timer/HI32 pins  • EXTAL <sup>8</sup>                  | V <sub>IL</sub><br>V <sub>ILP</sub><br>V <sub>ILX</sub> | -0.3<br>-0.3<br>-0.3          | -<br>-   |             | 0.8<br>0.8<br>0.2 × V <sub>CC</sub> | V<br>V<br>V    |        |  |        |  |                         |        |
| Input leakage current   | I <sub>IN</sub>   | -10                           | -  | _           | 10                                  | μΑ             |        |  |        |  |                         |        |
| High impedance (off-state) input current (@ 2.4 V / 0.4 V)  | I <sub>TSI</sub>  | -10                           | _  |             | 10                                  | μΑ             |        |  |        |  |                         |        |
| Output high voltage • TTL (I <sub>OH</sub> = -0.4 mA) <sup>5,7</sup> • CMOS (I <sub>OH</sub> = -10 μA) <sup>5</sup>                           | V <sub>OH</sub>   | 2.4<br>V <sub>CC</sub> – 0.01 | _<br>_   |             | _<br>_                              | V<br>V         |        |  |        |  |                         |        |
| Output low voltage  • TTL ( $I_{OL}$ = 1.6 mA, open-drain pins $I_{OL}$ = 6.7 mA) <sup>5,7</sup> • CMOS ( $I_{OL}$ = 10 $\mu$ A) <sup>5</sup> | V <sub>OL</sub>   |                               | -  | _<br>_<br>_ |                                     | V<br>V         |        |  |        |  |                         |        |
| Internal supply current <sup>2</sup> :  In Normal mode  In Wait mode <sup>3</sup> In Stop mode <sup>4</sup>                                   | I <sub>CCI</sub><br>Iccw<br>Iccs                        |                               | 80 MHz         100 MHz           102         127           6         7.5           100         100 |             | _<br>_<br>_                         | mA<br>mA<br>μA |        |  |        |  |                         |        |
| PLL supply current  |   | _                             | 1  |             | 2.5                                 | mA             |        |  |        |  |                         |        |
| Input capacitance <sup>5</sup>  | C <sub>IN</sub>   | _                             | -  | _           |                                     | pF             |        |  |        |  |                         |        |

#### Notes:

- 1. Refers to MODA/IRQA, MODB/IRQB, MODC/IRQC, and MODD/IRQD pins.
- 2. Power Consumption Considerations on page 4-3 provides a formula to compute the estimated current requirements in Normal mode. To obtain these results, all inputs must be terminated (that is, not allowed to float). Measurements are based on synthetic intensive DSP benchmarks (see Appendix A). The power consumption numbers in this specification are 90 percent of the measured results of this benchmark. This reflects typical DSP applications. Typical internal supply current is measured with V<sub>CC</sub> = 3.0 V at T<sub>J</sub> = 100°C.
- 3. To obtain these results, all inputs must be terminated (that is, not allowed to float).
- 4. To obtain these results, all inputs that are not disconnected at Stop mode must be terminated (that is, not allowed to float). PLL and XTAL signals are disabled during Stop state.
- 5. Periodically sampled and not 100 percent tested.
- **6.**  $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ ;  $T_{J} = -40 ^{\circ}\text{C}$  to +100  $^{\circ}\text{C}$ ,  $C_{L} = 50 \text{ pF}$
- 7. This characteristic does not apply to XTAL and PCAP.
- 8. Driving EXTAL to the low  $V_{IHX}$  or the high  $V_{ILX}$  value may cause additional power consumption (DC current). To minimize power consumption, the minimum  $V_{IHX}$  should be no lower than  $0.9 \times V_{CC}$  and the maximum  $V_{ILX}$  should be no higher than  $0.1 \times V_{CC}$ .

## 2.5 AC Electrical Characteristics

The timing waveforms shown in the AC electrical characteristics section are tested with a  $V_{IL}$  maximum of 0.3 V and a  $V_{IH}$  minimum of 2.4 V for all pins except EXTAL, which is tested using the input levels shown in Note 6 of **Table 2-3**. AC timing specifications, which are referenced to a device input signal, are measured in production with respect to the 50 percent point of the respective input signal's transition.

**Note:** Although the minimum value for the frequency of EXTAL is 0 MHz, the device AC test conditions are 15 MHz and rated speed.

All specifications for the high impedance state are guaranteed by design.

#### 2.5.1 Internal Clocks

Table 2-4. Internal Clocks, CLKOUT

| Characteristics   | Symbol           |  | 2  |  |
|---|------------------|--|--|--|
| Gilaracteristics  | Symbol           | Min  | Тур  | Max  |
| Internal operation frequency and CLKOUT with PLL enabled                                  | f                | _  | $\begin{array}{c} (Ef \times MF) / \\ (PDF \times DF) \end{array}$ | _  |
| Internal operation frequency and CLKOUT with PLL disabled                                 | f                | _  | Ef/2   | _  |
| Internal clock and CLKOUT high period  • With PLL disabled  • With PLL enabled and MF ≤ 4 | T <sub>H</sub>   | <br>0.49 × ET <sub>C</sub> ×<br>PDF × DF/MF                              | ET <sub>C</sub>  | <br>0.51 × ET <sub>C</sub> ×<br>PDF × DF/MF                              |
| With PLL enabled and MF > 4   |                  | $0.47 \times \text{ET}_{\text{C}} \times \text{PDF} \times \text{DF/MF}$ | _  | $0.53 \times \text{ET}_{\text{C}} \times \text{PDF} \times \text{DF/MF}$ |
| Internal clock and CLKOUT low period  • With PLL disabled  • With PLL enabled and MF ≤ 4  | TL               |  | ET <sub>C</sub>  | <br>0.51 × ET <sub>C</sub> ×<br>PDF × DF/MF                              |
| With PLL enabled and MF > 4   |                  | $0.47 \times \text{ET}_{\text{C}} \times \text{PDF} \times \text{DF/MF}$ | _  | $0.53 \times \text{ET}_{\text{C}} \times \text{PDF} \times \text{DF/MF}$ |
| Internal clock and CLKOUT cycle time with PLL enabled                                     | T <sub>C</sub>   | _  | ET <sub>C</sub> ×<br>PDF ×<br>DF/MF                                | _  |
| Internal clock and CLKOUT cycle time with PLL disabled                                    | T <sub>C</sub>   | _  | 2 × ET <sub>C</sub>  | _  |
| Instruction cycle time  | I <sub>CYC</sub> | _  | T <sub>C</sub>   | _  |

Notes: 1. DF = Division Factor; Ef = External frequency;  $ET_C$  = External clock cycle = 1/Ef; MF = Multiplication Factor; PDF = Predivision Factor;  $T_C$  = Internal clock cycle

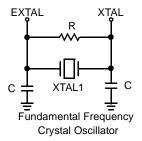
2. See the PLL and Clock Generator section in the DSP56300 Family Manual for details on the PLL.

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### 2.5.2 External Clock Operation

The DSP56301 system clock is derived from the on-chip oscillator or it is externally supplied. To use the on-chip oscillator, connect a crystal and associated resistor/capacitor components to EXTAL and XTAL; examples are shown in **Figure 2-1**.



**Note:** Make sure that in the PCTL Register:

- XTLD (bit 16) = 0
- If f<sub>OSC</sub> > 200 kHz, XTLR (bit 15) = 0

#### **Suggested Component Values:**

$$\begin{split} &f_{OSC} = 4 \text{ MHz} \\ &R = 680 \text{ } k\Omega \pm 10\% \\ &C = 56 \text{ pF} \pm 20\% \end{split} \qquad \begin{aligned} &f_{OSC} = 20 \text{ MHz} \\ &R = 680 \text{ } k\Omega \pm 10\% \\ &C = 22 \text{ pF} \pm 20\% \end{aligned}$$

Calculations were done for a 4/20 MHz crystal with the following parameters:

- C<sub>L</sub>of 30/20 pF,
- C<sub>0</sub> of 7/6 pF,
- series resistance of 100/20  $\Omega$ , and
- drive level of 2 mW.

Figure 2-1. Crystal Oscillator Circuits

If an externally supplied square wave voltage source is used, disable the internal oscillator circuit during boot-up by setting XTLD (PCTL Register bit 16 = 1—see the *DSP56301 User's Manual*). The external square wave source connects to EXTAL; XTAL is not physically connected to the board or socket. **Figure 2-2** shows the relationship between the EXTAL input and the internal clock and CLKOUT.

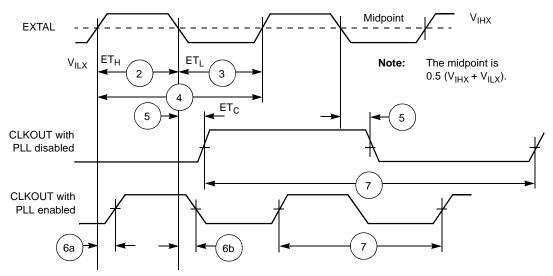


Figure 2-2. External Clock Timing

Table 2-5. Clock Operation

| No. | Characteristics  | Cumbal          | 80 MHz               |               |                      | 100 MHz                 |  |
|-----|--|-----------------|----------------------|---------------|----------------------|-------------------------|--|
| NO. | Characteristics  | Symbol          | Min                  | Max           | Min                  | Max                     |  |
| 1   | Frequency of EXTAL (EXTAL Pin Frequency) The rise and fall time of this external clock should be 3 ns maximum.   | Ef              | 0                    | 80.0 MHz      | 0                    | 100.0 MHz               |  |
| 2   | <ul> <li>EXTAL input high<sup>1, 2</sup></li> <li>With PLL disabled (46.7%–53.3% duty cycle<sup>6</sup>)</li> <li>With PLL enabled (42.5%–57.5% duty cycle<sup>6</sup>)</li> </ul> | ET <sub>H</sub> | 5.84 ns<br>5.31 ns   | ∞<br>157.0 μs | 4.67 ns<br>4.25 ns   | ∞<br>157.0 μs           |  |
| 3   | <ul> <li>EXTAL input low<sup>1, 2</sup></li> <li>With PLL disabled (46.7%–53.3% duty cycle<sup>6</sup>)</li> <li>With PLL enabled (42.5%–57.5% duty cycle<sup>6</sup>)</li> </ul>  | ET <sub>L</sub> | 5.84 ns<br>5.31 ns   | ∞<br>157.0 μs | 4.67 ns<br>4.25 ns   | ∞<br>157.0 μs           |  |
| 4   | EXTAL cycle time <sup>2</sup> • With PLL disabled • With PLL enabled   | ET <sub>C</sub> | 12.50 ns<br>12.50 ns | ∞<br>273.1 μs | 10.00 ns<br>10.00 ns | ∞<br>273.1 μs           |  |
| 5   | CLKOUT change from EXTAL fall with PLL disabled  |                 | 4.3 ns               | 11.0 ns       | 4.3 ns               | 11.0 ns                 |  |
| 6   | a. CLKOUT rising edge from EXTAL rising edge with PLL enabled (MF = 1 or 2 or 4, PDF = 1, Ef > 15 MHz) $^{3,5}$  |                 | 0.0 ns               | 1.8 ns        | 0.0 ns               | 1.8 ns                  |  |
|     | b. CLKOUT falling edge from EXTAL falling edge with PLL enabled (MF $\leq$ 4, PDF $\neq$ 1, Ef / PDF $>$ 15 MHz) $^{3,5}$  |                 | 0.0 ns               | 1.8 ns        | 0.0 ns               | 1.8 ns                  |  |
| 7   | Instruction cycle time = I <sub>CYC</sub> = T <sub>C</sub> <sup>4</sup> (see <b>Table 2-4</b> ) (46.7%–53.3% duty cycle)  • With PLL disabled                                      |                 | 25.0 ns              |               | 20.0 ns              |                         |  |
|     | With PLL disabled     With PLL enabled   | Icyc            | 25.0 ns<br>12.50 ns  | ∞<br>8.53 μs  | 20.0 ns<br>10.00 ns  | <sub>∞</sub><br>8.53 μs |  |

Notes:

- 1. Measured at 50 percent of the input transition
- 2. The maximum value for PLL enabled is given for minimum VCO frequency (see Table 2-6) and maximum MF.
- 3. Periodically sampled and not 100 percent tested
- 4. The maximum value for PLL enabled is given for minimum VCO frequency and maximum DF.
- 5. The skew is not guaranteed for any other MF value.
- 6. The indicated duty cycle is for the specified maximum frequency for which a part is rated. The minimum clock high or low time required for correction operation, however, remains the same at lower operating frequencies; therefore, when a lower clock frequency is used, the signal symmetry may vary from the specified duty cycle as long as the minimum high time and low time requirements are met.

## 2.5.3 Phase Lock Loop (PLL) Characteristics

Table 2-6. PLL Characteristics

| Characteristics  | 1 08                | ИНz          | 100 MHz          |                  |     |  |
|--|---------------------|--------------|------------------|------------------|-----|--|
| Characteristics  | Min Max Min Max     |              | Max              | Unit             |     |  |
| Voltage Controlled Oscillator (VCO) frequency when PLL enabled (MF $\times$ E $_{\rm f} \times$ 2/PDF) | 30                  | 160          | 30               | 200              | MHz |  |
| PLL external capacitor (PCAP pin to $V_{CCP}$ ) ( $C_{PCAP}$ ) • @ MF $\leq$ 4                         | (MF × 580) –<br>100 | (MF × 780) – | (MF × 580) – 100 | (MF × 780) – 140 | рF  |  |
| • @ MF > 4   | MF × 830            | MF × 1470    | MF × 830         | MF × 1470        | pF  |  |

**Note:** C<sub>PCAP</sub> is the value of the PLL capacitor (connected between the PCAP pin and V<sub>CCP</sub>). The recommended value in pF for C<sub>PCAP</sub> can be computed from one of the following equations:

 $(680 \times MF) - 120$ , for MF  $\leq 4$ , or  $1100 \times MF$ , for MF > 4.

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# 2.5.4 Reset, Stop, Mode Select, and Interrupt Timing

**Table 2-7.** Reset, Stop, Mode Select, and Interrupt Timing<sup>6</sup>

| NI- | Oh ava ataviatia  | F  | 80  | MHz                   | 100   | MHz              | 1114                             |
|-----|---|--|---|-----------------------|---|------------------|----------------------------------|
| No. | Characteristics   | Expression   | Min   | Max                   | Min   | Max              | Unit                             |
| 8   | Delay from RESET assertion to all pins at reset value <sup>3</sup>  | _  | _   | 26.0                  | _   | 26.0             | ns                               |
| 9   | Required RESET duration <sup>4</sup> Power on, external clock generator, PLL disabled  Power on, external clock generator, PLL enabled  Power on, internal oscillator  During STOP, XTAL disabled (PCTL Bit 16 = 0)  During STOP, XTAL enabled (PCTL Bit 16 = 1)  During normal operation | $50 \times \text{ET}_{\text{C}} \\ 1000 \times \text{ET}_{\text{C}} \\ 75000 \times \text{ET}_{\text{C}} \\ 75000 \times \text{ET}_{\text{C}} \\ 2.5 \times \text{T}_{\text{C}} \\ 2.5 \times \text{T}_{\text{C}}$ | 625.0<br>12.5<br>1.0<br>1.0<br>31.3<br>31.3 | _<br>_<br>_<br>_<br>_ | 500.0<br>10.0<br>0.75<br>0.75<br>25.0<br>25.0 | _<br>_<br>_<br>_ | ns<br>µs<br>ms<br>ms<br>ns<br>ns |
| 10  | Delay from asynchronous RESET deassertion to first external address output (internal reset deassertion) <sup>5</sup> • Minimum  • Maximum   | 3.25 × T <sub>C</sub> + 2.0<br>20.25 T <sub>C</sub> + 10.0   | 42.6<br>—                                   | <br>263.1             | 34.5<br>—                                     | <br>212.5        | ns<br>ns                         |
| 11  | Synchronous reset setup time from RESET deassertion to CLKOUT Transition 1  Minimum  Maximum  | T <sub>C</sub>   | 7.4<br>—                                    | <br>12.5              | 5.9<br>—                                      | —<br>10.0        | ns<br>ns                         |
| 12  | Synchronous reset deasserted, delay time from the CLKOUT Transition 1 to the first external address output  Minimum  Maximum  | 3.25 × T <sub>C</sub> + 1.0<br>20.25 × T <sub>C</sub> + 1.0  | 41.6<br>—                                   | <br>258.1             | 33.5<br>—                                     | <br>207.5        | ns<br>ns                         |
| 13  | Mode select setup time  |  | 30.0  | _                     | 30.0  | _                | ns                               |
| 14  | Mode select hold time   |  | 0.0   | _                     | 0.0   | _                | ns                               |
| 15  | Minimum edge-triggered interrupt request assertion width  |  | 8.25  | _                     | 6.6   | _                | ns                               |
| 16  | Minimum edge-triggered interrupt request deassertion width  |  | 8.25  | _                     | 7.1   | _                | ns                               |
| 17  | Delay from IRQA, IRQB, IRQC, IRQD, NMI assertion to external memory access address out valid  Caused by first interrupt instruction fetch  Caused by first interrupt instruction execution  | $4.25 \times T_{C} + 2.0$<br>$7.25 \times T_{C} + 2.0$   | 55.1<br>92.6                                |                       | 44.5<br>74.5                                  |                  | ns<br>ns                         |
| 18  | Delay from IRQA, IRQB, IRQC, IRQD, NMI assertion to general-purpose transfer output valid caused by first interrupt instruction execution   | 10 × T <sub>C</sub> + 5.0  | 130.0                                       | _                     | 105.0   | _                | ns                               |
| 19  | Delay from address output valid caused by first interrupt instruction execute to interrupt request deassertion for level sensitive fast interrupts <sup>1</sup>   |  | _   | Note 8                | _   | Note 8           | ns<br>ns                         |
| 20  | Delay from RD assertion to interrupt request deassertion for level sensitive fast interrupts <sup>1</sup>   | 80 MHz: $3.25 \times T_C + WS \times T_C - 12.4$ 100 MHz: $3.25 \times T_C + WS \times T_C - 10.94$  | _   | Note 8                | _   | Note 8           | ns<br>ns                         |

 Table 2-7.
 Reset, Stop, Mode Select, and Interrupt Timing<sup>6</sup> (Continued)

| Na  | Oh ava stavistica  | Funnasian  | 1 08              | ИHz                              | 100                 | MHz                            | l l mit        |
|-----|--|--|-------------------|----------------------------------|---------------------|--------------------------------|----------------|
| No. | Characteristics  | Expression   | Min               | Max                              | Min                 | Max                            | Unit           |
| 21  | Delay from WR assertion to interrupt request deassertion for level sensitive fast interrupts <sup>1</sup> • DRAM for all WS <sup>7</sup>   | <b>80 MHz</b> :<br>(WS + 3.5) × T <sub>C</sub> – 12.4<br><b>100 MHz</b> :  | _                 | Note 8                           |                     | Note 8                         | ns             |
|     | • SRAM WS = 1  | $(WS + 3.5) \times T_C - 10.94$ <b>80 MHz</b> : $(WS + 3.5) \times T_C - 12.4$ <b>100 MHz</b> :  | _                 | Note 8                           |                     | Note 8                         | ns<br>ns<br>ns |
|     | • SRAM WS = 2, 3   | (WS + 3.5) × T <sub>C</sub> - 10.94<br><b>80 MHz</b> :<br>(WS + 3) × T <sub>C</sub> - 12.4<br><b>100 MHz</b> :   | _                 | Note 8                           | _                   | Note 8                         | ns             |
|     | • SRAM WS ≥ 4  | $ \begin{array}{c} (\text{WS} + 3) \times \text{T}_{\text{C}} - 10.94 \\ \textbf{80 MHz} \\ (\text{WS} + 2.5) \times \text{T}_{\text{C}} - 12.4 \\ \textbf{100 MHz} \\ \end{array} $ | _                 | Note 8                           | -                   | Note 8                         | ns<br>ns       |
| 22  | Synchronous interrupt setup time from IRQA, IRQB, IRQC, IRQD, NMI assertion to the CLKOUT Transition 2   | (WS + 2.5) × T <sub>C</sub> – 10.94  | 7.4               | T <sub>C</sub>                   | 5.9                 | T <sub>C</sub>                 | ns             |
| 23  | Synchronous interrupt delay time from the CLKOUT Transition 2 to the first external address output valid caused by the first instruction fetch after coming out of Wait Processing state  Minimum  Maximum               | $8.25 \times T_{C} + 1.0$<br>$24.75 \times T_{C} + 5.0$  | 116.6<br>—        | <br>314.4                        | 83.5                | <br>252.5                      | ns<br>ns       |
| 24  | Duration for IRQA assertion to recover from Stop state   |  | 7.4               | _                                | 5.9                 | _                              | ns             |
| 25  | Delay from IRQA assertion to fetch of first instruction (when exiting Stop) <sup>2, 3</sup> • PLL is not active during Stop (PCTL Bit 17 = 0) and Stop delay is enabled (Operating Mode Register Bit 6 = 0)              | $PLC \times ET_{C} \times PDF + (128 \text{ K} - PLC/2) \times T_{C}$  | 1.6               | 17.0                             | 1.3                 | 13.6                           | ms             |
|     | <ul> <li>PLL is not active during Stop (PCTL Bit 17 = 0) and<br/>Stop delay is not enabled (Operating Mode Register<br/>Bit 6 = 1)</li> </ul>  | PLC × ET <sub>C</sub> × PDF + $(23.75 \pm 0.5) \times$ T <sub>C</sub><br>$(9.25 \pm 0.5) \times$ TC  | 290.6 ns<br>109.4 | 15.4 ms<br>121.9                 | 232.5<br>ns<br>87.5 | 12.3<br>ms<br>97.5             | ns             |
|     | <ul> <li>PLL is active during Stop (PCTL Bit 17 = 1) (Implies<br/>No Stop Delay)</li> </ul>  |  |                   |                                  |                     |                                |                |
| 26  | Duration of level sensitive IRQA assertion to ensure interrupt service (when exiting Stop) <sup>2, 3</sup> PLL is not active during Stop (PCTL Bit 17 = 0) and Stop delay is enabled (Operating Mode Register Bit 6 = 0) | $\begin{array}{c} PLC \times ET_{C} \times PDF + (128K - \\ PLC/2) \times T_{C} \end{array}$   | 17.0              |                                  | 13.6                | _                              | ms             |
|     | <ul> <li>PLL is not active during Stop (PCTL Bit 17 = 0) and<br/>Stop delay is not enabled (Operating Mode Register<br/>Bit 6 = 1)</li> </ul>  | PLC × ET <sub>C</sub> × PDF +<br>$(20.5 \pm 0.5) \times T_C$<br>$5.5 \times T_C$   | 15.4<br>68.8      | _                                | 12.3<br>55.0        | _                              | ms<br>ns       |
|     | <ul> <li>PLL is active during Stop (PCTL Bit 17 = 1) (implies no<br/>Stop delay)</li> </ul>  |  |                   |                                  |                     |                                |                |
| 27  | Interrupt Request Rate  HI32, ESSI, SCI, Timer  DMA  IRQ, NMI (edge trigger)  IRQ, NMI (level trigger)   | $12 \times T_{C}$ $8 \times T_{C}$ $8 \times T_{C}$ $12 \times T_{C}$  |                   | 150.0<br>100.0<br>100.0<br>150.0 | _<br>_<br>_<br>_    | 120.0<br>80.0<br>80.0<br>120.0 | ns<br>ns<br>ns |

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**Table 2-7.** Reset, Stop, Mode Select, and Interrupt Timing<sup>6</sup> (Continued)

| No. | Characteristics  | Francoica  | 80 MHz             |                              | 100 MHz          |                              | Unit           |
|-----|--|--|--------------------|------------------------------|------------------|------------------------------|----------------|
|     | Characteristics  | Expression   | Min                | Max                          | Min              | Max                          | Onit           |
| 28  | DMA Request Rate  Data read from HI32, ESSI, SCI  Data write to HI32, ESSI, SCI  Timer  RQ, NMI (edge trigger) | 6 × T <sub>C</sub><br>7 × T <sub>C</sub><br>2 × T <sub>C</sub><br>3 × T <sub>C</sub> | <br> -<br> -<br> - | 75.0<br>87.5<br>25.0<br>37.5 | _<br>_<br>_<br>_ | 60.0<br>70.0<br>20.0<br>30.0 | ns<br>ns<br>ns |
| 29  | Delay from IRQA, IRQB, IRQC, IRQD, NMI assertion to external memory (DMA source) access address out valid      | $4.25 \times T_{C} + 2.0$  | 55.1               | _                            | 44.5             | _                            | ns             |

#### Notes:

- . When using fast interrupts and IRQA, IRQB, IRQC, and IRQD are defined as level-sensitive, timings 19 through 21 apply to prevent multiple interrupt service. To avoid these timing restrictions, the deasserted Edge-triggered mode is recommended when using fast interrupts. Long interrupts are recommended when using Level-sensitive mode.
- **2.** This timing depends on several settings:
  - For PLL disable, using internal oscillator (PLL Control Register (PCTL) Bit 16 = 0) and oscillator disabled during Stop (PCTL Bit 17 = 0), a stabilization delay is required to assure that the oscillator is stable before programs are executed. Resetting the Stop delay (Operating Mode Register Bit 6 = 0) provides the proper delay. While Operating Mode Register Bit 6 = 1 can be set, it is not recommended, and these specifications do not guarantee timings for that case.
  - For PLL disable, using internal oscillator (PCTL Bit 16 = 0) and oscillator enabled during Stop (PCTL Bit 17=1), no stabilization delay is required and recovery is minimal (Operating Mode Register Bit 6 setting is ignored).
  - For PLL disable, using external clock (PCTL Bit 16 = 1), no stabilization delay is required and recovery time is defined by the PCTL Bit 17 and Operating Mode Register Bit 6 settings.
  - For PLL enable, if PCTL Bit 17 is 0, the PLL is shutdown during Stop. Recovering from Stop requires the PLL to get locked. The PLL lock procedure duration, PLL Lock Cycles (PLC), may be in the range of 0 to 1000 cycles. This procedure occurs in parallel with the stop delay counter, and stop recovery ends when the last of these two events occurs. The stop delay counter completes count or PLL lock procedure completion.
  - PLC value for PLL disable is 0.
  - The maximum value for ET<sub>C</sub> is 4096 (maximum MF) divided by the desired internal frequency (that is, for 66 MHz it is 4096/66 MHz = 62 μs). During the stabilization period, T<sub>C</sub>, T<sub>H</sub>, and T<sub>L</sub> is not constant, and their width may vary, so timing may vary as well.
- 3. Periodically sampled and not 100 percent tested.
- 4. Value depends on clock source:
  - For an external clock generator, RESET duration is measured while RESET is asserted, V<sub>CC</sub> is valid, and the EXTAL input is active and valid.
  - For an internal oscillator, RESET duration is measured while RESET is asserted and V<sub>CC</sub> is valid. The specified timing reflects the crystal oscillator stabilization time after power-up. This number is affected both by the specifications of the crystal and other components connected to the oscillator and reflects worst case conditions.
  - When the V<sub>CC</sub> is valid, but the other "required RESET duration" conditions (as specified above) have not been yet met, the device circuitry is in an uninitialized state that can result in significant power consumption and heat-up. Designs should minimize this state to the shortest possible duration.
- 5. If PLL does not lose lock.
- **6.**  $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ ;  $T_{J} = -40 ^{\circ}\text{C}$  to  $+100 ^{\circ}\text{C}$ ,  $C_{L} = 50 \text{ pF}$ .
- 7. WS = number of wait states (measured in clock cycles, number of  $T_C$ ).
- 8. Use the expression to compute a maximum value.

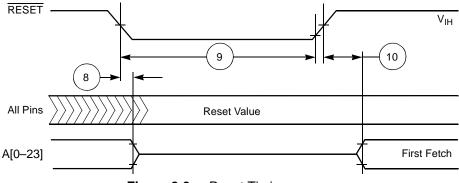


Figure 2-3. Reset Timing

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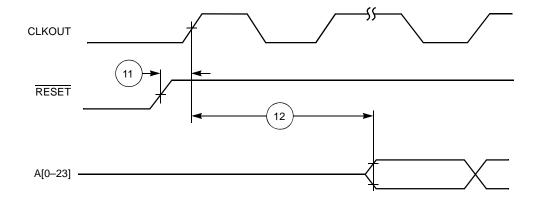
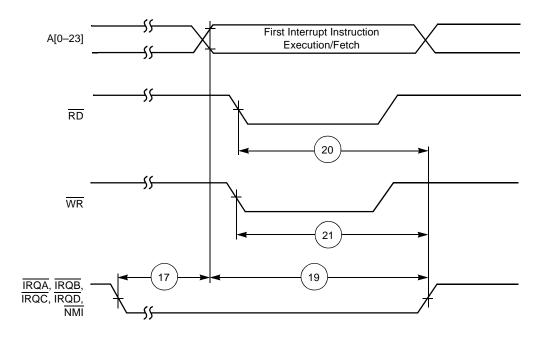
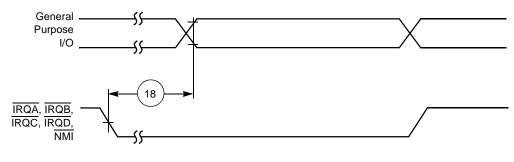


Figure 2-4. Synchronous Reset Timing



#### a) First Interrupt Instruction Execution



b) General-Purpose I/O

Figure 2-5. External Fast Interrupt Timing

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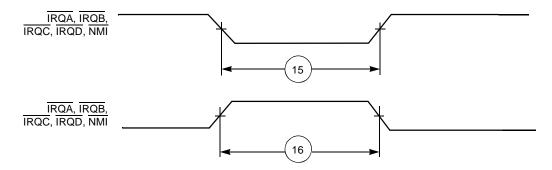


Figure 2-6. External Interrupt Timing (Negative Edge-Triggered)

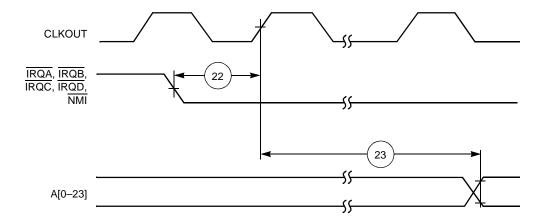


Figure 2-7. Synchronous Interrupt from Wait State Timing

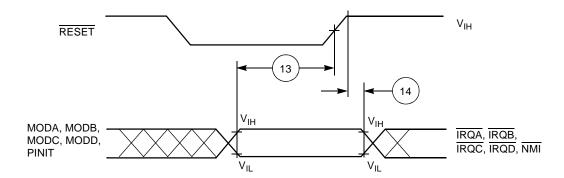


Figure 2-8. Operating Mode Select Timing

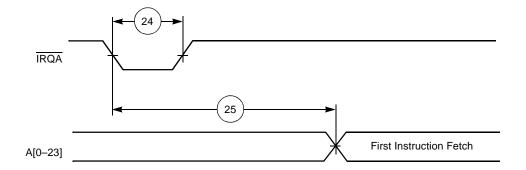


Figure 2-9. Recovery from Stop State Using IRQA

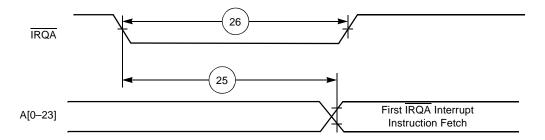


Figure 2-10. Recovery from Stop State Using IRQA Interrupt Service

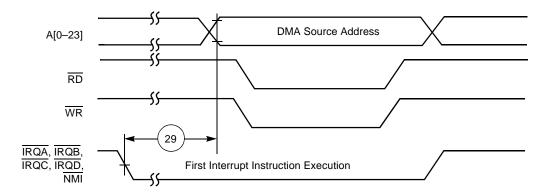


Figure 2-11. External Memory Access (DMA Source) Timing

# 2.5.5 External Memory Expansion Port (Port A)

2-12 Freescale Semiconductor

# 2.5.5.1 SRAM Timing

**Table 2-8.** SRAM Read and Write Accesses<sup>3,6</sup>

| NI  | Oh annat a tation                                       | 0                                  | F 1  | 80 1                       | ИНz                 | 100                        | MHz                 | 1124           |
|-----|---|------------------------------------|--|----------------------------|---------------------|----------------------------|---------------------|----------------|
| No. | Characteristics   | Symbol                             | Expression <sup>1</sup>  | Min                        | Max                 | Min                        | Max                 | Unit           |
| 100 | Address valid and AA assertion pulse width <sup>2</sup> | t <sub>RC</sub> , t <sub>WC</sub>  | $ \begin{array}{c} (\text{WS} + 1) \times \text{T}_{\text{C}} - 4.0 \ [1 \leq \text{WS} \leq 3] \\ (\text{WS} + 2) \times \text{T}_{\text{C}} - 4.0 \ [4 \leq \text{WS} \leq 7] \\ (\text{WS} + 3) \times \text{T}_{\text{C}} - 4.0 \ [\text{WS} \geq 8] \end{array} $ | 21.0<br>71.0<br>133.5      | _<br>_<br>_         | 16.0<br>56.0<br>106.0      | _<br>_<br>_         | ns<br>ns<br>ns |
| 101 | Address and AA valid to WR assertion                    | t <sub>AS</sub>                    | $\begin{array}{c} 0.25 \times T_{C} - 2.0 \; [WS = 1] \\ 0.75 \times T_{C} - 2.0 \; [2 \leq WS \leq 3] \\ 1.25 \times T_{C} - 2.0 \; [WS \geq 4] \end{array}$  | 1.1<br>7.4<br>13.6         | <br>_<br>_          | 0.5<br>5.5<br>10.5         | _<br>_<br>_         | ns<br>ns<br>ns |
| 102 | WR assertion pulse width                                | t <sub>WP</sub>                    | $\begin{array}{c} 1.5 \times T_{C} - 4.0 \; [WS = 1] \\ WS \times T_{C} - 4.0 \; [2 \leq WS \leq 3] \\ (WS - 0.5) \times T_{C} - 4.0 \; [WS \geq 4] \end{array}$   | 14.8<br>21.0<br>39.8       | _<br>_<br>_         | 11.0<br>16.0<br>31.0       | _<br>_<br>_         | ns<br>ns<br>ns |
| 103 | WR deassertion to address not valid                     | t <sub>WR</sub>                    | $\begin{array}{c} 0.25 \times T_{C} - 2.0 \; [1 \leq WS \leq 3] \\ 1.25 \times T_{C} - 4.0 \; [4 \leq WS \leq 7] \\ 2.25 \times T_{C} - 4.0 \; [WS \geq 8] \end{array}$  | 1.1<br>11.6<br>24.1        | _<br>_<br>_         | 0.5<br>8.5<br>18.5         | _<br>_<br>_         | ns<br>ns<br>ns |
| 104 | Address and AA valid to input data valid                | t <sub>AA</sub> , t <sub>AC</sub>  | $(WS + 0.75) \times T_C - 5.0 [WS \ge 1]$  | _                          | 16.9                | _                          | 12.5                | ns             |
| 105 | RD assertion to input data valid                        | t <sub>OE</sub>                    | $(WS + 0.25) \times T_{C} - 5.0 \ [WS \ge 1]$  | _                          | 10.6                | _                          | 7.5                 | ns             |
| 106 | RD deassertion to data not valid (data hold time)       | t <sub>OHZ</sub>                   |  | 0.0                        | _                   | 0.0                        | _                   | ns             |
| 107 | Address valid to WR deassertion <sup>2</sup>            | t <sub>AW</sub>                    | $(WS + 0.75) \times T_C - 4.0 \ [WS \ge 1]$  | 17.9                       | _                   | 13.5                       | _                   | ns             |
| 108 | Data valid to WR deassertion (data setup time)          | t <sub>DS</sub> (t <sub>DW</sub> ) | $(WS - 0.25) \times T_C - 3.0 \ [WS \ge 1]$  | 6.4                        | _                   | 4.5                        | _                   | ns             |
| 109 | Data hold time from WR deassertion                      | t <sub>DH</sub>                    | $\begin{array}{c} 0.25 \times T_{C} - 2.0 \; [1 \leq WS \leq 3] \\ 1.25 \times T_{C} - 2.0 \; [4 \leq WS \leq 7] \\ 2.25 \times T_{C} - 2.0 \; [WS \geq 8] \end{array}$  | 1.1<br>13.6<br>26.1        | _<br>_<br>_         | 0.5<br>10.5<br>20.5        | _<br>_<br>_         | ns<br>ns<br>ns |
| 110 | WR assertion to data active                             |                                    | $\begin{array}{c} 0.75 \times T_{C} - 3.7 \; [WS = 1] \\ 0.25 \times T_{C} - 3.7 \; [2 \leq WS \leq 3] \\ -0.25 \times T_{C} - 3.7 \; [WS \geq 4] \end{array}$   | 5.7<br>-0.6<br>-6.8        | _<br>_<br>_         | 3.8<br>-1.2<br>-6.2        | _<br>_<br>_         | ns<br>ns<br>ns |
| 111 | WR deassertion to data high impedance                   |                                    | $\begin{array}{c} 0.25 \times T_{C} + 0.2 \; [1 \leq WS \leq 3] \\ 1.25 \times T_{C} + 0.2 \; [4 \leq WS \leq 7] \\ 2.25 \times T_{C} + 0.2 \; [WS \geq 8] \end{array}$  | _<br>_<br>_                | 3.3<br>15.8<br>28.3 | _<br>_<br>_                | 2.7<br>12.7<br>22.7 | ns<br>ns<br>ns |
| 112 | Previous RD deassertion to data active (write)          |                                    | $\begin{array}{l} 1.25 \times T_{C} - 4.0 \; [1 \leq WS \leq 3] \\ 2.25 \times T_{C} - 4.0 \; [4 \leq WS \leq 7] \\ 3.25 \times T_{C} - 4.0 \; [WS \geq 8] \end{array}$  | 11.6<br>24.1<br>36.6       | _<br>_<br>_         | 8.5<br>18.5<br>28.5        | _<br>_<br>_         | ns<br>ns<br>ns |
| 113 | RD deassertion time                                     |                                    | $\begin{array}{c} 0.75 \times T_C - 4.0 \; [1 \leq WS \leq 3] \\ 1.75 \times T_C - 4.0 \; [4 \leq WS \leq 7] \\ 2.75 \times T_C - 4.0 \; [WS \geq 8] \end{array}$  | 5.4<br>17.9<br>30.4        | _<br>_<br>_         | 3.5<br>13.5<br>23.5        | _<br>_<br>_         | ns<br>ns<br>ns |
| 114 | WR deassertion time                                     |                                    | $0.5 \times T_{C} - 4.0 \text{ [WS = 1]}$ $T_{C} - 4.0 \text{ [2 \le WS \le 3]}$ $2.5 \times T_{C} - 4.0 \text{ [4 \le WS \le 7]}$ $3.5 \times T_{C} - 4.0 \text{ [WS \ge 8]}$   | 2.3<br>8.5<br>27.3<br>39.8 | _<br>_<br>_<br>_    | 1.0<br>6.0<br>21.0<br>31.0 | _<br>_<br>_<br>_    | ns<br>ns<br>ns |

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**Table 2-8.** SRAM Read and Write Accesses<sup>3,6</sup> (Continued)

| No.  | Characteristics                                   | Symbol | Expression <sup>1</sup>  | 1 08                | 80 MHz      |                     | 100 MHz     |                |  |
|------|---|--------|--|---------------------|-------------|---------------------|-------------|----------------|--|
| 140. | Onaracteristics                                   | Oymboi | Expression   | Min                 | Max         | Min                 | Max         | Unit           |  |
| 115  | Address valid to RD assertion                     |        | 0.5 × T <sub>C</sub> – 4.0   | 2.3                 | _           | 1.0                 | _           | ns             |  |
| 116  | RD assertion pulse width                          |        | $(WS + 0.25) \times T_C - 4.0$   | 11.6                | _           | 8.5                 | _           | ns             |  |
| 117  | RD deassertion to address not valid               |        | $\begin{array}{c} 0.25 \times T_{C} - 2.0 \ [1 \leq WS \leq 3] \\ 1.25 \times T_{C} - 2.0 \ [4 \leq WS \leq 7] \\ 2.25 \times T_{C} - 2.0 \ [WS \geq 8] \end{array}$ | 1.1<br>13.6<br>26.1 | _<br>_<br>_ | 0.5<br>10.5<br>20.5 | _<br>_<br>_ | ns<br>ns<br>ns |  |
| 118  | TA setup before RD or WR deassertion <sup>4</sup> |        | $0.25 \times T_{C} + 2.0$  | 5.1                 | _           | 4.5                 | _           | ns             |  |
| 119  | TA hold after RD or WR deassertion                |        |  | 0                   | _           | 0                   | _           | ns             |  |

- 1. WS is the number of wait states specified in the BCR.
- 2. Timings 100, 107 are guaranteed by design, not tested.
- 3. All timings for 100 MHz are measured from 0.5 · Vcc to 0.5 · Vcc
- **4.** Timing 118 is relative to the deassertion edge of  $\overline{RD}$  or  $\overline{WR}$  even if  $\overline{TA}$  remains active.
- 5. Timings 110, 111, and 112, are not helpful and are not specified for 100 MHz.
- **6.**  $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ ;  $T_{J} = -40^{\circ}\text{C}$  to  $+100^{\circ}\text{C}$ ,  $C_{L} = 50 \text{ pF}$

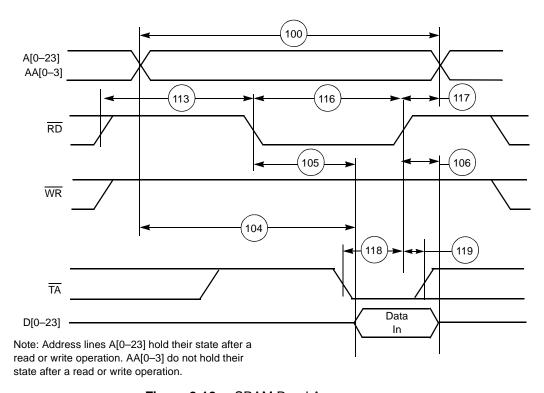
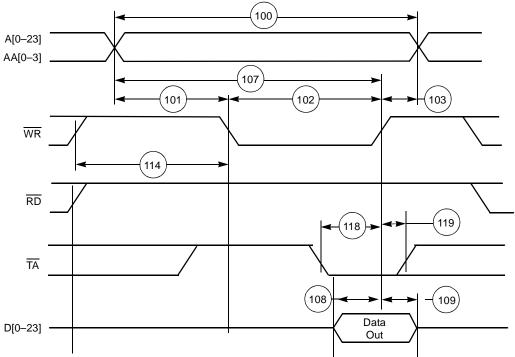


Figure 2-12. SRAM Read Access



Note: Address lines A[0–23] hold their state after a read or write operation. AA[0–3] do not hold their state after a read or write operation.

Figure 2-13. SRAM Write Access

## 2.5.5.2 DRAM Timing

The selection guides in **Figure 2-14** and **Figure 2-17** are for primary selection only. Final selection should be based on the timing in the following tables. For example, the selection guide suggests that four wait states must be used for 100 MHz operation in Page Mode DRAM. However, using the information in the appropriate table, a designer could choose to evaluate whether fewer wait states might be used by determining which timing prevents operation at 100 MHz, by running the chip at a slightly lower frequency (for example, 95 MHz), by using faster DRAM (if it becomes available), and by manipulating control factors such as capacitive and resistive load to improve overall system performance.

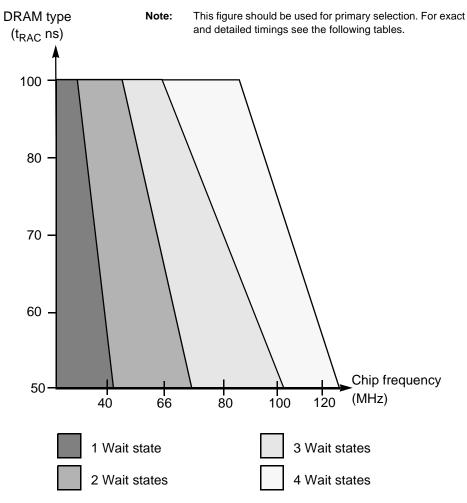


Figure 2-14. DRAM Page Mode Wait States Selection Guide

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**Table 2-9.** DRAM Page Mode Timings, Two Wait States<sup>1, 2, 3, 7</sup>

| NI-               | Oh arrantariation  | O                 | F  | 80 1                      | MHz                | 1111           |
|-------------------|--|-------------------|--|---------------------------|--------------------|----------------|
| No.               | Characteristics  | Symbol            | Expression   | Min                       | Max                | Unit           |
| 131               | Page mode cycle time for two consecutive accesses of the same direction  |                   | 3×T <sub>C</sub>   | 37.5                      | _                  | ns             |
|                   | Page mode cycle time for mixed (read and write) accesses   | t <sub>PC</sub>   | $2.75 \times T_{C}$  | 34.4                      | _                  | ns             |
| 132               | CAS assertion to data valid (read)   | t <sub>CAC</sub>  | $1.5 \times T_{C} - 6.5$   | _                         | 12.3               | ns             |
| 133               | Column address valid to data valid (read)  | t <sub>AA</sub>   | $2.5 \times T_{C} - 6.5$   | _                         | 24.8               | ns             |
| 134               | CAS deassertion to data not valid (read hold time)   | t <sub>OFF</sub>  |  | 0.0                       | _                  | ns             |
| 135               | Last CAS assertion to RAS deassertion  | t <sub>RSH</sub>  | $1.75 \times T_{C} - 4.0$  | 17.9                      | _                  | ns             |
| 136               | Previous CAS deassertion to RAS deassertion  | t <sub>RHCP</sub> | $3.25 \times T_{C} - 4.0$  | 36.6                      | _                  | ns             |
| 137               | CAS assertion pulse width  | t <sub>CAS</sub>  | $1.5 \times T_{C} - 4.0$   | 14.8                      | _                  | ns             |
| 138               | Last $\overline{\text{CAS}}$ deassertion to $\overline{\text{RAS}}$ deassertion <sup>5</sup> BRW[1-0] = 00 BRW[1-0] = 01 BRW[1-0] = 10 BRW[1-0] = 11 | t <sub>CRP</sub>  | Not supported $3.5 \times T_C - 6.0$ $4.5 \times T_C - 6.0$ $6.5 \times T_C - 6.0$ | —<br>37.8<br>50.3<br>75.3 | <br> -<br> -<br> - | ns<br>ns<br>ns |
| 139               | CAS deassertion pulse width  | t <sub>CP</sub>   | $1.25 \times T_{C} - 4.0$  | 11.6                      | _                  | ns             |
| 140               | Column address valid to CAS assertion  | t <sub>ASC</sub>  | T <sub>C</sub> – 4.0   | 8.5                       | _                  | ns             |
| 141               | CAS assertion to column address not valid  | t <sub>CAH</sub>  | $1.75 \times T_{C} - 4.0$  | 17.9                      | _                  | ns             |
| 142               | Last column address valid to RAS deassertion   | t <sub>RAL</sub>  | $3 \times T_C - 4.0$   | 33.5                      | _                  | ns             |
| 143               | WR deassertion to CAS assertion  | t <sub>RCS</sub>  | $1.25\times T_C-4$   | 11.6                      | _                  | ns             |
| 144               | CAS deassertion to WR assertion  | t <sub>RCH</sub>  | $0.5 \times T_C - 3.7$   | 2.6                       | _                  | ns             |
| 145               | CAS assertion to WR deassertion  | t <sub>WCH</sub>  | $1.5 \times T_C - 4.2$   | 14.6                      | _                  | ns             |
| 146               | WR assertion pulse width   | t <sub>WP</sub>   | $2.5\times T_C-4.5$  | 26.8                      | _                  | ns             |
| 147               | Last WR assertion to RAS deassertion   | t <sub>RWL</sub>  | $2.75\times T_C-4.3$   | 30.1                      | _                  | ns             |
| 148               | WR assertion to CAS deassertion  | t <sub>CWL</sub>  | $2.5\times T_C-4.3$  | 27.0                      | _                  | ns             |
| 149               | Data valid to CAS assertion (write)  | t <sub>DS</sub>   | $0.25\times T_C-3.0$   | 0.1                       | _                  | ns             |
| 150               | CAS assertion to data not valid (write)  | t <sub>DH</sub>   | $1.75\times T_C-4.0$   | 17.9                      | _                  | ns             |
| 151               | WR assertion to CAS assertion  | t <sub>WCS</sub>  | $T_C - 4.3$  | 8.2                       | _                  | ns             |
| 152               | Last RD assertion to RAS deassertion   | t <sub>ROH</sub>  | $2.5\times T_C-4.0$  | 27.3                      | _                  | ns             |
| 153               | RD assertion to data valid   | t <sub>GA</sub>   | $1.75 \times T_{C} - 6.5$  | _                         | 15.4               | ns             |
| 154               | RD deassertion to data not valid <sup>6</sup>  | t <sub>GZ</sub>   |  | 0.0                       | _                  | ns             |
| 155               | WR assertion to data active  |                   | $0.75 \times T_{C} - 1.5$  | 7.9                       | _                  | ns             |
| 156               | WR deassertion to data high impedance  |                   | $0.25 \times T_{C}$  | _                         | 3.1                | ns             |
| 153<br>154<br>155 | RD assertion to data valid  RD deassertion to data not valid  WR assertion to data active  | t <sub>GA</sub>   | $1.75 \times T_{C} - 6.5$ $0.75 \times T_{C} - 1.5$                                | 0.0                       |                    |                |

- 1. The number of wait states for Page mode access is specified in the DCR.
- 2. The refresh period is specified in the DCR.
- 3. The asynchronous delays specified in the expressions are valid for the DSP56301.
- 4. All the timings are calculated for the worst case. Some of the timings are better for specific cases (for example,  $t_{PC}$  equals  $3 \times T_{C}$  for read-after-read or write-after-write sequences).
- 5. BRW[1–0] (DRAM Control Register bits) defines the number of wait states that should be inserted in each DRAM out-of-page access.
- **6.** RD deassertion always occurs after  $\overline{\text{CAS}}$  deassertion; therefore, the restricted timing is  $t_{\text{OFF}}$  and not  $t_{\text{GZ}}$ .
- 7. At this time, there are no DRAMs fast enough to fit with two wait states Page mode @ 100MHz (see **Table 2-14**). However, DRAM speeds are approaching two-wait-state compatibility.

**Table 2-10.** DRAM Page Mode Timings, Three Wait States<sup>1, 2, 3</sup>

| NI- | Oh ann at a risting   | 0                 | F   | 80 1                 | MHz  | 100                  | MHz                | 11!6           |
|-----|---|-------------------|---|----------------------|------|----------------------|--------------------|----------------|
| No. | Characteristics   | Symbol            | Expression  | Min                  | Max  | Min                  | Max                | Unit           |
| 131 | Page mode cycle time for two consecutive accesses of the same direction                                       |                   | 4×T <sub>C</sub>  | 50.0                 | _    | 40.0                 | _                  | ns             |
|     | Page mode cycle time for mixed (read and write) accesses  | t <sub>PC</sub>   | $3.5\times T_{\hbox{\scriptsize C}}$  | 43.7                 | _    | 35.0                 | _                  | ns             |
| 132 | CAS assertion to data valid (read)  | t <sub>CAC</sub>  | $2 \times T_C - 5.7$  | _                    | 19.3 | _                    | 14.3               | ns             |
| 133 | Column address valid to data valid (read)   | t <sub>AA</sub>   | $3 \times T_C - 5.7$  | _                    | 31.8 | _                    | 24.3               | ns             |
| 134 | CAS deassertion to data not valid (read hold time)  | t <sub>OFF</sub>  |   | 0.0                  | _    | 0.0                  | _                  | ns             |
| 135 | Last CAS assertion to RAS deassertion   | t <sub>RSH</sub>  | $2.5\times T_C-4.0$   | 27.3                 | _    | 21.0                 | _                  | ns             |
| 136 | Previous CAS deassertion to RAS deassertion   | t <sub>RHCP</sub> | $4.5 \times T_C - 4.0$  | 52.3                 | _    | 41.0                 | _                  | ns             |
| 137 | CAS assertion pulse width   | t <sub>CAS</sub>  | 2 × T <sub>C</sub> - 4.0  | 21.0                 | _    | 16.0                 | _                  | ns             |
| 138 | Last CAS deassertion to RAS assertion <sup>5</sup> BRW[1-0] = 00  BRW[1-0] = 01  BRW[1-0] = 10  BRW[1-0] = 11 | <sup>t</sup> CRP  | Not supported $3.75 \times T_{C} - 6.0$ $4.75 \times T_{C} - 6.0$ $6.75 \times T_{C} - 6.0$ | 40.9<br>53.4<br>78.4 |      | 31.5<br>41.5<br>61.5 | <br> -<br> -<br> - | ns<br>ns<br>ns |
| 139 | CAS deassertion pulse width   | t <sub>CP</sub>   | $1.5 \times T_{C} - 4.0$  | 14.8                 | _    | 11.0                 | _                  | ns             |
| 140 | Column address valid to CAS assertion   | t <sub>ASC</sub>  | T <sub>C</sub> – 4.0  | 8.5                  | _    | 6.0                  | _                  | ns             |
| 141 | CAS assertion to column address not valid   | t <sub>CAH</sub>  | $2.5 \times T_{C} - 4.0$  | 27.3                 | _    | 21.0                 | _                  | ns             |
| 142 | Last column address valid to RAS deassertion  | t <sub>RAL</sub>  | $4 \times T_C - 4.0$  | 46.0                 | _    | 36.0                 | _                  | ns             |
| 143 | WR deassertion to CAS assertion   | t <sub>RCS</sub>  | $1.25 \times T_{C} - 4.0$   | 11.6                 | _    | 8.5                  | _                  | ns             |
| 144 | CAS deassertion to WR assertion   | t <sub>RCH</sub>  | 0.75 × TC - 4.0   | 5.4                  | _    | 3.5                  | _                  | ns             |
| 145 | CAS assertion to WR deassertion   | t <sub>WCH</sub>  | 2.25 × T <sub>C</sub> – 4.2   | 23.9                 | _    | 18.3                 | _                  | ns             |
| 146 | WR assertion pulse width  | t <sub>WP</sub>   | $3.5 \times T_C - 4.5$  | 39.3                 | _    | 30.5                 | _                  | ns             |
| 147 | Last WR assertion to RAS deassertion  | t <sub>RWL</sub>  | $3.75 \times T_{C} - 4.3$   | 42.6                 | _    | 33.2                 | _                  | ns             |
| 148 | WR assertion to CAS deassertion   | t <sub>CWL</sub>  | $3.25 \times T_{C} - 4.3$   | 36.3                 | _    | 28.2                 | _                  | ns             |
| 149 | Data valid to CAS assertion (write)   | t <sub>DS</sub>   | $0.5 \times T_{C} - 4.8$  | 2.0                  | _    | 0.2                  | _                  | ns             |
| 150 | CAS assertion to data not valid (write)   | t <sub>DH</sub>   | $2.5 \times T_{C} - 4.0$  | 27.3                 | _    | 21.0                 | _                  | ns             |
| 151 | WR assertion to CAS assertion   | t <sub>WCS</sub>  | $1.25\times T_C-4.3$  | 11.3                 | _    | 8.2                  | _                  | ns             |
| 152 | Last RD assertion to RAS deassertion  | t <sub>ROH</sub>  | $3.5 \times T_C - 4.0$  | 39.8                 | _    | 31.0                 | _                  | ns             |
| 153 | RD assertion to data valid  | t <sub>GA</sub>   | $2.5 \times T_C - 5.7$  | _                    | 25.6 | _                    | 19.3               | ns             |
| 154 | RD deassertion to data not valid <sup>6</sup>   | t <sub>GZ</sub>   |   | 0.0                  | _    | 0.0                  | _                  | ns             |
| 155 | WR assertion to data active   |                   | $0.75 \times T_{C} - 1.5$   | 7.9                  | _    | 6.0                  | _                  | ns             |
| 156 | WR deassertion to data high impedance   |                   | $0.25 \times T_{\hbox{\scriptsize C}}$  | _                    | 3.1  | _                    | 2.5                | ns             |

- 1. The number of wait states for Page mode access is specified in the DCR.
- 2. The refresh period is specified in the DCR.
- 3. The asynchronous delays specified in the expressions are valid for DSP56301.
- 4. All the timings are calculated for the worst case. Some of the timings are better for specific cases (for example, t<sub>PC</sub> equals 4 × T<sub>C</sub> for read-after-read or write-after-write sequences).
- 5. BRW[1–0] (DRAM control register bits) defines the number of wait states that should be inserted in each DRAM out-of page-access.
- **6.**  $\overline{\text{RD}}$  deassertion always occurs after  $\overline{\text{CAS}}$  deassertion; therefore, the restricted timing is  $t_{\text{OFF}}$  and not  $t_{\text{GZ}}$ .

DRAM Page Mode Timings, Four Wait States<sup>1, 2, 3</sup> Table 2-11.

|     |   |                   | <b>-</b>  | 80 1                 | ИНz          | 100                       | MHz          |                |
|-----|---|-------------------|---|----------------------|--------------|---------------------------|--------------|----------------|
| No. | Characteristics   | Symbol            | Expression  | Min                  | Max          | Min                       | Max          | Unit           |
| 131 | Page mode cycle time for two consecutive accesses of the same direction                                       |                   | 5×T <sub>C</sub>  | 62.5                 | _            | 50.0                      | _            | ns             |
|     | Page mode cycle time for mixed (read and write) accesses  | t <sub>PC</sub>   | $4.5 \times T_{C}$  | 56.2                 | _            | 45.0                      | _            | ns             |
| 132 | CAS assertion to data valid (read)  | t <sub>CAC</sub>  | $2.75\times T_C-5.7$  | _                    | 28.7         | _                         | 21.8         | ns             |
| 133 | Column address valid to data valid (read)   | t <sub>AA</sub>   | $3.75\times T_C-5.7$  | _                    | 41.2         | _                         | 31.8         | ns             |
| 134 | CAS deassertion to data not valid (read hold time)  | t <sub>OFF</sub>  |   | 0.0                  | _            | 0.0                       | _            | ns             |
| 135 | Last CAS assertion to RAS deassertion   | t <sub>RSH</sub>  | $3.5 \times T_C - 4.0$  | 39.8                 | _            | 31.0                      | _            | ns             |
| 136 | Previous CAS deassertion to RAS deassertion   | t <sub>RHCP</sub> | $6 \times T_C - 4.0$  | 71.0                 | _            | 56.0                      | _            | ns             |
| 137 | CAS assertion pulse width   | t <sub>CAS</sub>  | $2.5 \times T_C - 4.0$  | 27.3                 | _            | 21.0                      | _            | ns             |
| 138 | Last CAS deassertion to RAS assertion <sup>5</sup> BRW[1-0] = 00  BRW[1-0] = 01  BRW[1-0] = 10  BRW[1-0] = 11 | <sup>t</sup> CRP  | Not supported $4.25 \times T_C - 6.0$ $5.25 \times T_C - 6.0$ $7.25 \times T_C - 6.0$ | 47.2<br>59.6<br>84.6 | <br> -<br> - | —<br>36.5<br>46.5<br>66.5 | <br> -<br> - | ns<br>ns<br>ns |
| 139 | CAS deassertion pulse width   | t <sub>CP</sub>   | 2 × T <sub>C</sub> - 4.0  | 21.0                 | _            | 16.0                      | _            | ns             |
| 140 | Column address valid to CAS assertion   | t <sub>ASC</sub>  | T <sub>C</sub> – 4.0  | 8.5                  | _            | 6.0                       | _            | ns             |
| 141 | CAS assertion to column address not valid   | t <sub>CAH</sub>  | $3.5 \times T_C - 4.0$  | 39.8                 | _            | 31.0                      | _            | ns             |
| 142 | Last column address valid to RAS deassertion  | t <sub>RAL</sub>  | $5 \times T_C - 4.0$  | 58.5                 | _            | 46.0                      | _            | ns             |
| 143 | WR deassertion to CAS assertion   | t <sub>RCS</sub>  | $1.25\times T_C-4.0$  | 11.8                 | _            | 8.5                       | _            | ns             |
| 144 | CAS deassertion to WR assertion   | t <sub>RCH</sub>  | $1.25\times T_C-3.7$  | 11.9                 | _            | 8.8                       | _            | ns             |
| 145 | CAS assertion to WR deassertion   | t <sub>WCH</sub>  | $3.25 \times T_C - 4.2$   | 36.4                 | _            | 28.3                      | _            | ns             |
| 146 | WR assertion pulse width  | t <sub>WP</sub>   | $4.5\times T_C-4.5$   | 51.8                 | _            | 40.5                      | _            | ns             |
| 147 | Last WR assertion to RAS deassertion  | t <sub>RWL</sub>  | $4.75\times T_C-4.3$  | 55.1                 | _            | 43.2                      | _            | ns             |
| 148 | WR assertion to CAS deassertion   | t <sub>CWL</sub>  | $3.75\times T_{C}-4.3$  | 42.6                 | _            | 33.2                      | _            | ns             |
| 149 | Data valid to CAS assertion (write)   | t <sub>DS</sub>   | $0.5 \times T_C - 4.8$  | 1.5                  | _            | 0.2                       | _            | ns             |
| 150 | CAS assertion to data not valid (write)   | t <sub>DH</sub>   | $3.5\times T_C-4.0$   | 39.8                 | _            | 31.0                      | _            | ns             |
| 151 | WR assertion to CAS assertion   | t <sub>WCS</sub>  | $1.25 \times T_{C} - 4.3$   | 11.3                 | _            | 8.2                       | _            | ns             |
| 152 | Last RD assertion to RAS deassertion  | t <sub>ROH</sub>  | $4.5\times T_C-4.0$   | 52.3                 | _            | 41.0                      | _            | ns             |
| 153 | RD assertion to data valid  | t <sub>GA</sub>   | $3.25 \times T_C - 5.7$   | _                    | 34.9         | _                         | 26.8         | ns             |
| 154 | RD deassertion to data not valid <sup>6</sup>   | t <sub>GZ</sub>   |   | 0.0                  | _            | 0.0                       |              | ns             |
| 155 | WR assertion to data active   |                   | $0.75 \times T_{C} - 1.5$   | 7.9                  | _            | 6.0                       | _            | ns             |
| 156 | WR deassertion to data high impedance   |                   | $0.25\times T_{\hbox{\scriptsize C}}$   | -                    | 3.1          | _                         | 2.5          | ns             |

- Notes: 1. The number of wait states for Page mode access is specified in the DCR.
  - 2. The refresh period is specified in the DCR.
  - The asynchronous delays specified in the expressions are valid for DSP56301.
  - All the timings are calculated for the worst case. Some of the timings are better for specific cases (for example,  $t_{PC}$  equals  $3 \times T_C$  for read-after-read or write-after-write sequences).
  - BRW[1-0] (DRAM control register bits) defines the number of wait states that should be inserted in each DRAM out-of-page access. N/A = does not apply because 100 MHz requires a minimum of three wait states.
  - RD deassertion always occurs after CAS deassertion; therefore, the restricted timing is t<sub>OFF</sub> and not t<sub>GZ</sub>.

2-19 Freescale Semiconductor

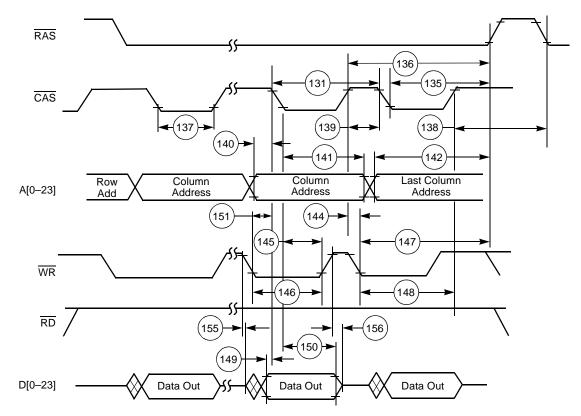


Figure 2-15. DRAM Page Mode Write Accesses

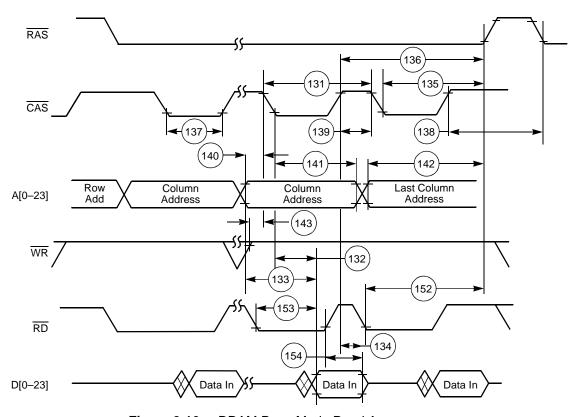


Figure 2-16. DRAM Page Mode Read Accesses

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2-20 Freescale Semiconductor

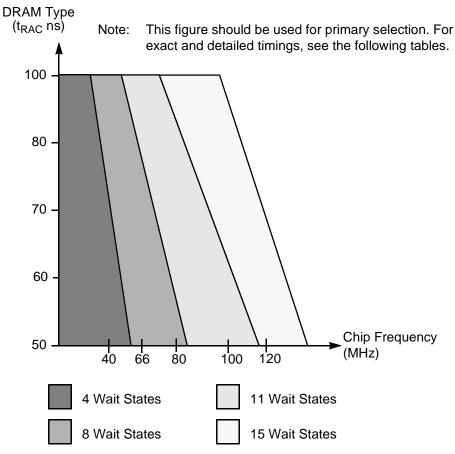


Figure 2-17. DRAM Out-of-Page Wait States Selection Guide

**Table 2-12.** DRAM Out-of-Page and Refresh Timings, Eight Wait States<sup>1, 2</sup>

| Na  |  | Cumbal           | Funnasian                 | 1 08  | ИНz  | l l m i t |
|-----|--|------------------|---------------------------|-------|------|-----------|
| No. | Characteristics <sup>3</sup>                       | Symbol           | Expression                | Min   | Max  | Unit      |
| 157 | Random read or write cycle time                    | t <sub>RC</sub>  | 9×T <sub>C</sub>          | 112.5 | _    | ns        |
| 158 | RAS assertion to data valid (read)                 | t <sub>RAC</sub> | $4.75 \times T_{C} - 6.5$ | _     | 52.9 | ns        |
| 159 | CAS assertion to data valid (read)                 | t <sub>CAC</sub> | $2.25\times T_C-6.5$      | _     | 21.6 | ns        |
| 160 | Column address valid to data valid (read)          | t <sub>AA</sub>  | $3 \times T_C - 6.5$      | _     | 31.0 | ns        |
| 161 | CAS deassertion to data not valid (read hold time) | t <sub>OFF</sub> |                           | 0.0   | _    | ns        |
| 162 | RAS deassertion to RAS assertion                   | t <sub>RP</sub>  | $3.25\times T_C-4.0$      | 36.6  | _    | ns        |
| 163 | RAS assertion pulse width                          | t <sub>RAS</sub> | $5.75\times T_C-4.0$      | 67.9  | _    | ns        |
| 164 | CAS assertion to RAS deassertion                   | t <sub>RSH</sub> | $3.25\times T_{C}-4.0$    | 36.6  | _    | ns        |
| 165 | RAS assertion to CAS deassertion                   | t <sub>CSH</sub> | $4.75\times T_C-4.0$      | 55.4  | _    | ns        |
| 166 | CAS assertion pulse width                          | t <sub>CAS</sub> | $2.25\times T_C-4.0$      | 24.1  | _    | ns        |
| 167 | RAS assertion to CAS assertion                     | t <sub>RCD</sub> | $2.5 \times T_C \pm 2$    | 29.3  | 33.3 | ns        |
| 168 | RAS assertion to column address valid              | t <sub>RAD</sub> | $1.75\times T_{C}\pm 2$   | 19.9  | 23.9 | ns        |
| 169 | CAS deassertion to RAS assertion                   | t <sub>CRP</sub> | $4.25\times T_C-4.0$      | 49.1  | _    | ns        |
| 170 | CAS deassertion pulse width                        | t <sub>CP</sub>  | $2.75\times T_{C}-6.0$    | 28.4  |      | ns        |
| 171 | Row address valid to RAS assertion                 | t <sub>ASR</sub> | $3.25 \times T_{C} - 4.0$ | 36.6  |      | ns        |

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### **Specifications**

DRAM Out-of-Page and Refresh Timings, Eight Wait States<sup>1, 2</sup> (Continued) Table 2-12.

| Na  |   | Comple al        | Fygge                        | 80 1  | ИНz  | l lm!t |
|-----|---|------------------|------------------------------|-------|------|--------|
| No. | Characteristics <sup>3</sup>  | Symbol           | Expression                   | Min   | Max  | Unit   |
| 172 | RAS assertion to row address not valid                                    | t <sub>RAH</sub> | $1.75 \times T_{C} - 4.0$    | 17.9  | _    | ns     |
| 173 | Column address valid to CAS assertion                                     | t <sub>ASC</sub> | $0.75 \times T_{C} - 4.0$    | 5.4   | _    | ns     |
| 174 | CAS assertion to column address not valid                                 | t <sub>CAH</sub> | $3.25\times T_C-4.0$         | 36.6  | _    | ns     |
| 175 | RAS assertion to column address not valid                                 | t <sub>AR</sub>  | $5.75\times T_C-4.0$         | 67.9  | _    | ns     |
| 176 | Column address valid to RAS deassertion                                   | t <sub>RAL</sub> | $4 \times T_C - 4.0$         | 46.0  | _    | ns     |
| 177 | WR deassertion to CAS assertion   | t <sub>RCS</sub> | $2 \times T_C - 3.8$         | 21.2  | _    | ns     |
| 178 | $\overline{\text{CAS}}$ deassertion to $\overline{\text{WR}}^4$ assertion | t <sub>RCH</sub> | $1.25\times T_C-3.7$         | 11.9  | _    | ns     |
| 179 | RAS deassertion to WR <sup>4</sup> assertion                              | t <sub>RRH</sub> | $0.25\times T_C-2.6$         | 0.5   | _    | ns     |
| 180 | CAS assertion to WR deassertion   | t <sub>WCH</sub> | $3 \times T_C - 4.2$         | 33.3  | _    | ns     |
| 181 | RAS assertion to WR deassertion   | t <sub>WCR</sub> | $5.5 \times T_C - 4.2$       | 64.6  | _    | ns     |
| 182 | WR assertion pulse width  | t <sub>WP</sub>  | $8.5\times T_C-4.5$          | 101.8 | _    | ns     |
| 183 | WR assertion to RAS deassertion   | t <sub>RWL</sub> | $8.75\times T_C-4.3$         | 105.1 | _    | ns     |
| 184 | WR assertion to CAS deassertion   | t <sub>CWL</sub> | $7.75\times T_C-4.3$         | 92.6  | _    | ns     |
| 185 | Data valid to CAS assertion (write)                                       | t <sub>DS</sub>  | $4.75 \times T_{C} - 4.0$    | 55.4  | _    | ns     |
| 186 | CAS assertion to data not valid (write)                                   | t <sub>DH</sub>  | $3.25\times T_C-4.0$         | 36.6  | _    | ns     |
| 187 | RAS assertion to data not valid (write)                                   | t <sub>DHR</sub> | $5.75\times T_C-4.0$         | 67.9  | _    | ns     |
| 188 | WR assertion to CAS assertion   | t <sub>WCS</sub> | $5.5 \times T_C - 4.3$       | 64.5  | _    | ns     |
| 189 | CAS assertion to RAS assertion (refresh)                                  | t <sub>CSR</sub> | $1.5\times T_{\text{C}}-4.0$ | 14.8  | _    | ns     |
| 190 | RAS deassertion to CAS assertion (refresh)                                | t <sub>RPC</sub> | $1.75 \times T_{C} - 4.0$    | 17.9  | _    | ns     |
| 191 | RD assertion to RAS deassertion   | t <sub>ROH</sub> | $8.5 \times T_C - 4.0$       | 102.3 | _    | ns     |
| 192 | RD assertion to data valid  | t <sub>GA</sub>  | $7.5 \times T_{C} - 6.5$     | _     | 87.3 | ns     |
| 193 | RD deassertion to data not valid <sup>3</sup>                             | t <sub>GZ</sub>  |                              | 0.0   | _    | ns     |
| 194 | WR assertion to data active   |                  | $0.75 \times T_{C} - 1.5$    | 7.9   | _    | ns     |
| 195 | WR deassertion to data high impedance                                     |                  | $0.25 \times T_{C}$          | _     | 3.1  | ns     |

Notes:

- The number of wait states for an out-of-page access is specified in the DCR.  $\underline{\text{The}} \text{ refresh period is specified in the } \underline{\text{DCR}}.$ 1.
- $\overline{\text{RD}}$  deassertion always occurs after  $\overline{\text{CAS}}$  deassertion; therefore, the restricted timing is  $t_{\text{OFF}}$  and not  $t_{\text{GZ}}$ .
- Either t<sub>RCH</sub> or t<sub>RRH</sub> must be satisfied for read cycles.

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 Table 2-13.
 DRAM Out-of-Page and Refresh Timings, Eleven Wait States<sup>1, 2</sup>

|     | 21 3   |                  |   | 80 1  | ИНz  | 100   | MHz       |          |
|-----|--|------------------|---|-------|------|-------|-----------|----------|
| No. | Characteristics <sup>3</sup>                       | Symbol           | Expression  | Min   | Max  | Min   | Max       | Unit     |
| 157 | Random read or write cycle time                    | t <sub>RC</sub>  | 12 × T <sub>C</sub>   | 150.0 | _    | 120.0 | _         | ns       |
| 158 | RAS assertion to data valid (read)                 | t <sub>RAC</sub> |   | _     | 71.6 | _     | _<br>55.5 | ns<br>ns |
| 159 | CAS assertion to data valid (read)                 | t <sub>CAC</sub> | $80 \text{ MHz}: \\ 3.75 \times T_{\text{C}} - 6.5 \\ \textbf{100 MHz}: \\ 3.75 \times T_{\text{C}} - 7.0$        | _     | 40.4 | _     | _<br>30.5 | ns<br>ns |
| 160 | Column address valid to data valid (read)          | t <sub>AA</sub>  | 80 MHz:<br>$4.5 \times T_{C} - 6.5$<br>100 MHz:<br>$4.5 \times T_{C} - 7.0$                                       | _<br> | 49.8 | _     | _<br>38.0 | ns       |
| 161 | CAS deassertion to data not valid (read hold time) | t <sub>OFF</sub> |   | 0.0   | _    | 0.0   | _         | ns       |
| 162 | RAS deassertion to RAS assertion                   | t <sub>RP</sub>  | $4.25 \times T_{C} - 4.0$   | 49.1  | _    | 38.5  | _         | ns       |
| 163 | RAS assertion pulse width                          | t <sub>RAS</sub> | $7.75 \times T_{C} - 4.0$   | 92.9  | _    | 73.5  | _         | ns       |
| 164 | CAS assertion to RAS deassertion                   | t <sub>RSH</sub> | 5.25 × T <sub>C</sub> – 4.0   | 61.6  | _    | 48.5  | _         | ns       |
| 165 | RAS assertion to CAS deassertion                   | t <sub>CSH</sub> | $6.25 \times T_{C} - 4.0$   | 74.1  | _    | 58.5  | _         | ns       |
| 166 | CAS assertion pulse width                          | t <sub>CAS</sub> | $3.75 \times T_{C} - 4.0$   | 42.9  | _    | 33.5  | _         | ns       |
| 167 | RAS assertion to CAS assertion                     | t <sub>RCD</sub> | $2.5 \times T_C \pm 4.0$  | 27.3  | 35.3 | 21.0  | 29.0      | ns       |
| 168 | RAS assertion to column address valid              | t <sub>RAD</sub> | $1.75 \times T_{C} \pm 4.0$   | 17.9  | 25.9 | 13.5  | 21.5      | ns       |
| 169 | CAS deassertion to RAS assertion                   | t <sub>CRP</sub> | 5.75 × T <sub>C</sub> – 4.0   | 67.9  | _    | 53.5  | _         | ns       |
| 170 | CAS deassertion pulse width                        | t <sub>CP</sub>  | $4.25 \times T_{C} - 6.0$   | 49.1  | _    | 36.5  | _         | ns       |
| 171 | Row address valid to RAS assertion                 | t <sub>ASR</sub> | $4.25 \times T_{C} - 4.0$   | 49.1  | _    | 38.5  | _         | ns       |
| 172 | RAS assertion to row address not valid             | t <sub>RAH</sub> | 1.75 × T <sub>C</sub> – 4.0   | 17.9  | _    | 13.5  | _         | ns       |
| 173 | Column address valid to CAS assertion              | t <sub>ASC</sub> | $0.75\times T_C-4.0$  | 5.4   | _    | 3.5   |           | ns       |
| 174 | CAS assertion to column address not valid          | t <sub>CAH</sub> | $5.25\times T_{C}-4.0$  | 61.6  | _    | 48.5  |           | ns       |
| 175 | RAS assertion to column address not valid          | t <sub>AR</sub>  | $7.75\times T_C-4.0$  | 92.9  | _    | 73.5  |           | ns       |
| 176 | Column address valid to RAS deassertion            | t <sub>RAL</sub> | $6 \times T_C - 4.0$  | 71.0  | _    | 56.0  | _         | ns       |
| 177 | WR deassertion to CAS assertion                    | t <sub>RCS</sub> | $3.0\times T_{C}-4.0$   | 33.5  | _    | 26.0  | _         | ns       |
| 178 | CAS deassertion to WR <sup>4</sup> assertion       | t <sub>RCH</sub> | $1.75\times T_C-3.7$  | 17.9  | _    | 13.8  | _         | ns       |
| 179 | RAS deassertion to WR <sup>4</sup> assertion       | t <sub>RRH</sub> | $\begin{array}{c} \textbf{80 MHz}:\\ 0.25\times T_{C}-2.6\\ \textbf{100 MHz}:\\ 0.25\times T_{C}-2.0 \end{array}$ | 0.5   | _    | 0.5   | _         | ns<br>ns |
| 180 | CAS assertion to WR deassertion                    | t <sub>WCH</sub> | $5 \times T_{C} - 4.2$  | 58.3  |      | 45.8  |           | ns       |
| 181 | RAS assertion to WR deassertion                    | t <sub>WCR</sub> | $7.5 \times T_{C} - 4.2$  | 89.6  | _    | 70.8  | _         | ns       |
| 182 | WR assertion pulse width                           | t <sub>WP</sub>  | $11.5 \times T_{C} - 4.5$   | 139.3 |      | 110.5 | _         | ns       |
| 183 | WR assertion to RAS deassertion                    | t <sub>RWL</sub> | 11.75 × T <sub>C</sub> – 4.3  | 142.7 | _    | 113.2 | _         | ns       |
| 184 | WR assertion to CAS deassertion                    | t <sub>CWL</sub> | $10.25 \times T_{C} - 4.3$  | 123.8 | _    | 98.2  | _         | ns       |
| 185 | Data valid to CAS assertion (write)                | t <sub>DS</sub>  | 5.75 × T <sub>C</sub> – 4.0   | 67.9  | _    | 53.5  | _         | ns       |
| 186 | CAS assertion to data not valid (write)            | t <sub>DH</sub>  | 5.25 × T <sub>C</sub> – 4.0   | 61.6  | _    | 48.5  | _         | ns       |

**Table 2-13.** DRAM Out-of-Page and Refresh Timings, Eleven Wait States<sup>1, 2</sup> (Continued)

| N.a. | Characteristics <sup>3</sup>                  | Comple of        | Fygge  | 1 08  | ИНz   | 100   | MHz  | l lm!t   |
|------|---|------------------|--|-------|-------|-------|------|----------|
| No.  | Characteristics                               | Symbol           | Expression   | Min   | Max   | Min   | Max  | Unit     |
| 187  | RAS assertion to data not valid (write)       | t <sub>DHR</sub> | $7.75 \times T_{C} - 4.0$  | 92.9  | _     | 73.5  | _    | ns       |
| 188  | WR assertion to CAS assertion                 | t <sub>WCS</sub> | $6.5 \times T_C - 4.3$   | 77.0  | _     | 60.7  | _    | ns       |
| 189  | CAS assertion to RAS assertion (refresh)      | t <sub>CSR</sub> | $1.5 \times T_C - 4.0$   | 14.8  | _     | 11.0  | _    | ns       |
| 190  | RAS deassertion to CAS assertion (refresh)    | t <sub>RPC</sub> | $2.75\times T_C-4.0$   | 30.4  | _     | 23.5  | _    | ns       |
| 191  | RD assertion to RAS deassertion               | t <sub>ROH</sub> | 11.5 × T <sub>C</sub> – 4.0  | 139.8 | _     | 111.0 | _    | ns       |
| 192  | RD assertion to data valid                    | t <sub>GA</sub>  | <b>80 MHz</b> : $10 \times T_C - 6.5$ <b>100 MHz</b> : $10 \times T_C - 7.0$ | _     | 118.5 | _     | 93.0 | ns<br>ns |
| 193  | RD deassertion to data not valid <sup>3</sup> | t <sub>GZ</sub>  | 10 % 10 7.0  | 0.0   | _     | 0.0   | _    | ns       |
| 194  | WR assertion to data active                   |                  | $0.75 \times T_{C} - 1.5$  | 9.1   | _     | 6.0   | _    | ns       |
| 195  | WR deassertion to data high impedance         |                  | 0.25 × T <sub>C</sub>  | _     | 3.1   | _     | 2.5  | ns       |

- 1. The number of wait states for an out-of-page access is specified in the DCR.
- 2. The refresh period is specified in the DCR.
- 3.  $\overline{RD}$  deassertion always occurs after  $\overline{CAS}$  deassertion; therefore, the restricted timing is  $t_{OFF}$  and not  $t_{GZ}$ .
- 4. Either  $t_{RCH}$  or  $t_{RRH}$  must be satisfied for read cycles.

**Table 2-14.** DRAM Out-of-Page and Refresh Timings, Fifteen Wait States<sup>1, 2</sup>

| No. | Characteristics <sup>3</sup>                       | Symbol           | Everencies   | 80 1  | ИHz  | 100   | MHz  | Unit |
|-----|--|------------------|--|-------|------|-------|------|------|
| NO. | Characteristics                                    | Symbol           | Expression   | Min   | Max  | Min   | Max  | Unit |
| 157 | Random read or write cycle time                    | t <sub>RC</sub>  | 16 × T <sub>C</sub>  | 200.0 | _    | 160.0 | _    | ns   |
| 158 | RAS assertion to data valid (read)                 | t <sub>RAC</sub> | <b>80 MHz</b> : $8.25 \times T_C - 6.5$ <b>100 MHz</b> : $0.25 \times T_C = 5.7$ | _     | 96.6 |       | _    | ns   |
|     | <u> </u>   |                  | $8.25 \times T_{C} - 5.7$  | _     | _    | _     | 76.8 | ns   |
| 159 | CAS assertion to data valid (read)                 | t <sub>CAC</sub> | <b>80 MHz</b> :<br>4.75 × T <sub>C</sub> – 6.5<br><b>100 MHz</b> :               | _     | 52.9 | _     | _    | ns   |
|     |  |                  | $4.75 \times T_{C} - 5.7$  | _     | _    | _     | 41.8 | ns   |
| 160 | Column address valid to data valid (read)          | t <sub>AA</sub>  | <b>80 MHz</b> :<br>5.5 × T <sub>C</sub> – 6.5<br><b>100 MHz</b> :                | _     | 62.3 | _     | _    | ns   |
|     |  |                  | $5.5 \times T_C - 5.7$   | _     | _    | _     | 49.3 | ns   |
| 161 | CAS deassertion to data not valid (read hold time) | t <sub>OFF</sub> | 0.0  | 0.0   |      | 0.0   | _    | ns   |
| 162 | RAS deassertion to RAS assertion                   | t <sub>RP</sub>  | $6.25\times T_C-4.0$   | 74.1  | _    | 58.5  | _    | ns   |
| 163 | RAS assertion pulse width                          | t <sub>RAS</sub> | $9.75\times T_C-4.0$   | 117.9 | _    | 93.5  | _    | ns   |
| 164 | CAS assertion to RAS deassertion                   | t <sub>RSH</sub> | $6.25\times T_C-4.0$   | 74.1  | 1    | 58.5  | _    | ns   |
| 165 | RAS assertion to CAS deassertion                   | t <sub>CSH</sub> | $8.25\times T_{\text{C}}-4.0$  | 99.1  | 1    | 78.5  | _    | ns   |
| 166 | CAS assertion pulse width                          | t <sub>CAS</sub> | $4.75 \times T_{C} - 4.0$  | 55.4  | 1    | 43.5  | _    | ns   |
| 167 | RAS assertion to CAS assertion                     | t <sub>RCD</sub> | $3.5 \times T_C \pm 2$   | 41.8  | 45.8 | 33.0  | 37.0 | ns   |
| 168 | RAS assertion to column address valid              | t <sub>RAD</sub> | $2.75 \times T_{\text{C}} \pm 2.0$   | 32.4  | 36.4 | 25.5  | 29.5 | ns   |
| 169 | CAS deassertion to RAS assertion                   | t <sub>CRP</sub> | $7.75 \times T_{C} - 4.0$  | 92.9  | _    | 73.5  | _    | ns   |

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DRAM Out-of-Page and Refresh Timings, Fifteen Wait States<sup>1, 2</sup> (Continued) Table 2-14.

|     | OL  |                  | <b>-</b>   | 80 1  | ИHz   | 100      | MHz   |          |
|-----|---|------------------|--|-------|-------|----------|-------|----------|
| No. | Characteristics <sup>3</sup>  | Symbol           | Expression   | Min   | Max   | Min      | Max   | Unit     |
| 170 | CAS deassertion pulse width   | t <sub>CP</sub>  | $6.25 \times T_{C} - 6.0$  | 74.1  | _     | 56.5     | _     | ns       |
| 171 | Row address valid to RAS assertion  | t <sub>ASR</sub> | $6.25 \times T_{C} - 4.0$  | 74.1  | _     | 58.5     | _     | ns       |
| 172 | RAS assertion to row address not valid                                    | t <sub>RAH</sub> | $2.75 \times T_{C} - 4.0$  | 30.4  | _     | 23.5     | _     | ns       |
| 173 | Column address valid to CAS assertion                                     | t <sub>ASC</sub> | $0.75 \times T_{C} - 4.0$  | 5.4   | _     | 3.5      | _     | ns       |
| 174 | CAS assertion to column address not valid                                 | t <sub>CAH</sub> | $6.25 \times T_{C} - 4.0$  | 74.1  | _     | 58.5     | _     | ns       |
| 175 | RAS assertion to column address not valid                                 | t <sub>AR</sub>  | $9.75 \times T_{C} - 4.0$  | 117.9 | _     | 93.5     | _     | ns       |
| 176 | Column address valid to RAS deassertion                                   | t <sub>RAL</sub> | $7 \times T_C - 4.0$   | 83.5  | _     | 66.0     | _     | ns       |
| 177 | WR deassertion to CAS assertion   | t <sub>RCS</sub> | 5 × T <sub>C</sub> – 3.8   | 58.7  | _     | 46.2     | _     | ns       |
| 178 | $\overline{\text{CAS}}$ deassertion to $\overline{\text{WR}}^4$ assertion | t <sub>RCH</sub> | $1.75 \times T_{C} - 3.7$  | 18.2  | _     | 13.8     | _     | ns       |
| 179 | RAS deassertion to WR <sup>4</sup> assertion                              | <sup>t</sup> RRH | <b>80 MHz</b> : $0.25 \times T_C - 2.6$ <b>100 MHz</b> : $0.25 \times T_C - 2.0$ | 0.5   |       | —<br>0.5 | _     | ns<br>ns |
| 180 | CAS assertion to WR deassertion   | t <sub>WCH</sub> | $6 \times T_C - 4.2$   | 70.8  | _     | 55.8     | _     | ns       |
| 181 | RAS assertion to WR deassertion   | t <sub>WCR</sub> | $9.5 \times T_{C} - 4.2$   | 114.6 | _     | 90.8     | _     | ns       |
| 182 | WR assertion pulse width  | t <sub>WP</sub>  | 15.5 × T <sub>C</sub> – 4.5  | 189.3 | _     | 150.5    | _     | ns       |
| 183 | WR assertion to RAS deassertion   | t <sub>RWL</sub> | 15.75 × T <sub>C</sub> – 4.3   | 192.6 | _     | 153.2    | _     | ns       |
| 184 | WR assertion to CAS deassertion   | t <sub>CWL</sub> | 14.25 × T <sub>C</sub> – 4.3   | 173.8 | _     | 138.2    | _     | ns       |
| 185 | Data valid to CAS assertion (write)                                       | t <sub>DS</sub>  | $8.75 \times T_{C} - 4.0$  | 105.4 | _     | 83.5     | _     | ns       |
| 186 | CAS assertion to data not valid (write)                                   | t <sub>DH</sub>  | $6.25 \times T_{C} - 4.0$  | 74.1  | _     | 58.5     | _     | ns       |
| 187 | RAS assertion to data not valid (write)                                   | t <sub>DHR</sub> | 9.75 × T <sub>C</sub> – 4.0  | 117.9 | _     | 93.5     | _     | ns       |
| 188 | WR assertion to CAS assertion   | t <sub>WCS</sub> | $9.5 \times T_C - 4.3$   | 114.5 | _     | 90.7     | _     | ns       |
| 189 | CAS assertion to RAS assertion (refresh)                                  | t <sub>CSR</sub> | 1.5 × T <sub>C</sub> – 4.0   | 14.8  | _     | 11.0     | _     | ns       |
| 190 | RAS deassertion to CAS assertion (refresh)                                | t <sub>RPC</sub> | $4.75 \times T_{C} - 4.0$  | 55.4  | _     | 43.5     | _     | ns       |
| 191 | RD assertion to RAS deassertion   | t <sub>ROH</sub> | 15.5 × T <sub>C</sub> – 4.0  | 189.8 | _     | 151.0    | _     | ns       |
| 192 | RD assertion to data valid  | t <sub>GA</sub>  | 80 MHz: $14 \times T_C - 6.5$ 100 MHz:   | _     | 168.5 | _        | _     | ns       |
|     |   |                  | $14 \times T_C - 5.7$  |       | _     | _        | 134.3 | ns       |
| 193 | RD deassertion to data not valid <sup>3</sup>                             | t <sub>GZ</sub>  |  | 0.0   | _     | 0.0      | _     | ns       |
| 194 | WR assertion to data active   |                  | $0.75 \times T_{C} - 1.5$  | 9.1   | _     | 6.0      | _     | ns       |
| 195 | WR deassertion to data high impedance                                     |                  | $0.25 \times T_{C}$  | _     | 3.1   | _        | 2.5   | ns       |

- The number of wait states for an out-of-page access is specified in the DCR.
- The refresh period is specified in the DCR.
- $\overline{RD}$  deassertion always occurs after  $\overline{CAS}$  deassertion; therefore, the restricted timing is  $t_{OFF}$  and not  $t_{GZ}$ .
- Either  $t_{RCH}$  or  $t_{RRH}$  must be satisfied for read cycles.

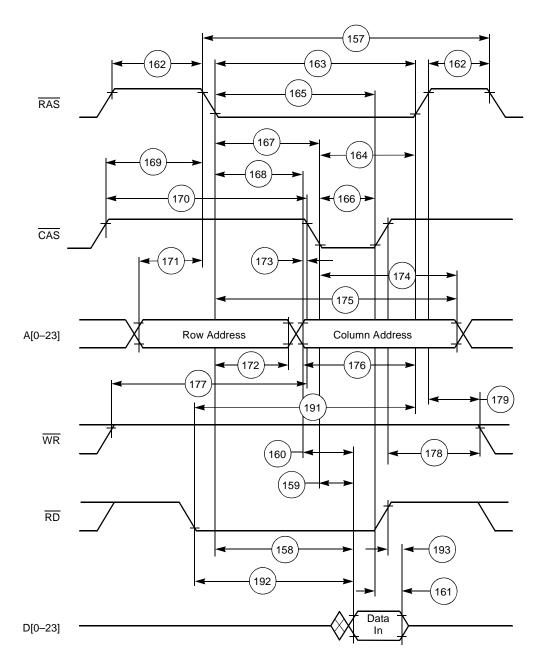


Figure 2-18. DRAM Out-of-Page Read Access

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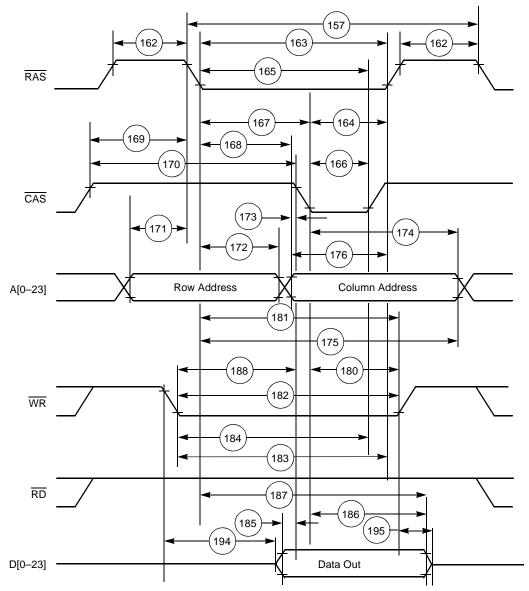


Figure 2-19. DRAM Out-of-Page Write Access

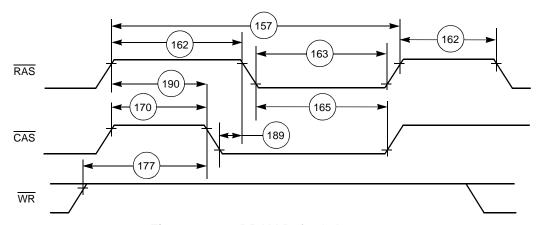


Figure 2-20. DRAM Refresh Access

## 2.5.5.3 Synchronous Timings (SRAM)

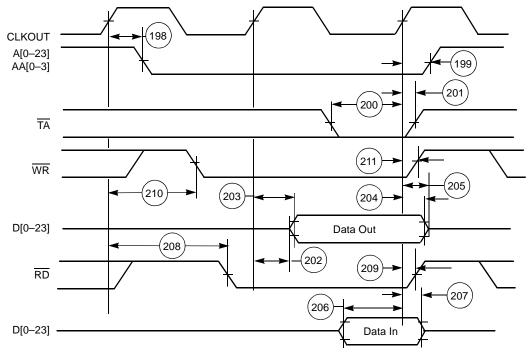
**Table 2-15.** External Bus Synchronous Timings (SRAM Access)<sup>3</sup>

| NI - | Oh avantavintina                                    | F  | 80 1         | MHz         | 100        | MHz        | Unit     |  |
|------|---|--|--------------|-------------|------------|------------|----------|--|
| No.  | Characteristics                                     | Expression <sup>1,2</sup>  | Min          | Max         | Min        | Max        | Unit     |  |
| 196  | CLKOUT high to BS assertion                         | $0.25 \times T_{C} + 5.2 / -0.5$   | 2.6          | 8.3         | 2.0        | 7.7        | ns       |  |
| 197  | CLKOUT high to BS deassertion                       | $0.75 \times T_{C} + 4.2 / -1.0$   | 8.4          | 13.6        | 6.5        | 11.7       | ns       |  |
| 198  | CLKOUT high to address, and AA valid <sup>4</sup>   | $0.25 \times T_{C} + 2.5$  | _            | 5.6         | _          | 5.0        | ns       |  |
| 199  | CLKOUT high to address, and AA invalid <sup>4</sup> | $0.25 \times T_{C} - 0.7$  | 2.4          | _           | 1.8        | _          | ns       |  |
| 200  | TA valid to CLKOUT high (setup time)                |  | 5.8          | _           | 4.0        | _          | ns       |  |
| 201  | CLKOUT high to TA invalid (hold time)               |  | 0.0          | _           | 0.0        | _          | ns       |  |
| 202  | CLKOUT high to data out active                      | 0.25 × T <sub>C</sub>  | 3.1          | _           | 2.5        | _          | ns       |  |
| 203  | CLKOUT high to data out valid                       |  |              | 7.6<br>—    | _          | —<br>6.5   | ns<br>ns |  |
| 204  | CLKOUT high to data out invalid                     | 0.25 × T <sub>C</sub>  | 3.1          | _           | 2.5        | _          | ns       |  |
| 205  | CLKOUT high to data out high impedance              | $\begin{array}{c} \textbf{80 MHz:} \\ 0.25 \times T_{\text{C}} + 0.5 \\ \textbf{100 MHz:} \\ 0.25 \times T_{\text{C}} \end{array}$ | <br> -<br> - | 3.6         | _          | _<br>2.5   | ns<br>ns |  |
| 206  | Data in valid to CLKOUT high (setup)                |  | 5.0          | _           | 4.0        | _          | ns       |  |
| 207  | CLKOUT high to data in invalid (hold)               |  | 0.0          | _           | 0.0        | _          | ns       |  |
| 208  | CLKOUT high to RD assertion                         | maximum:<br>0.75 × T <sub>C</sub> + 2.5  | 10.4         | 11.9        | 6.7        | 10.0       | ns<br>ns |  |
| 209  | CLKOUT high to RD deassertion                       |  | 0.0          | 4.5         | 0.0        | 4.0        | ns       |  |
| 210  | CLKOUT high to WR assertion <sup>2</sup>            | $0.5 \times T_C + 4.3$<br>[WS = 1 or WS $\geq$ 4]<br>[2 $\leq$ WS $\leq$ 3]  | 7.6<br>1.3   | 10.6<br>4.8 | 4.5<br>0.0 | 9.3<br>4.3 | ns<br>ns |  |
| 211  | CLKOUT high to WR deassertion                       | [2 2 440 2 0]  | 0.0          | 4.3         | 0.0        | 3.8        | ns       |  |

Notes:

- 1. WS is the number of wait states specified in the BCR.
- 2. If WS > 1,  $\overline{\text{WR}}$  assertion refers to the next rising edge of CLKOUT.
- 3. External bus synchronous timings should be used only for reference to the clock and *not* for relative timings.
- 4. T198 and T199 are valid for Address Trace mode if the ATE bit in the Operating Mode Register is set. Use the status of BR (See T212) to determine whether the access referenced by A[0–23] is internal or external in this mode.

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**Note**: Address lines A[0–23] hold their state after a read or write operation. AA[0–3] do not hold their state after a read or write operation.

CLKOUT A[0-23] **\_**199 AA[0-3] 201 201 200 TA 211 WR 205 203 204 D[0-23] Data Out 202 208 (209 RD (207 (206 Data In D[0-23]

Figure 2-21. Synchronous Bus Timings 1 WS (BCR Controlled)

**Note**: Address lines A[0–23] hold their state after a read or write operation. AA[0–3] do not hold their state after a read or write operation.

Figure 2-22. Synchronous Bus Timings 2 WS (TA Controlled)

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# 2.5.5.4 Arbitration Timings

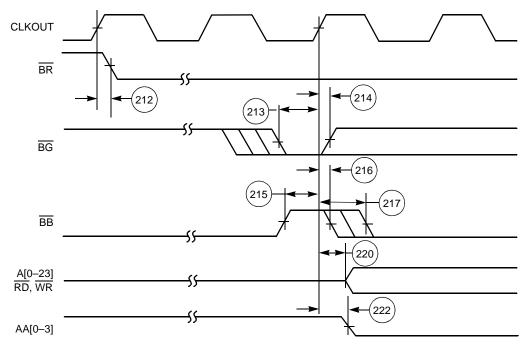
**Table 2-16.** Arbitration Bus Timings<sup>1</sup>.

| No. | Characteristics   | Expression <sup>2</sup>          | 80 1 | MHz | 100 | MHz | Unit  |
|-----|---|----------------------------------|------|-----|-----|-----|-------|
| NO. | Characteristics   | Expression                       | Min  | Max | Min | Max | Offic |
| 212 | CLKOUT high to BR assertion/deassertion <sup>3</sup>      |                                  | 1.0  | 4.5 | 0.0 | 4.0 | ns    |
| 213 | BG asserted/deasserted to CLKOUT high (setup)             |                                  | 5.0  | _   | 4.0 | _   | ns    |
| 214 | CLKOUT high to $\overline{BG}$ deasserted/asserted (hold) |                                  | 0.0  | _   | 0.0 | _   | ns    |
| 215 | BB deassertion to CLKOUT high (input setup)               |                                  | 5.0  | _   | 4.0 | _   | ns    |
| 216 | CLKOUT high to BB assertion (input hold)                  |                                  | 0.0  | _   | 0.0 | _   | ns    |
| 217 | CLKOUT high to BB assertion (output)                      |                                  | 1.0  | 4.5 | 0.0 | 4.0 | ns    |
| 218 | CLKOUT high to BB deassertion (output)                    |                                  | 1.0  | 4.5 | 0.0 | 4.0 | ns    |
| 219 | BB high to BB high impedance (output)                     |                                  | _    | 5.6 | _   | 4.5 | ns    |
| 220 | CLKOUT high to address and controls active                | 0.25 × T <sub>C</sub>            | 3.1  | _   | 2.5 | _   | ns    |
| 221 | CLKOUT high to address and controls high impedance        | 0.75 × T <sub>C</sub>            | _    | 9.4 | _   | 7.5 | ns    |
| 222 | CLKOUT high to AA active                                  | 0.25 × T <sub>C</sub>            | 3.1  | _   | 2.5 | _   | ns    |
| 223 | CLKOUT high to AA deassertion                             | maximum: $0.25 \times T_C + 4.0$ | 4.1  | 7.1 | 2.0 | 6.5 | ns    |
| 224 | CLKOUT high to AA high impedance                          | $0.75 \times T_{\mathbb{C}}$     |      | 9.4 | _   | 7.5 | ns    |

#### Notes:

- 1. Synchronous Bus Arbitration is not recommended. Use Asynchronous mode whenever possible.
- 2. An expression is used to compute the maximum or minimum value listed, as appropriate. For timing 223, the minimum is an absolute value.
- 3. T212 is valid for Address Trace mode when the ATE bit in the Operating Mode Register is set. BR is deasserted for internal accesses and asserted for external accesses.

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**Note**: Address lines A[0–23] hold their state after a read or write operation. AA[0–3] do not hold their state after a read or write operation.

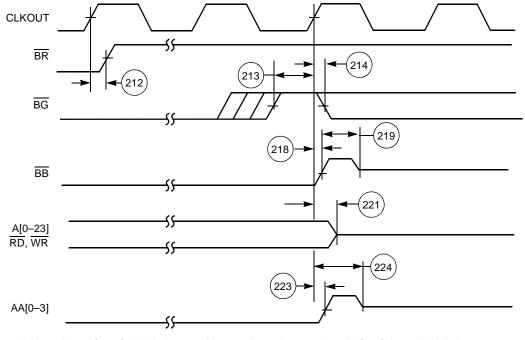
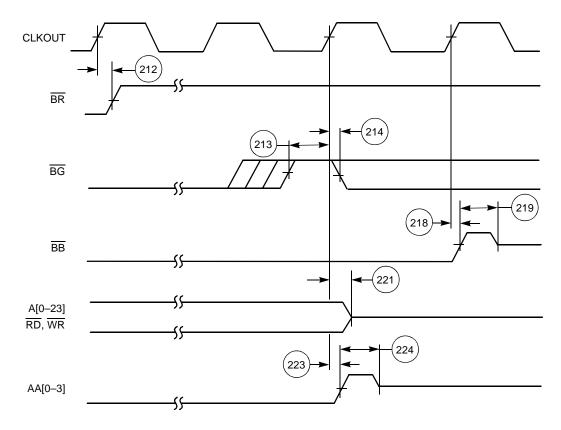


Figure 2-23. Bus Acquisition Timings

Note: Address lines A[0-23] hold their state after a read or write operation. AA[0-3] do not hold their state after a read or write operation.

Figure 2-24. Bus Release Timings Case 1 (BRT Bit in Operating Mode Register Cleared)



**Note:** Address lines A[0–23] hold their state after a read or write operation. AA[0–3] do not hold their state after a read or write operation.

Figure 2-25. Bus Release Timings Case 2 (BRT Bit in Operating Mode Register Set)

### 2.5.5.5 Asynchronous Bus Arbitrations Timings

**Table 2-17.** Asynchronous Bus Arbitration Timing<sup>1,3</sup>

| No. Characteristics | Characteristics  | Expression   | 80 MHz |     | 100 I | Unit |      |
|---------------------|--|--------------|--------|-----|-------|------|------|
|                     | Onaraciensiles   | Expression   | Min    | Max | Min   | Max  | Onic |
| 250                 | BB assertion window from BG input deassertion <sup>4</sup> | 2.5 × Tc + 5 | _      | 25  |       | 30   | ns   |
| 251                 | Delay from BB assertion to BG assertion <sup>4</sup>       | 2 × Tc + 5   | 25     | _   | 25    | _    | ns   |

Notes:

- 1. Bit 13 in the Operating Mode Register must be set to enter Asynchronous Arbitration mode.
- 2. Asynchronous Arbitration mode is recommended for operation at 100 MHz.
- 3. If Asynchronous Arbitration mode is active, none of the timings in **Table 2-16** is required.
- 4. In order to guarantee timings 250, and 251,  $\overline{\text{BG}}$  inputs must be asserted to different DSP56300 devices on the same bus in the non-overlap manner shown in **Figure 2-26**.

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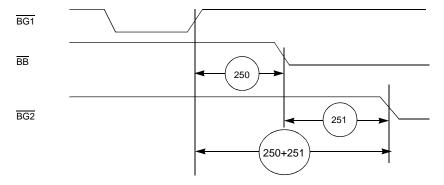


Figure 2-26. Asynchronous Bus Arbitration Timing

The asynchronous bus arbitration is enabled by internal  $\overline{BB}$  inputs and synchronization circuits on  $\overline{BG}$ . These synchronization circuits add delay from the external signal until it is exposed to internal logic. As a result of this delay, a DSP56300 part can assume mastership and assert  $\overline{BB}$ , for some time after  $\overline{BG}$  is deasserted. Timing 250 defines when  $\overline{BB}$  can be asserted.

Once  $\overline{BB}$  is asserted, there is a synchronization delay from  $\overline{BB}$  assertion to the time this assertion is exposed to other DSP56300 components which are potential masters on the same bus. If  $\overline{BG}$  input is asserted before that time, a situation of  $\overline{BG}$  asserted, and  $\overline{BB}$  deasserted, can cause another DSP56300 component to assume mastership at the same time. Therefore, a non-overlap period between one  $\overline{BG}$  input active to another  $\overline{BG}$  input active is required. Timing 251 ensures that such a situation is avoided.

## 2.5.6 Host Interface Timing

| Table 2-18. | Universal E | Bus Mode | I iming I | -arameters |
|-------------|-------------|----------|-----------|------------|
|-------------|-------------|----------|-----------|------------|

|     | Observatoristis  | Farmanasian   | 80 1 | ИНz | 100  | MHz | 11!6     |
|-----|--|---|------|-----|------|-----|----------|
| No. | Characteristic   | Expression  | Min  | Max | Min  | Max | Unit     |
| 300 | Access Cycle Time  | 3×T <sub>C</sub>  | 37.5 | _   | 30.0 |     | ns       |
| 301 | HA[10–0], HAEN Setup to Data Strobe Assertion <sup>1</sup>                             |   | 5.8  | _   | 4.6  | I   | ns       |
| 302 | HA[10–0], HAEN Valid Hold from Data Strobe Deassertion <sup>1</sup>                    |   | 0.0  | _   | 0.0  | I   | ns       |
| 303 | HRW Setup to HDS Assertion <sup>2</sup>  |   | 5.8  | _   | 4.6  | _   | ns       |
| 304 | HRW Valid Hold from HDS Deassertion <sup>2</sup>                                       |   | 0.0  | _   | 0.0  | I   | ns       |
| 305 | Data Strobe Deasserted Width <sup>1</sup>  |   | 4.1  | _   | 3.3  | _   | ns       |
| 306 | Data Strobe Asserted Pulse Width <sup>1</sup>  | <b>80 MHz:</b> 2.5 × T <sub>C</sub> + 1.7<br><b>100 MHz:</b> 2.5 × T <sub>C</sub> + 1.3 | 32.9 | _   | 26.3 | _   | ns<br>ns |
| 307 | HBS Asserted Pulse Width   |   | 2.5  | _   | 2.0  | _   | ns       |
| 308 | HBS Assertion to Data Strobe Assertion <sup>1</sup>                                    | <b>80 MHz:</b> T <sub>C</sub> – 4.9<br><b>100 MHz:</b> T <sub>C</sub> – 4.0             | _    | 7.6 | _    | 6.0 | ns<br>ns |
| 309 | HBS Assertion to Data Strobe Deassertion <sup>1</sup>                                  | <b>80 MHz:</b> 2.5 × T <sub>C</sub> + 2.9<br><b>100 MHz:</b> 2.5 × T <sub>C</sub> + 2.3 | 34.1 | _   | 27.3 | _   | ns<br>ns |
| 310 | HBS Deassertion to Data Strobe Deassertion <sup>1</sup>                                | <b>80 MHz:</b> 1.5 × T <sub>C</sub> + 3.3<br><b>100 MHz:</b> 1.5 × T <sub>C</sub> + 2.6 | 22.1 | _   | 17.6 | _   | ns<br>ns |
| 311 | Data Out Valid to TA Assertion ( $\overline{\rm HBS}$ Not Used—Tied to $\rm V_{CC})^2$ | <b>80 MHz:</b> 2 × T <sub>C</sub> - 11.6<br><b>100 MHz:</b> 2 × T <sub>C</sub> - 9.2    | 13.4 | _   | 10.8 |     | ns<br>ns |
| 312 | Data Out Active from Read Data Strobe Assertion <sup>3</sup>                           |   | 1.7  | _   | 1.3  | _   | ns       |

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 Table 2-18.
 Universal Bus Mode Timing Parameters (Continued)

| No. | Characteristic  | Fyggesien   | 80 1 | ИНz  | 100  | MHz  | Unit     |
|-----|---|---|------|------|------|------|----------|
| NO. | Characteristic  | Expression  | Min  | Max  | Min  | Max  | Unit     |
| 313 | Data Out Valid from Read <u>Data</u> Strobe Assertion (No Wait States Inserted—HTA Asserted) <sup>3</sup> |   | _    | 18.9 | _    | 16.9 | ns       |
| 314 | Data Out Valid Hold from Read Data Strobe Deassertion <sub>3</sub>  |   | 1.7  | _    | 1.3  | _    | ns       |
| 315 | Data Out High Impedance from Read Data Strobe Deassertion <sup>3</sup>                                    |   | _    | 12.0 | _    | 9.6  | ns       |
| 316 | Data In Valid Setup to Write Data Strobe Deassertion <sup>4</sup>   |   | 8.3  | _    | 6.6  | _    | ns       |
| 317 | Data In Valid Hold from Write Data Strobe Deassertion <sup>4</sup>  |   | 0.0  | _    | 0.0  | _    | ns       |
| 318 | HSAK Assertion from Data Strobe Assertion <sup>1</sup>  |   | _    | 30.0 | _    | 30.0 | ns       |
| 319 | HSAK Asserted Hold from Data Strobe Deassertion <sup>1</sup>  |   | 2.0  | _    | 2.0  | _    | ns       |
| 320 | HTA Active from Data Strobe Assertion <sup>1,2,5</sup>  |   | 3.1  | _    | 2.5  | _    | ns       |
| 321 | HTA Assertion from Data Strobe Assertion (HBS Not Used—Tied to V <sub>CC</sub> ) <sup>1,2,5</sup>         | <b>80 MHz:</b> 2.0 × T <sub>C</sub> + 13.0<br><b>100 MHz:</b> 2.0 × T <sub>C</sub> + 12.2 | 38.0 | _    | 32.2 | _    | ns<br>ns |
| 322 | HTA Assertion from HBS Assertion <sup>2,5</sup>   | <b>80 MHz:</b> 2.0 × T <sub>C</sub> + 13.0<br><b>100 MHz:</b> 2.0 × T <sub>C</sub> + 12.2 | 38.0 | _    | 32.2 | _    | ns<br>ns |
| 323 | HTA Deasserted from Data Strobe Assertion <sup>1,2,5</sup>  |   | _    | 17.1 | _    | 15.0 | ns       |
| 324 | HTA Assertion to Data Strobe Deassertion <sup>1,2</sup>   |   | 0.0  | _    | 0.0  | _    | ns       |
| 325 | HTA High Impedance from Data Strobe Deassertion <sup>1,2</sup>  |   | _    | 15.3 | _    | 12.2 | ns       |
| 326 | HIRQ Asserted Pulse Width (HIRH = 0, HIRD = 1)  | $(LT + 1) \times T_C - 6.0^7$   | 19.0 | _    | 14.0 | _    | ns       |
| 327 | Data Strobe Deasserted Hold from HIRQ Deassertion (HIRH = 0) <sup>1</sup>                                 |   | 0.0  | _    | 0.0  | _    | ns       |
| 328 | HIRQ Asserted Hold from Data Strobe Assertion (HIRH = 1) <sup>1</sup>                                     | 1.5 × T <sub>C</sub>  | 18.8 | _    | 15.0 | _    | ns       |
| 329 | HIRQ Deassertion from Data Strobe Assertion (HIRH = 1, HIRD = 1) <sup>1</sup>                             | <b>80 MHz:</b> 2.5 × T <sub>C</sub> + 24.7<br>100 MHz: 2.5 × T <sub>C</sub> + 21.5        | _    | 55.9 | _    | 46.5 | ns<br>ns |
| 330 | HIRQ High Impedance from Data Strobe Assertion (HIRH = 1, HIRD = 0) <sup>1,6</sup>                        | <b>80 MHz:</b> 2.5 × T <sub>C</sub> + 24.7<br><b>100 MHz:</b> 2.5 × T <sub>C</sub> + 21.5 | _    | 55.9 | _    | 46.5 | ns<br>ns |
| 331 | HIRQ Active from Data Strobe Deassertion (HIRH = 1, HIRD = 0) <sup>1</sup>                                | 2.5 × T <sub>C</sub>  | 31.3 | _    | 25.0 | _    | ns       |
| 332 | HIRQ Deasserted Hold from Data Strobe Deassertion <sup>1</sup>  | 2.5 × T <sub>C</sub>  | 31.3 | _    | 25.0 | _    | ns       |
| 333 | HDRQ <sup>2</sup> Asserted Hold from Data Strobe Assertion <sup>1</sup>                                   | 1.5 × T <sub>C</sub>  | 18.8 | _    | 15.0 | _    | ns       |
| 334 | HDRQ <sup>2</sup> Deassertion from Data Strobe Assertion <sup>1</sup>                                     | <b>80 MHz:</b> 2.5 × T <sub>C</sub> + 24.7<br><b>100 MHz:</b> 2.5 × T <sub>C</sub> + 21.5 | _    | 55.9 | _    | 46.5 | ns<br>ns |
| 335 | HDRQ <sup>2</sup> Deasserted Hold from Data Strobe Deassertion <sup>1</sup>                               | <b>80 MHz:</b> 2.5 × T <sub>C</sub> + 3.7<br><b>100 MHz:</b> 2.5 × T <sub>C</sub> + 3.0   | 35.0 | _    | 28.0 | _    | ns<br>ns |
| 336 | HDAK Assertion to Data Strobe Assertion <sup>1</sup>  |   | 5.8  | _    | 4.6  | _    | ns       |
| 337 | HDAK Asserted Hold from Data Strobe Deassertion <sup>1</sup>  |   | 0.0  | _    | 0.0  | _    | ns       |
| 338 | HDBEN Deasserted Hold from Data Strobe Assertion <sup>1</sup>   |   | 2.5  | _    | 2.0  | _    | ns       |
| 339 | HDBEN Assertion from Data Strobe Assertion <sup>1</sup>   |   | _    | 22.2 | _    | 19.6 | ns       |
| 340 | HDBEN Asserted Hold from Data Strobe Deassertion <sup>1</sup>   |   | 2.5  | _    | 2.0  | _    | ns       |
| 341 | HDBEN Deassertion from Data Strobe Deassertion <sup>1</sup>   |   | _    | 22.2 | _    | 19.6 | ns       |
| 342 | HDBDR High Hold from Read Data Strobe Assertion <sup>3</sup>  |   | 2.5  | _    | 2.0  | _    | ns       |
| 343 | HDBDR Low from Read Data Strobe Assertion <sup>3</sup>  |   | _    | 22.2 | _    | 19.6 | ns       |
| 344 | HDBDR Low Hold from Read Data Strobe Deassertion <sup>3</sup>   |   | 2.5  | _    | 2.0  | _    | ns       |

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**Table 2-18.** Universal Bus Mode Timing Parameters (Continued)

| No. Characteristic | Characteristic   | Expression | 80 MHz Expression |      | 100 | Unit  |    |
|--------------------|--|------------|-------------------|------|-----|-------|----|
|                    | Expression   | Min        | Max               | Min  | Max | Ollit |    |
| 345                | HDBDR High from Read Data Strobe Deassertion <sup>3</sup>    |            |                   | 22.2 | _   | 19.6  | ns |
| 346                | HRST Assertion to Host Port Pins High Impedance <sup>2</sup> |            | 1                 | 22.2 | _   | 19.6  | ns |

- 1. The Data Strobe is  $\overline{\text{HRD}}$  or  $\overline{\text{HWR}}$  in the Dual Data Strobe mode and  $\overline{\text{HDS}}$  in the Single Data Strobe mode.
- 2. HTA, HDRQ, and HRST may be programmed as active-high or active-low. In the example timing diagrams, HDRQ and HRST are shown as active-high and HTA is shown as active low.
- 3. The Read Data Strobe is HRD in the Dual Data Strobe mode and HDS in the Single Data Strobe mode.
- 4. The Write Data Strobe is  $\overline{HWR}$  in the Dual Data Strobe mode and  $\overline{HDS}$  in the Single Data Strobe mode.
- 5. HTA requires an external pull-down resistor if programmed as active high (HTAP = 0); or an external pull-up resistor if programmed as active low (HTAP = 1). The resistor value should be consistent with the DC specifications.
- **6.** HIRQ requires an external pull-up resistor if programmed as open drain (HIRD = 0). The resistor value should be consistent with the DC specifications.
- 7. "LT" is the value of the latency timer register (CLAT) as programmed by the user during self configuration.  $LT \ge 1$ .
- **8.** Values are valid for  $V_{CC} = 3.3 \pm 0.3 V$

**Table 2-19.** Universal Bus Mode, Synchronous Port A Type Host Timing

|     | 01  |   | 80 I | MHz  | 100  | MHz  |          |
|-----|---|---|------|------|------|------|----------|
| No. | Characteristic  | Expression  | Min  | Max  | Min  | Max  | Unit     |
| 300 | Access Cycle Time   | $3 \times T_{C}$  | 37.5 | _    | 30.0 | _    | ns       |
| 301 | HA[10-0], HAEN Setup to Data Strobe Assertion <sup>1</sup>  |   | 5.8  | _    | 4.6  | _    | ns       |
| 302 | HA[10–0], HAEN Valid Hold from Data Strobe Deassertion <sup>1</sup>                                       |   | 0.0  | _    | 0.0  | _    | ns       |
| 305 | Data Strobe Deasserted Width <sup>1</sup>   |   | 4.1  | _    | 3.3  | _    | ns       |
| 307 | HBS Asserted Pulse Width  |   | 2.5  | _    | 2.0  | _    | ns       |
| 308 | HBS Assertion to Data Strobe Assertion <sup>1</sup>   | <b>80 MHz:</b> T <sub>C</sub> – 4.9<br><b>100 MHz:</b> T <sub>C</sub> – 4.0               | _    | 7.6  | _    | 6.0  | ns<br>ns |
| 309 | HBS Assertion to Data Strobe Deassertion <sup>1</sup>   | <b>80 MHz:</b> 2.5 × T <sub>C</sub> + 2.9<br><b>100 MHz:</b> 2.5 × T <sub>C</sub> + 2.3   | 34.1 | _    | 27.3 | _    | ns<br>ns |
| 310 | HBS Deassertion to Data Strobe Deassertion <sup>1</sup>   | <b>80 MHz:</b> 1.5 × T <sub>C</sub> + 3.3<br><b>100 MHz:</b> 1.5 × T <sub>C</sub> + 2.6   | 22.1 | _    | 17.6 | _    | ns<br>ns |
| 312 | Data Out Active from Read Data Strobe Assertion <sup>3</sup>  |   | 1.7  | _    | 1.3  | _    | ns       |
| 313 | Data Out Valid from Read <u>Data</u> Strobe Assertion (No Wait States Inserted—HTA Asserted) <sup>3</sup> |   | _    | 18.9 | _    | 16.9 | ns       |
| 314 | Data Out Valid Hold from Read Data Strobe Deassertion <sub>3</sub>  |   | 1.7  | _    | 1.3  | _    | ns       |
| 315 | Data Out High Impedance from Read Data Strobe Deassertion <sup>3</sup>                                    |   | _    | 12.0 | _    | 9.6  | ns       |
| 316 | Data In Valid Setup to Write Data Strobe Deassertion <sup>4</sup>   |   | 8.3  | _    | 6.6  | _    | ns       |
| 317 | Data In Valid Hold from Write Data Strobe Deassertion <sup>4</sup>  |   | 0.0  | _    | 0.0  | _    | ns       |
| 324 | HTA Assertion to Data Strobe Deassertion <sup>1,2</sup>   |   | 0.0  | _    | 0.0  | _    | ns       |
| 325 | HTA High Impedance from Data Strobe Deassertion <sup>1,2</sup>  |   | _    | 15.3 | _    | 12.2 | ns       |
| 326 | HIRQ Asserted Pulse Width (HIRH = 0, HIRD = 1)  | $(LT + 1) \times T_C - 6.0^7$   | 6.5  | _    | 4.0  | _    | ns       |
| 327 | Data Strobe Deasserted Hold from HIRQ Deassertion (HIRH = 0) <sup>1</sup>                                 |   | 0.0  | _    | 0.0  | _    | ns       |
| 328 | HIRQ Asserted Hold from Data Strobe Assertion (HIRH = 1) <sup>1</sup>                                     | 1.5 × T <sub>C</sub>  | 18.8 | _    | 15.0 | _    | ns       |
| 329 | HIRQ Deassertion from Data Strobe Assertion (HIRH = 1, HIRD = 1) <sup>1</sup>                             | <b>80 MHz:</b> 2.5 × T <sub>C</sub> + 24.7<br><b>100 MHz:</b> 2.5 × T <sub>C</sub> + 21.5 |      | 55.9 |      | 46.5 | ns<br>ns |

Table 2-19. Universal Bus Mode, Synchronous Port A Type Host Timing (Continued)

| No. | Characteristic   | Evaracian   | 80 MHz |      | 100  | MHz  | Unit     |
|-----|--|---|--------|------|------|------|----------|
| NO. | Characteristic   | Expression  | Min    | Max  | Min  | Max  | Unit     |
| 330 | HIRQ High Impedance from Data Strobe Assertion (HIRH = 1, HIRD = 0) <sup>1,6</sup> | <b>80 MHz:</b> 2.5 × T <sub>C</sub> + 24.7<br><b>100 MHz:</b> 2.5 × T <sub>C</sub> + 21.5 |        | 55.9 | _    | 46.5 | ns<br>ns |
| 331 | HIRQ Active from Data Strobe Deassertion (HIRH = 1, HIRD = 0) <sup>1</sup>         | 2.5 × T <sub>C</sub>  | 31.3   | _    | 25.0 | _    | ns       |
| 332 | HIRQ Deasserted Hold from Data Strobe Deassertion <sup>1</sup>                     | 2.5 × T <sub>C</sub>  | 31.3   | _    | 25.0 | _    | ns       |
| 346 | HRST Assertion to Host Port Pins High Impedance <sup>2</sup>                       |   | _      | 22.2 | _    | 19.6 | ns       |
| 347 | HBS Assertion to CLKOUT Rising Edge  |   | 4.3    | _    | 3.4  | _    | ns       |
| 348 | Data Strobe Deassertion to CLKOUT Rising Edge <sup>1</sup>                         |   | 7.4    | _    | 5.9  | _    | ns       |

- 1. The Data Strobe is HRD or HWR in the Dual Data Strobe mode and HDS in the Single Data Strobe mode.
- 2. HTA, HDRQ, and HRST may be programmed as active-high or active-low. In the example timing diagrams, HDRQ and HRST are shown as active-high and HTA is shown as active low.
- 3. The Read Data Strobe is  $\overline{\text{HRD}}$  in the Dual Data Strobe mode and  $\overline{\text{HDS}}$  in the Single Data Strobe mode.
- 4. The Write Data Strobe is  $\overline{\text{HWR}}$  in the Dual Data Strobe mode and  $\overline{\text{HDS}}$  in the Single Data Strobe mode.
- 5. HTA requires an external pull-down resistor if programmed as active high (HTAP = 0); or an external pull-up resistor if programmed as active low (HTAP = 1). The resistor value should be consistent with the DC specifications.
- **6.** HIRQ requires an external pull-up resistor if programmed as open drain (HIRD = 0). The resistor value should be consistent with the DC specifications.
- 7. "LT" is the value of the latency timer register (CLAT) as programmed by the user during self configuration.
- **8.** Values are valid for  $V_{CC} = 3.3 \pm 0.3 V$

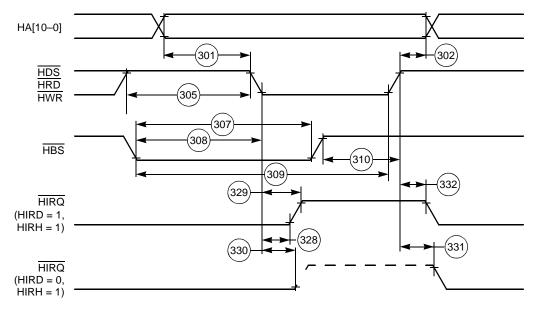


Figure 2-27. Universal Bus Mode I/O Access Timing

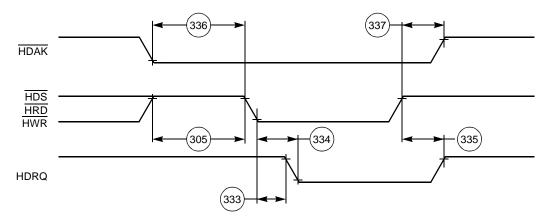


Figure 2-28. Universal Bus Mode DMA Access Timing

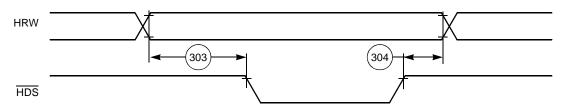


Figure 2-29. HRW to HDS Timing

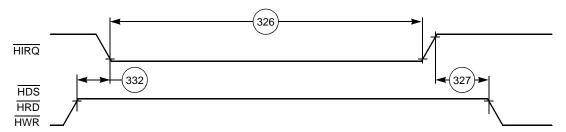


Figure 2-30.  $\overline{HIRQ}$  Pulse Width (HIRH = 0)

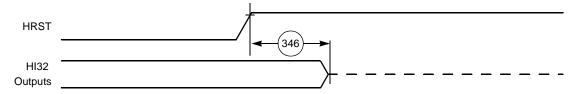


Figure 2-31. HRST Timing

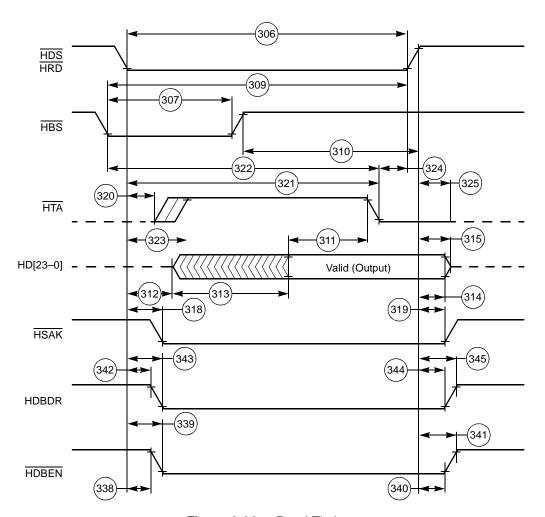


Figure 2-32. Read Timing

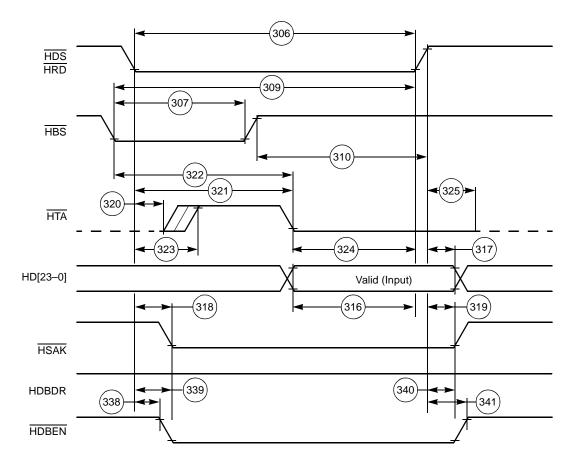


Figure 2-33. Write Timing

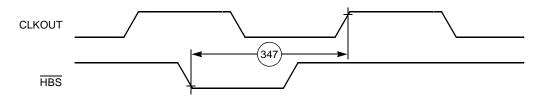


Figure 2-34. HBS Synchronous Timing

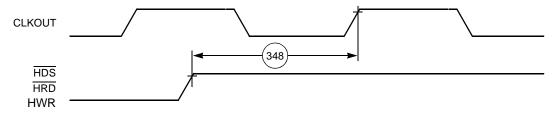


Figure 2-35. Data Strobe Synchronous Timing

**Table 2-20.** PCI Mode Timing Parameters<sup>1</sup>

| NI - | Observation 10                            | 0                     | 80 N       | ИHz  | 100        | 100 MHz |      |
|------|---|-----------------------|------------|------|------------|---------|------|
| No.  | Characteristic <sup>10</sup>              | Symbol                | Min        | Max  | Min        | Max     | Unit |
| 349  | HCLK to Signal Valid Delay—Bussed Signals | t <sub>VAL</sub>      | 2.0        | 11.0 | 2.0        | 11.0    | ns   |
| 350  | HCLK to Signal Valid Delay—Point to Point | t <sub>VAL(ptp)</sub> | 2.0        | 12.0 | 2.0        | 12.0    | ns   |
| 351  | Float to Active Delay                     | t <sub>ON</sub>       | 2.0        | _    | 2.0        | _       | ns   |
| 352  | Active to Float Delay                     | t <sub>OFF</sub>      | _          | 28.0 | _          | 28.0    | ns   |
| 353  | Input Set Up Time to HCLK—Bussed Signals  | t <sub>SU</sub>       | 7.0        | _    | 7.0        | _       | ns   |
| 354  | Input Set Up Time to HCLK—Point to Point  | t <sub>SU(ptp)</sub>  | 10.0, 12.0 | _    | 10.0, 12.0 | _       | ns   |
| 355  | Input Hold Time from HCLK                 | t <sub>H</sub>        | 0.0        | _    | 0.0        | _       | ns   |
| 356  | Reset Active Time After Power Stable      | t <sub>RST</sub>      | 1.0        | _    | 1.0        | _       | ms   |
| 357  | Reset Active Time After HCLK Stable       | t <sub>RST-CLK</sub>  | 100.0      |      | 100.0      | _       | μs   |
| 358  | Reset Active to Output Float Delay        | t <sub>RST-OFF</sub>  | _          | 40.0 | _          | 40.0    | ns   |
| 359  | HCLK Cycle Time                           | t <sub>CYC</sub>      | 30.0       | _    | 30.0       | _       | ns   |
| 360  | HCLK High Time                            | t <sub>HIGH</sub>     | 11.0       | _    | 11.0       | _       | ns   |
| 361  | HCLK Low Time                             | t <sub>LOW</sub>      | 11.0       | _    | 11.0       | _       | ns   |

- 1. For standard PCI timing, see the PCI Local Bus Specification, Rev. 2.0, especially Chapters 3 and 4.
- 2. The HI32 supports these timings for a PCI bus operating at 33 MHz for a DSP clock frequency of 56 MHz and above. The DSP core operating frequency should be greater than 5/3 of the PCI bus frequency to maintain proper PCI operation.
- 3. HGNT has a setup time of 10 ns. HREQ has a setup time of 12 ns.

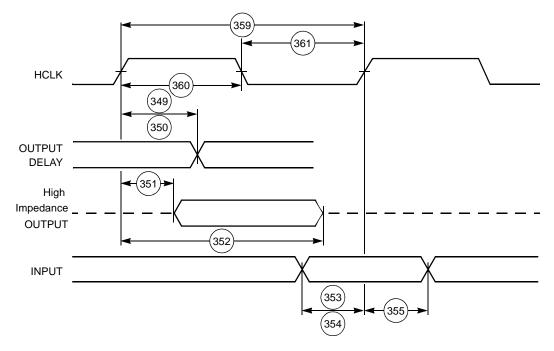


Figure 2-36. PCI Timing

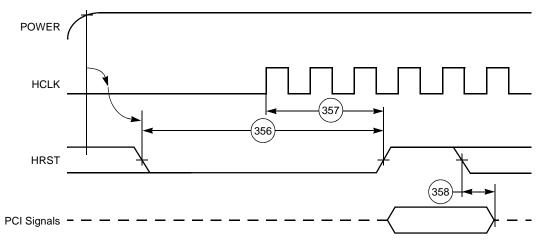


Figure 2-37. PCI Reset Timing

# 2.5.7 SCI Timing

Table 2-21. SCI Timing

|     |   |                               |                                     | 1 08  | ИНz  | 100   | MHz  |      |
|-----|---|-------------------------------|-------------------------------------|-------|------|-------|------|------|
| No. | Characteristics <sup>1</sup>                                    | Symbol                        | Expression                          | Min   | Max  | Min   | Max  | Unit |
| 400 | Synchronous clock cycle   | t <sub>SCC</sub> <sup>2</sup> | 8×T <sub>C</sub>                    | 100.0 | _    | 80.0  | _    | ns   |
| 401 | Clock low period  |                               | t <sub>SCC</sub> /2 – 10.0          | 40.0  | _    | 30.0  | _    | ns   |
| 402 | Clock high period   |                               | t <sub>SCC</sub> /2 - 10.0          | 40.0  | _    | 30.0  | _    | ns   |
| 403 | Output data setup to clock falling edge (internal clock)        |                               | $t_{SCC}/4 + 0.5 \times T_C - 17.0$ | 14.3  | _    | 8.0   | _    | ns   |
| 404 | Output data hold after clock rising edge (internal clock)       |                               | $t_{SCC}/4 - 0.5 \times T_{C}$      | 18.8  | _    | 15.0  | _    | ns   |
| 405 | Input data setup time before clock rising edge (internal clock) |                               | $t_{SCC}/4 + 0.5 \times T_C + 25.0$ | 56.3  | _    | 50.0  | _    | ns   |
| 406 | Input data not valid before clock rising edge (internal clock)  |                               | $t_{SCC}/4 + 0.5 \times T_C - 5.5$  | _     | 25.8 | _     | 19.5 | ns   |
| 407 | Clock falling edge to output data valid (external clock)        |                               |                                     | _     | 32.0 | _     | 32.0 | ns   |
| 408 | Output data hold after clock rising edge (external clock)       |                               | T <sub>C</sub> + 8.0                | 20.5  | _    | 18.0  | _    | ns   |
| 409 | Input data setup time before clock rising edge (external clock) |                               |                                     | 0.0   | _    | 0.0   | _    | ns   |
| 410 | Input data hold time after clock rising edge (external clock)   |                               |                                     | 9.0   | _    | 9.0   | _    | ns   |
| 411 | Asynchronous clock cycle  | t <sub>ACC</sub> 3            | 64 × T <sub>C</sub>                 | 800.0 | _    | 640.0 | _    | ns   |
| 412 | Clock low period  |                               | t <sub>ACC</sub> /2 - 10.0          | 390.0 | _    | 310.0 | _    | ns   |
| 413 | Clock high period   |                               | t <sub>ACC</sub> /2 - 10.0          | 390.0 | _    | 310.0 | _    | ns   |
| 414 | Output data setup to clock rising edge (internal clock)         |                               | t <sub>ACC</sub> /2 - 30.0          | 370.0 | _    | 290.0 | _    | ns   |
| 415 | Output data hold after clock rising edge (internal clock)       |                               | t <sub>ACC</sub> /2 - 30.0          | 370.0 | _    | 290.0 | _    | ns   |

Table 2-21. SCI Timing (Continued)

| No    | 01111   | Characteristics <sup>1</sup> Symbol Expression | Evarencies | 80 I | ИНz | 100 | I Init |  |
|-------|---|--|------------|------|-----|-----|--------|--|
| No.   | Characteristics   |  | Min        | Max  | Min | Max | Unit   |  |
| Notes | 1. $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ ; $T_J = -40^{\circ}\text{C}$ to +100 °C, | $C_1 = 50  pF$                                 |            |      |     |     |        |  |

- - $t_{SCC}$  = synchronous clock cycle time (For internal clock,  $t_{SCC}$  is determined by the SCI clock control register and  $t_{CC}$ )  $t_{ACC}$  = asynchronous clock cycle time; value given for 1X Clock mode (For internal clock,  $t_{ACC}$  is determined by the SCI clock control register and T<sub>C</sub>)

400

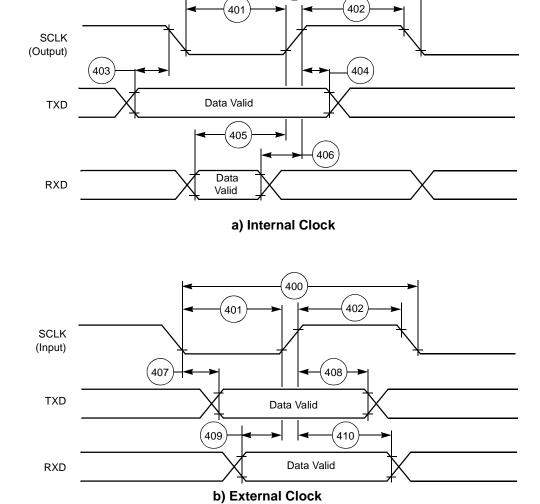


Figure 2-38. SCI Synchronous Mode Timing

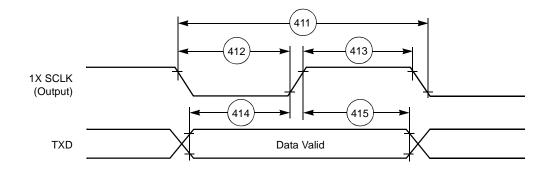


Figure 2-39. SCI Asynchronous Mode Timing

# 2.5.8 ESSI0/ESSI1 Timing

Table 2-22. ESSI Timings

|     | 0 457  |                    |   | 80 1         | ИНz          | 100          | MHz          | Cond-              |          |
|-----|--|--------------------|---|--------------|--------------|--------------|--------------|--------------------|----------|
| No. | Characteristics <sup>4, 5, 7</sup>                                   | Symbol             | Expression  | Min          | Max          | Min          | Max          | ition <sup>6</sup> | Unit     |
| 430 | Clock cycle <sup>1</sup>   | t <sub>SSICC</sub> | $\begin{array}{c} 3\times T_C \\ 4\times T_C \end{array}$ | 50.0<br>37.5 | _<br>_       | 30.0<br>40.0 | _<br>_       | x ck<br>i ck       | ns       |
| 431 | Clock high period<br>For internal clock<br>For external clock        |                    | $2 \times T_{C} - 10.0$ $1.5 \times T_{C}$                | 15.0<br>18.8 | _            | 10.0<br>15.0 | _            |                    | ns<br>ns |
| 432 | Clock low period<br>For internal clock<br>For external clock         |                    | 2 × T <sub>C</sub> - 10.0<br>1.5 × T <sub>C</sub>         | 15.0<br>18.8 | _            | 10.0<br>15.0 | _            |                    | ns<br>ns |
| 433 | RXC rising edge to FSR out (bl) high                                 |                    |   | _<br>_       | 37.0<br>22.0 | _            | 37.0<br>22.0 | x ck<br>i ck a     | ns       |
| 434 | RXC rising edge to FSR out (bl) low                                  |                    |   | _            | 37.0<br>22.0 | _            | 37.0<br>22.0 | x ck<br>i ck a     | ns       |
| 435 | RXC rising edge to FSR out (wr) high <sup>2</sup>                    |                    |   | _            | 39.0<br>24.0 | _            | 39.0<br>24.0 | x ck<br>i ck a     | ns       |
| 436 | RXC rising edge to FSR out (wr) low <sup>2</sup>                     |                    |   | _            | 39.0<br>24.0 | _            | 39.0<br>24.0 | x ck<br>i ck a     | ns       |
| 437 | RXC rising edge to FSR out (wl) high                                 |                    |   | _<br>_       | 36.0<br>21.0 | _            | 36.0<br>21.0 | x ck<br>i ck a     | ns       |
| 438 | RXC rising edge to FSR out (wl) low                                  |                    |   | _            | 37.0<br>22.0 | _            | 37.0<br>22.0 | x ck<br>i ck a     | ns       |
| 439 | Data in setup time before RXC (SCK in Synchronous mode) falling edge |                    |   | 10.0<br>19.0 | _            | 10.0<br>19.0 | _            | x ck<br>i ck       | ns       |
| 440 | Data in hold time after RXC falling edge                             |                    |   | 5.0<br>3.0   | _            | 5.0<br>3.0   | _            | x ck<br>i ck       | ns       |
| 441 | FSR input (bl, wr) high before RXC falling edge <sup>2</sup>         |                    |   | 1.0<br>23.0  | _            | 1.0<br>23.0  | _            | x ck<br>i ck a     | ns       |
| 442 | FSR input (wl) high before RXC falling edge                          |                    |   | 3.5<br>23.0  | _            | 3.5<br>23.0  | _            | x ck<br>i ck a     | ns       |
| 443 | FSR input hold time after RXC falling edge                           |                    |   | 3.0<br>0.0   | _            | 3.0<br>0.0   |              | x ck<br>i ck a     | ns       |
| 444 | Flags input setup before RXC falling edge                            |                    |   | 5.5<br>19.0  |              | 5.5<br>19.0  |              | x ck<br>i ck s     | ns       |

Table 2-22. ESSI Timings (Continued)

| No. | Characteristics <sup>4, 5, 7</sup>                                      | Symbol | Expression | 80 MHz      |              | 100 MHz     |              | Cond-              |      |
|-----|---|--------|------------|-------------|--------------|-------------|--------------|--------------------|------|
|     |   |        |            | Min         | Max          | Min         | Max          | ition <sup>6</sup> | Unit |
| 445 | Flags input hold time after RXC falling edge                            |        |            | 6.0<br>0.0  | _            | 6.0<br>0.0  | _            | x ck<br>i ck s     | ns   |
| 446 | TXC rising edge to FST out (bl) high                                    |        |            |             | 29.0<br>15.0 | _           | 29.0<br>15.0 | x ck<br>i ck       | ns   |
| 447 | TXC rising edge to FST out (bl) low                                     |        |            | _           | 31.0<br>17.0 | _           | 31.0<br>17.0 | x ck<br>i ck       | ns   |
| 448 | TXC rising edge to FST out (wr) high <sup>2</sup>                       |        |            | _           | 31.0<br>17.0 | _           | 31.0<br>17.0 | x ck<br>i ck       | ns   |
| 449 | TXC rising edge to FST out (wr) low <sup>2</sup>                        |        |            | _           | 33.0<br>19.0 | _           | 33.0<br>19.0 | x ck<br>i ck       | ns   |
| 450 | TXC rising edge to FST out (wl) high                                    |        |            | _           | 30.0<br>16.0 | _           | 30.0<br>16.0 | x ck<br>i ck       | ns   |
| 451 | TXC rising edge to FST out (wl) low                                     |        |            | _           | 31.0<br>17.0 | _           | 31.0<br>17.0 | x ck<br>i ck       | ns   |
| 452 | TXC rising edge to data out enable from high impedance                  |        |            | _           | 31.0<br>17.0 | _           | 31.0<br>17.0 | x ck<br>i ck       | ns   |
| 453 | TXC rising edge to Transmitter #0 drive enable assertion                |        |            | _           | 34.0<br>20.0 | _           | 34.0<br>20.0 | x ck<br>i ck       | ns   |
| 454 | TXC rising edge to data out valid <sup>8</sup>                          |        |            | _           | 20.0<br>10.0 | _           | 20.0<br>10.0 | x ck<br>i ck       | ns   |
| 455 | TXC rising edge to data out high impedance <sup>3</sup>                 |        |            | _           | 31.0<br>16.0 | _           | 31.0<br>16.0 | x ck<br>i ck       | ns   |
| 456 | TXC rising edge to Transmitter #0 drive enable deassertion <sup>3</sup> |        |            |             | 34.0<br>20.0 | _           | 34.0<br>20.0 | x ck<br>i ck       | ns   |
| 457 | FST input (bl, wr) setup time before TXC falling edge <sup>2</sup>      |        |            | 2.0<br>21.0 | _            | 2.0<br>21.0 | <u>-</u>     | x ck<br>i ck       | ns   |
| 458 | FST input (wl) to data out enable from high impedance                   |        |            | _           | 27.0         | _           | 27.0         | _                  | ns   |
| 459 | FST input (wl) to Transmitter #0 drive enable assertion                 |        |            | _           | 31.0         | _           | 31.0         | _                  | ns   |
| 460 | FST input (wl) setup time before TXC falling edge                       |        |            | 2.5<br>21.0 | _            | 2.5<br>21.0 | _            | x ck<br>i ck       | ns   |
| 461 | FST input hold time after TXC falling edge                              |        |            | 4.0<br>0.0  | _            | 4.0<br>0.0  |              | x ck<br>i ck       | ns   |
| 462 | Flag output valid after TXC rising edge                                 |        |            | _           | 32.0<br>18.0 | _           | 32.0<br>18.0 | x ck<br>i ck       | ns   |

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### Table 2-22. ESSI Timings (Continued)

| No. | Characteristics <sup>4, 5, 7</sup> | Symbol | Expression | 80 MHz |     | 100 MHz |     | Cond-              | 1111 |
|-----|------------------------------------|--------|------------|--------|-----|---------|-----|--------------------|------|
|     |                                    |        |            | Min    | Max | Min     | Max | ition <sup>6</sup> | Unit |

Notes:

- For the internal clock, the external clock cycle is defined by the instruction cycle time (timing 7 in **Table 2-5** on page 2-6) and the ESSI control register.
- 2. The word-relative frame sync signal waveform relative to the clock operates the same way as the bit-length frame sync signal waveform, but spreads from one serial clock before the first bit clock (same as Bit Length Frame Sync signal), until the one before the last bit clock of the first word in frame.
- 3. Periodically sampled and not 100 percent tested
- **4.**  $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ ;  $T_J = -40 ^{\circ}\text{C}$  to +100  $^{\circ}\text{C}$ ,  $C_L = 50 \text{ pF}$
- 5. TXC (SCK Pin) = Transmit Clock RXC (SC0 or SCK Pin) = Receive Clock

FST (SC2 Pin) = Transmit Frame Sync

FSR (SC1 or SC2 Pin) Receive Frame Sync

6. i ck = Internal Clock

x ck = External Clock

i ck a = Internal Clock, Asynchronous Mode

(Asynchronous implies that TXC and RXC are two different clocks)

i ck s = Internal Clock, Synchronous Mode

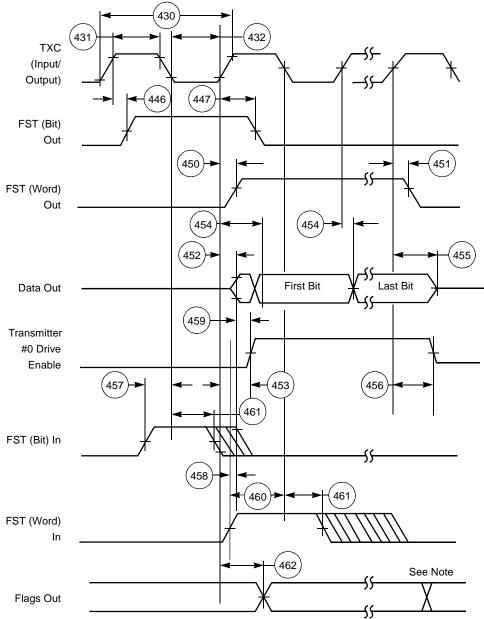
(Synchronous implies that TXC and RXC are the same clock)

7. bl = bit length

wl = word length

wr = word length relative

If the DSP core writes to the transmit register during the last cycle before causing an underrun error, the delay is 20 ns + (0.5 × T<sub>C</sub>).



**Note:** In Network mode, output flag transitions can occur at the start of each time slot within the frame. In Normal mode, the output flag state is asserted for the entire frame period.

Figure 2-40. ESSI Transmitter Timing

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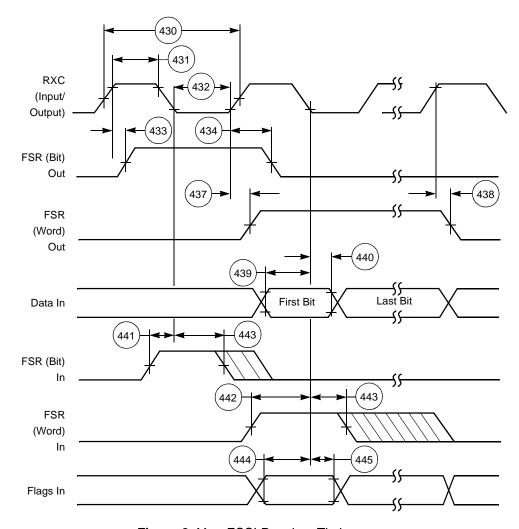


Figure 2-41. ESSI Receiver Timing

# 2.5.9 Timer Timing

Table 2-23. Timer Timing

| N.  | Characteristics  | F   | 1 08     | ИНz      | 100 MHz  |          | 11-26    |
|-----|--|---|----------|----------|----------|----------|----------|
| No. | Cnaracteristics  | Expression  | Min      | Max      | Min      | Max      | Unit     |
| 480 | TIO Low  | 2 × T <sub>C</sub> + 2.0                              | 27.0     | _        | 22.0     |          | ns       |
| 481 | TIO High   | 2 × T <sub>C</sub> + 2.0                              | 27.0     | _        | 22.0     |          | ns       |
| 482 | Timer setup time from TIO (Input) assertion to CLKOUT rising edge  |   | 9.0      | 12.5     | 9.0      | 10.0     | ns       |
| 483 | Synchronous timer delay time from CLKOUT rising edge to the external memory access address out valid caused by first interrupt instruction execution | $10.25 \times T_{C} + 1.0$                            | 129.1    | _        | 103.5    | _        | ns       |
| 484 | CLKOUT rising edge to TIO (Output) assertion  Minimum  Maximum   | $0.5 \times T_{C} + 0.5$<br>$0.5 \times T_{C} + 19.8$ | 9.8<br>— | <br>26.1 | 5.5<br>— | <br>24.8 | ns<br>ns |

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Table 2-23. Timer Timing (Continued)

| No.   | Characteristics   | Everession  | 80 MHz   |          | 100 MHz  |          | Unit     |
|-------|---|---|----------|----------|----------|----------|----------|
|       |   | Expression  | Min      | Max      | Min      | Max      |          |
| 485   | CLKOUT rising edge to TIO (Output) deassertion  Minimum  Maximum  | $0.5 \times T_{C} + 0.5$<br>$0.5 \times T_{C} + 19.8$ | 9.8<br>— | <br>26.1 | 5.5<br>— | <br>24.8 | ns<br>ns |
| Note: | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}; T_{J} = -40 ^{\circ}\text{C to } +100 ^{\circ}\text{C}, C_{L} = 50 \text{ pF}$ |   |          |          |          |          |          |

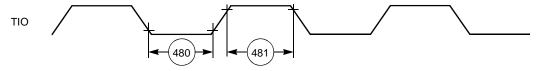


Figure 2-42. TIO Timer Event Input Restrictions

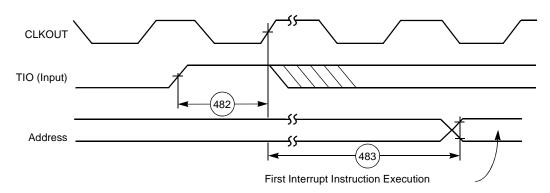


Figure 2-43. Timer Interrupt Generation

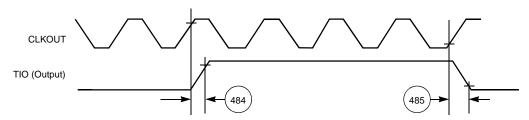


Figure 2-44. External Pulse Generation

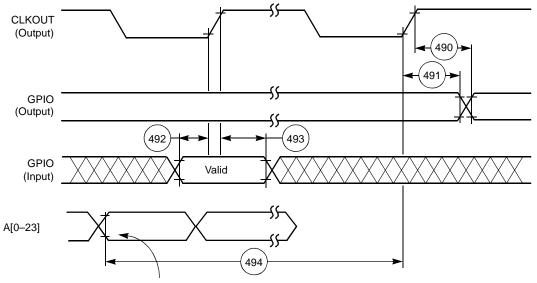
# 2.5.10 GPIO Timing

Table 2-24. GPIO Timing

| No.   | Characteristics  | Evarossion        | 80 MHz |      | 100 MHz |     | Unit  |
|-------|--|-------------------|--------|------|---------|-----|-------|
| NO.   | Cridiacteristics   | Expression        | Min    | Max  | Min     | Max | Ullit |
| 490   | CLKOUT edge to GPIO out valid (GPIO out delay time)  |                   | _      | 31.0 | _       | 8.5 | ns    |
| 491   | CLKOUT edge to GPIO out not valid (GPIO out hold time)   |                   | 0.0    | _    | 0.0     | _   | ns    |
| 492   | GPIO In valid to CLKOUT edge (GPIO in set-up time)   |                   | 8.5    | _    | 8.5     | _   | ns    |
| 493   | CLKOUT edge to GPIO in not valid (GPIO in hold time)   |                   | 0.0    | _    | 0.0     | _   | ns    |
| 494   | Fetch to CLKOUT edge before GPIO change  | $6.75 \times T_C$ | 84.4   | _    | 67.5    | _   | ns    |
| Note: | vite: $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ ; $T_J = -40 ^{\circ}\text{C}$ to +100 $^{\circ}\text{C}$ , $C_L = 50 \text{ pF}$ |                   |        |      |         |     |       |

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Fetch the instruction MOVE X0,X:(R0); X0 contains the new value of GPIO and R0 contains the address of GPIO data register.

Figure 2-45. GPIO Timing

## 2.5.11 JTAG Timing

Table 2-25. JTAG Timing

| Observatorists 12   | All freq   | Unit  |  |
|---|--|---|--|
| Characteristics   | Min  | Max   | Unit   |
| TCK frequency of operation (1/(T <sub>C</sub> × 3); maximum 22 MHz) | 0.0  | 22.0  | MHz  |
| TCK cycle time in Crystal mode                                      | 45.0   | _   | ns   |
| TCK clock pulse width measured at 1.5 V                             | 20.0   | _   | ns   |
| TCK rise and fall times   | 0.0  | 3.0   | ns   |
| Boundary scan input data setup time                                 | 5.0  | _   | ns   |
| Boundary scan input data hold time                                  | 24.0   | _   | ns   |
| TCK low to output data valid  | 0.0  | 40.0  | ns   |
| TCK low to output high impedance                                    | 0.0  | 40.0  | ns   |
| TMS, TDI data setup time  | 5.0  | _   | ns   |
| TMS, TDI data hold time   | 25.0   | _   | ns   |
| TCK low to TDO data valid   | 0.0  | 44.0  | ns   |
| TCK low to TDO high impedance                                       | 0.0  | 44.0  | ns   |
| TRST assert time  | 100.0  | _   | ns   |
| TRST setup time to TCK low  | 40.0   | _   | ns   |
|   | TCK cycle time in Crystal mode  TCK clock pulse width measured at 1.5 V  TCK rise and fall times  Boundary scan input data setup time  Boundary scan input data hold time  TCK low to output data valid  TCK low to output high impedance  TMS, TDI data setup time  TMS, TDI data hold time  TCK low to TDO data valid  TCK low to TDO high impedance | Characteristics 1,2           Min           TCK frequency of operation (1/(T <sub>C</sub> × 3); maximum 22 MHz)         0.0           TCK cycle time in Crystal mode         45.0           TCK clock pulse width measured at 1.5 V         20.0           TCK rise and fall times         0.0           Boundary scan input data setup time         5.0           Boundary scan input data hold time         24.0           TCK low to output data valid         0.0           TCK low to output high impedance         0.0           TMS, TDI data setup time         5.0           TMS, TDI data hold time         25.0           TCK low to TDO data valid         0.0           TCK low to TDO high impedance         0.0           TCK low to TDO high impedance         0.0           TRST assert time         100.0           TRST setup time to TCK low         40.0 | Min         Max           TCK frequency of operation (1/(T <sub>C</sub> × 3); maximum 22 MHz)         0.0         22.0           TCK cycle time in Crystal mode         45.0         —           TCK clock pulse width measured at 1.5 V         20.0         —           TCK rise and fall times         0.0         3.0           Boundary scan input data setup time         5.0         —           Boundary scan input data hold time         24.0         —           TCK low to output data valid         0.0         40.0           TCK low to output high impedance         0.0         40.0           TMS, TDI data setup time         5.0         —           TCK low to TDO data valid         0.0         44.0           TCK low to TDO high impedance         0.0         44.0           TCK low to TDO high impedance         0.0         44.0           TRST assert time         100.0         —           TRST setup time to TCK low         40.0         — |

**Notes:** 1.  $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ ;  $T_J = -40 ^{\circ}\text{C}$  to +100  $^{\circ}\text{C}$ ,  $C_L = 50 \text{ pF}$ 

2. All timings apply to OnCE module data transfers because it uses the JTAG port as an interface.

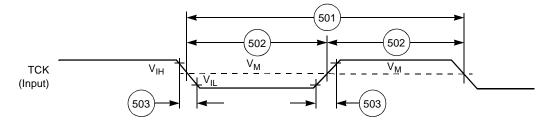


Figure 2-46. Test Clock Input Timing Diagram

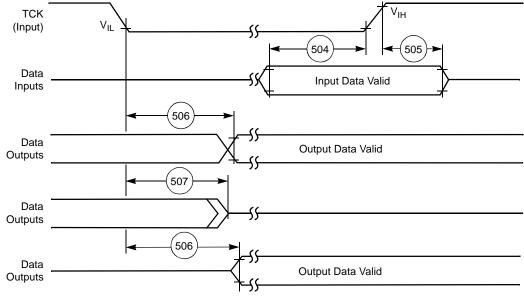


Figure 2-47. Boundary Scan (JTAG) Timing Diagram

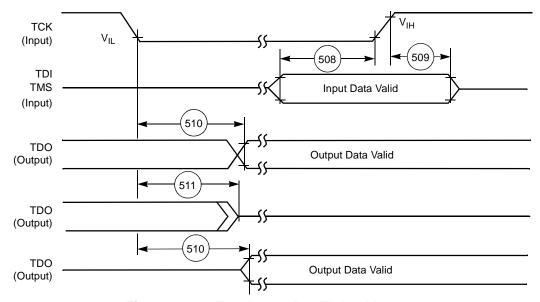


Figure 2-48. Test Access Port Timing Diagram

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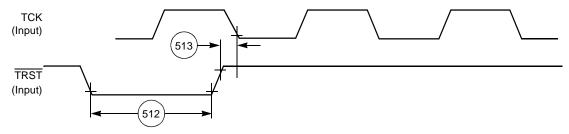


Figure 2-49. TRST Timing Diagram

# 2.5.12 OnCE Module TimIng

Table 2-26. OnCE Module Timing

| No.   | Characteristics   | <b>5</b>                                 | 80 MHz |      | 100  | 11!  |      |
|-------|---|--|--------|------|------|------|------|
| NO.   | Characteristics   | Expression                               | Min    | Max  | Min  | Max  | Unit |
| 500   | TCK frequency of operation  | 1/(T <sub>C</sub> × 3),<br>max: 22.0 MHz | 0.0    | 22.0 | 0.0  | 22.0 | MHz  |
| 514   | DE assertion time in order to enter Debug mode  | $1.5 \times T_{C} + 10.0$                | 28.8   | _    | 25.0 | _    | ns   |
| 515   | Response time when DSP56301 is executing NOP instructions from internal memory  | $5.5 \times T_{C} + 30.0$                | _      | 98.8 | _    | 85.0 | ns   |
| 516   | Debug acknowledge assertion time  | $3 \times T_C - 5.0$                     | 47.5   | _    | 25.0 | _    | ns   |
| Note: | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}; T_J = -40 ^{\circ}\text{C to } +100 ^{\circ}\text{C}, C_L = 50 \text{ pF}$ |  |        |      |      |      |      |

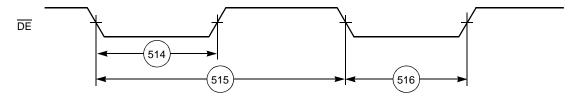


Figure 2-50. OnCE—Debug Request

**Specifications** 

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This section provides information on the available packages for the DSP56301, including diagrams of the package pinouts and tables showing how the signals discussed in **Section 1** are allocated for each package. The DSP56301 is available in two package types:

- 208-pin Thin Quad Flat Pack (TQFP)
- 252-pin Molded Array Process-Ball Grid Array (MAP-BGA)

**Note:** Both packages are available in lead-bearing and lead-free versions. Switching a design from a lead-bearing package device to a lead-free package device may require a change in the board manufacturing process. The lead-free package requires a higher solder flow temperature than the lead-bearing device. Refer to *Lead-Free BGA Solder Joint Assembly Evaluation* (EB635) for manufacturing considerations when incorporating lead-free package devices into a design.

## 3.1 TQFP Package Description

Top and bottom views of the TQFP package are shown in Figure 3-1 and Figure 3-2 with their pin-outs.

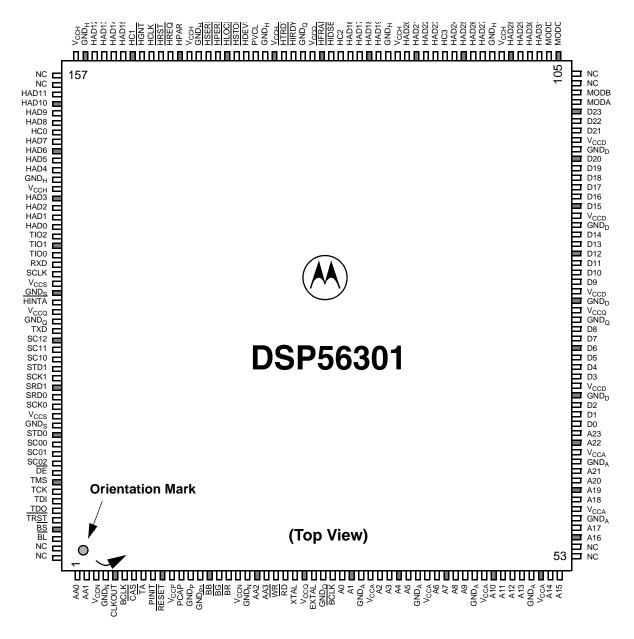


Figure 3-1. DSP56301 Thin Quad Flat Pack (TQFP), Top View

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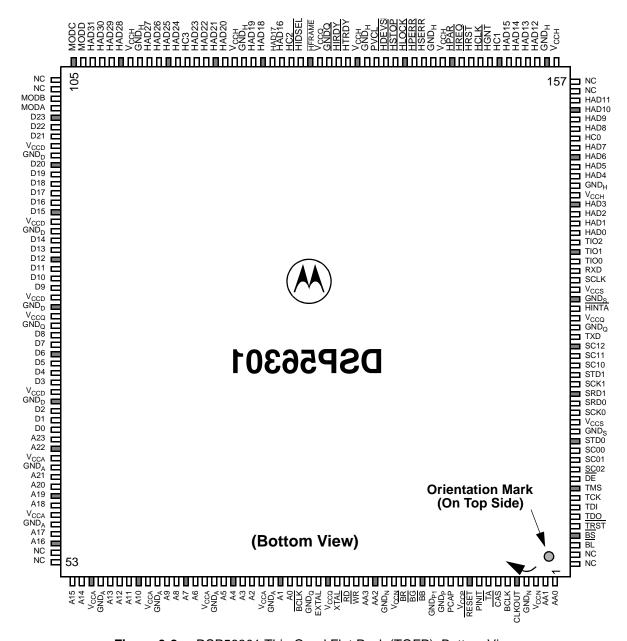


Figure 3-2. DSP56301 Thin Quad Flat Pack (TQFP), Bottom View

 Table 3-1.
 DSP56301 TQFP Signal Identification by Pin Number

| Pin<br>No. | Signal Name       | Pin<br>No. | Signal Name      | Pin<br>No. | Signal Name      |
|------------|-------------------|------------|------------------|------------|------------------|
| 1          | AA0/RAS0          | 26         | EXTAL            | 51         | A14              |
| 2          | AA1/RAS1          | 27         | $GND_Q$          | 52         | A15              |
| 3          | V <sub>CCN</sub>  | 28         | BCLK             | 53         | NC               |
| 4          | $GND_N$           | 29         | A0               | 54         | NC               |
| 5          | CLKOUT            | 30         | A1               | 55         | A16              |
| 6          | BCLK              | 31         | GND <sub>A</sub> | 56         | A17              |
| 7          | CAS               | 32         | V <sub>CCA</sub> | 57         | GND <sub>A</sub> |
| 8          | TA                | 33         | A2               | 58         | V <sub>CCA</sub> |
| 9          | PINIT/NMI         | 34         | A3               | 59         | A18              |
| 10         | RESET             | 35         | A4               | 60         | A19              |
| 11         | V <sub>CCP</sub>  | 36         | A5               | 61         | A20              |
| 12         | PCAP              | 37         | GND <sub>A</sub> | 62         | A21              |
| 13         | GND <sub>P</sub>  | 38         | V <sub>CCA</sub> | 63         | GND <sub>A</sub> |
| 14         | GND <sub>P1</sub> | 39         | A6               | 64         | V <sub>CCA</sub> |
| 15         | BB                | 40         | A7               | 65         | A22              |
| 16         | BG                | 41         | A8               | 66         | A23              |
| 17         | BR                | 42         | А9               | 67         | D0               |
| 18         | V <sub>CCN</sub>  | 43         | GND <sub>A</sub> | 68         | D1               |
| 19         | $GND_N$           | 44         | V <sub>CCA</sub> | 69         | D2               |
| 20         | AA2/RAS2          | 45         | A10              | 70         | GND <sub>D</sub> |
| 21         | AA3/RAS3          | 46         | A11              | 71         | V <sub>CCD</sub> |
| 22         | WR                | 47         | A12              | 72         | D3               |
| 23         | RD                | 48         | A13              | 73         | D4               |
| 24         | XTAL              | 49         | GND <sub>A</sub> | 74         | D5               |
| 25         | V <sub>CCQ</sub>  | 50         | V <sub>CCA</sub> | 75         | D6               |

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 Table 3-1.
 DSP56301 TQFP Signal Identification by Pin Number (Continued)

| Pin<br>No. | Signal Name      | Pin<br>No. | Signal Name      | Pin<br>No. | Signal Name            |
|------------|------------------|------------|------------------|------------|------------------------|
| 76         | D7               | 101        | MODA/IRQA        | 126        | HAD17 or HD9           |
| 77         | D8               | 102        | MODB/IRQB        | 127        | HAD16 or HD8           |
| 78         | $GND_Q$          | 103        | NC               | 128        | HC2/HBE2, HA2, or PB18 |
| 79         | V <sub>CCQ</sub> | 104        | NC               | 129        | HIDSEL or HRD/HDS      |
| 80         | GND <sub>D</sub> | 105        | MODC/IRQC        | 130        | HFRAME                 |
| 81         | V <sub>CCD</sub> | 106        | MODD/IRQD        | 131        | V <sub>CCQ</sub>       |
| 82         | D9               | 107        | HAD31 or HD23    | 132        | GND <sub>Q</sub>       |
| 83         | D10              | 108        | HAD30 or HD22    | 133        | HIRDY, HDBDR, or PB21  |
| 84         | D11              | 109        | HAD29 or HD21    | 134        | HTRDY, HDBEN, or PB20  |
| 85         | D12              | 110        | HAD28 or HD20    | 135        | V <sub>CCH</sub>       |
| 86         | D13              | 111        | V <sub>CCH</sub> | 136        | GND <sub>H</sub>       |
| 87         | D14              | 112        | GND <sub>H</sub> | 137        | PVCL                   |
| 88         | GND <sub>D</sub> | 113        | HAD27 or HD19    | 138        | HDEVSEL, HSAK, or PB22 |
| 89         | V <sub>CCD</sub> | 114        | HAD26 or HD18    | 139        | HSTOP or HWR/HRW       |
| 90         | D15              | 115        | HAD25 or HD17    | 140        | HLOCK, HBS, or PB23    |
| 91         | D16              | 116        | HAD24 or HD16    | 141        | HPERR or HDRQ          |
| 92         | D17              | 117        | HC3/HBE3 or PB19 | 142        | HSERR or HIRQ          |
| 93         | D18              | 118        | HAD23 or HD15    | 143        | GND <sub>H</sub>       |
| 94         | D19              | 119        | HAD22 or HD14    | 144        | V <sub>CCH</sub>       |
| 95         | D20              | 120        | HAD21 or HD13    | 145        | HPAR or HDAK           |
| 96         | GND <sub>D</sub> | 121        | HAD20 or HD12    | 146        | HREQ or HTA            |
| 97         | V <sub>CCD</sub> | 122        | V <sub>CCH</sub> | 147        | HRST or HRST           |
| 98         | D21              | 123        | GND <sub>H</sub> | 148        | HCLK                   |
| 99         | D22              | 124        | HAD19 or HD11    | 149        | HGNT or HAEN           |
| 100        | D23              | 125        | HAD18 or HD10    | 150        | HC1/HBE1, HA1, or PB17 |

Table 3-1. DSP56301 TQFP Signal Identification by Pin Number (Continued)

| Pin<br>No. | Signal Name            | Pin<br>No. | Signal Name       | Pin<br>No. | Signal Name      |
|------------|------------------------|------------|-------------------|------------|------------------|
| 151        | HAD15, HD7, or PB15    | 171        | HAD2, HA5, or PB2 | 191        | SRD0 or PC4      |
| 152        | HAD14, HD6, or PB14    | 172        | HAD1, HA4, or PB1 | 192        | SCK0 or PC3      |
| 153        | HAD13, HD5, or PB13    | 173        | HAD0, HA3, or PB0 | 193        | V <sub>CCS</sub> |
| 154        | HAD12, HD4, or PB12    | 174        | TIO2              | 194        | GND <sub>S</sub> |
| 155        | GND <sub>H</sub>       | 175        | TIO1              | 195        | STD0 or PC5      |
| 156        | V <sub>CCH</sub>       | 176        | TIO0              | 196        | SC00 or PC0      |
| 157        | NC                     | 177        | RXD or PE0        | 197        | SC01 or PC1      |
| 158        | NC                     | 178        | SCLK or PE2       | 198        | SC02 or PC2      |
| 159        | HAD11, HD3, or PB11    | 179        | V <sub>CCS</sub>  | 199        | DE               |
| 160        | HAD10, HD2, or PB10    | 180        | GND <sub>S</sub>  | 200        | TMS              |
| 161        | HAD9, HD1, or PB9      | 181        | HINTA             | 201        | TCK              |
| 162        | HAD8, HD0, or PB8      | 182        | V <sub>CCQ</sub>  | 202        | TDI              |
| 163        | HC0/HBE0, HA0, or PB16 | 183        | $GND_Q$           | 203        | TDO              |
| 164        | HAD7, HA10, or PB7     | 184        | TXD or PE1        | 204        | TRST             |
| 165        | HAD6, HA9, or PB6      | 185        | SC12 or PD2       | 205        | BS               |
| 166        | HAD5, HA8, or PB5      | 186        | SC11 or PD1       | 206        | BL               |
| 167        | HAD4, HA7, or PB4      | 187        | SC10 or PD0       | 207        | NC               |
| 168        | GND <sub>H</sub>       | 188        | STD1 or PD5       | 208        | NC               |
| 169        | V <sub>CCH</sub>       | 189        | SCK1 or PD3       |            |                  |
| 170        | HAD3, HA6, or PB3      | 190        | SRD1 or PD4       | 1          |                  |

### Notes:

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<sup>1.</sup> Signal names are based on configured functionality. Most pins supply a single signal. Some pins provide a signal with dual functionality, such as the MODx/IRQx pins that select an operating mode after RESET is deasserted, but act as interrupt lines during operation. Some pins have two or more configurable functions; names assigned to these pins indicate the function for a specific configuration. For example, Pin 165 is address/data line HAD6 in PCI bus mode, address line HA9 in non-PCI bus mode, or GPIO line PB6 when the GPIO function is enabled for this pin.

<sup>2.</sup> NC stands for Not Connected. These pins are reserved for future development. Do not connect any line, component, trace, or via to these pins.

 Table 3-2.
 DSP56301 TQFP Signal Identification by Name

| Signal Name | Pin<br>No. | Signal Name | Pin<br>No. | Signal Name       | Pin<br>No. |
|-------------|------------|-------------|------------|-------------------|------------|
| A0          | 29         | AA3         | 21         | D3                | 72         |
| A1          | 30         | BB          | 15         | D4                | 73         |
| A10         | 45         | BCLK        | 6          | D5                | 74         |
| A11         | 46         | BCLK        | 28         | D6                | 75         |
| A12         | 47         | BG          | 16         | D7                | 76         |
| A13         | 48         | BL          | 206        | D8                | 77         |
| A14         | 51         | BR          | 17         | D9                | 82         |
| A15         | 52         | BS          | 205        | DE                | 199        |
| A16         | 55         | CAS         | 7          | EXTAL             | 26         |
| A17         | 56         | CLKOUT      | 5          | GND <sub>P1</sub> | 14         |
| A18         | 59         | D0          | 67         | GND <sub>A</sub>  | 31         |
| A19         | 60         | D1          | 68         | GND <sub>A</sub>  | 37         |
| A2          | 33         | D10         | 83         | GND <sub>A</sub>  | 43         |
| A20         | 61         | D11         | 84         | GND <sub>A</sub>  | 49         |
| A21         | 62         | D12         | 85         | GND <sub>A</sub>  | 57         |
| A22         | 65         | D13         | 86         | GND <sub>A</sub>  | 63         |
| A23         | 66         | D14         | 87         | GND <sub>D</sub>  | 70         |
| A3          | 34         | D15         | 90         | GND <sub>D</sub>  | 80         |
| A4          | 35         | D16         | 91         | GND <sub>D</sub>  | 88         |
| A5          | 36         | D17         | 92         | GND <sub>D</sub>  | 96         |
| A6          | 39         | D18         | 93         | GND <sub>H</sub>  | 112        |
| A7          | 40         | D19         | 94         | GND <sub>H</sub>  | 123        |
| A8          | 41         | D2          | 69         | GND <sub>H</sub>  | 136        |
| A9          | 42         | D20         | 95         | GND <sub>H</sub>  | 143        |
| AA0         | 1          | D21         | 98         | GND <sub>H</sub>  | 155        |
| AA1         | 2          | D22         | 99         | GND <sub>H</sub>  | 168        |
| AA2         | 20         | D23         | 100        | GND <sub>N</sub>  | 4          |

 Table 3-2.
 DSP56301 TQFP Signal Identification by Name (Continued)

| Signal Name      | Pin<br>No. | Signal Name | Pin<br>No. | Signal Name | Pin<br>No. |
|------------------|------------|-------------|------------|-------------|------------|
| GND <sub>N</sub> | 19         | HAD14       | 152        | HAEN        | 149        |
| GND <sub>P</sub> | 13         | HAD15       | 151        | HBE0        | 163        |
| $GND_Q$          | 27         | HAD16       | 127        | HBE1        | 150        |
| $GND_Q$          | 78         | HAD17       | 126        | HBE2        | 128        |
| $GND_Q$          | 132        | HAD18       | 125        | HBE3        | 117        |
| $GND_Q$          | 183        | HAD19       | 124        | HBS         | 140        |
| $GND_Q$          | 183        | HAD2        | 171        | HC0         | 163        |
| GND <sub>S</sub> | 180        | HAD20       | 121        | HC1         | 150        |
| GND <sub>S</sub> | 194        | HAD21       | 120        | HC2         | 128        |
| HA0              | 163        | HAD22       | 119        | HC3         | 117        |
| HA1              | 150        | HAD23       | 118        | HCLK        | 148        |
| HA10             | 164        | HAD24       | 116        | HD0         | 162        |
| HA2              | 128        | HAD25       | 115        | HD1         | 161        |
| HA3              | 173        | HAD26       | 114        | HD10        | 125        |
| HA4              | 172        | HAD27       | 113        | HD11        | 124        |
| HA5              | 171        | HAD28       | 110        | HD12        | 121        |
| HA6              | 170        | HAD29       | 109        | HD13        | 120        |
| HA7              | 167        | HAD3        | 170        | HD14        | 119        |
| HA8              | 166        | HAD30       | 108        | HD15        | 118        |
| HA9              | 165        | HAD31       | 107        | HD16        | 116        |
| HAD0             | 173        | HAD4        | 167        | HD17        | 115        |
| HAD1             | 172        | HAD5        | 166        | HD18        | 114        |
| HAD10            | 160        | HAD6        | 165        | HD19        | 113        |
| HAD11            | 159        | HAD7        | 164        | HD2         | 160        |
| HAD12            | 154        | HAD8        | 162        | HD20        | 110        |
| HAD13            | 153        | HAD9        | 161        | HD21        | 109        |

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 Table 3-2.
 DSP56301 TQFP Signal Identification by Name (Continued)

| Signal Name | Pin<br>No. | Signal Name | Pin<br>No. | Signal Name | Pin<br>No. |
|-------------|------------|-------------|------------|-------------|------------|
| HD22        | 108        | HRST/HRST   | 147        | PB0         | 173        |
| HD23        | 107        | HRW         | 139        | PB1         | 172        |
| HD3         | 159        | HSAK        | 138        | PB10        | 160        |
| HD4         | 154        | HSERR       | 142        | PB11        | 159        |
| HD5         | 153        | HSTOP       | 139        | PB12        | 154        |
| HD6         | 152        | HTA         | 146        | PB13        | 153        |
| HD7         | 151        | HTRDY       | 134        | PB14        | 152        |
| HD8         | 127        | HWR         | 139        | PB15        | 151        |
| HD9         | 126        | ĪRQĀ        | 101        | PB16        | 163        |
| HDAK        | 145        | ĪRQB        | 102        | PB17        | 150        |
| HDBDR       | 133        | ĪRQC        | 105        | PB18        | 128        |
| HDBEN       | 134        | ĪRQD        | 106        | PB19        | 117        |
| HDEVSEL     | 138        | MODA        | 101        | PB2         | 171        |
| HDRQ        | 141        | MODB        | 102        | PB20        | 134        |
| HDS         | 129        | MODC        | 105        | PB21        | 133        |
| HFRAME      | 130        | MODD        | 106        | PB22        | 138        |
| HGNT        | 149        | NC          | 28         | PB23        | 140        |
| HIDSEL      | 129        | NC          | 53         | PB3         | 170        |
| HINTA       | 181        | NC          | 54         | PB4         | 167        |
| HIRDY       | 133        | NC          | 103        | PB5         | 166        |
| HIRQ        | 142        | NC          | 104        | PB6         | 165        |
| HLOCK       | 140        | NC          | 157        | PB7         | 164        |
| HPAR        | 145        | NC          | 158        | PB8         | 162        |
| HPERR       | 141        | NC          | 207        | PB9         | 161        |
| HRD         | 129        | NC          | 208        | PC0         | 196        |
| HREQ        | 146        | NMI         | 9          | PC1         | 197        |

Table 3-2. DSP56301 TQFP Signal Identification by Name (Continued)

| Signal Name | Pin<br>No. | Signal Name      | Pin<br>No. | Signal Name      | Pin<br>No. |
|-------------|------------|------------------|------------|------------------|------------|
| PC2         | 198        | SC02             | 198        | V <sub>CCA</sub> | 58         |
| PC3         | 192        | SC10             | 187        | V <sub>CCA</sub> | 64         |
| PC4         | 191        | SC11             | 186        | V <sub>CCD</sub> | 71         |
| PC5         | 195        | SC12             | 185        | V <sub>CCD</sub> | 81         |
| PCAP        | 12         | SCK0             | 192        | V <sub>CCD</sub> | 89         |
| PD0         | 187        | SCK1             | 189        | V <sub>CCD</sub> | 97         |
| PD1         | 186        | SCLK             | 178        | V <sub>CCH</sub> | 111        |
| PD2         | 185        | SRD0             | 191        | V <sub>CCH</sub> | 122        |
| PD3         | 189        | SRD1             | 190        | V <sub>CCH</sub> | 135        |
| PD4         | 190        | STD0             | 195        | V <sub>CCH</sub> | 144        |
| PD5         | 188        | STD1             | 188        | V <sub>CCH</sub> | 156        |
| PE0         | 177        | TA               | 8          | V <sub>CCH</sub> | 169        |
| PE1         | 184        | TCK              | 201        | V <sub>CCN</sub> | 3          |
| PE2         | 178        | TDI              | 202        | V <sub>CCN</sub> | 18         |
| PINIT       | 9          | TDO              | 203        | V <sub>CCP</sub> | 11         |
| PVCL        | 137        | TIO0             | 176        | V <sub>CCQ</sub> | 25         |
| RAS0        | 1          | TIO1             | 175        | V <sub>CCQ</sub> | 79         |
| RAS1        | 2          | TIO2             | 174        | V <sub>CCQ</sub> | 131        |
| RAS2        | 20         | TMS              | 200        | V <sub>CCQ</sub> | 182        |
| RAS3        | 21         | TRST             | 204        | V <sub>CCS</sub> | 179        |
| RD          | 23         | TXD              | 184        | V <sub>CCS</sub> | 193        |
| RESET       | 10         | V <sub>CCA</sub> | 32         | WR               | 22         |
| RXD         | 177        | V <sub>CCA</sub> | 38         | XTAL             | 24         |
| SC00        | 196        | V <sub>CCA</sub> | 44         |                  |            |
| SC01        | 197        | V <sub>CCA</sub> | 50         |                  |            |

**Note:** NC stands for Not Connected. These pins are reserved for future development. Do not connect any line, component, or trace to these pins.

## 3.2 TQFP Package Mechanical Drawing

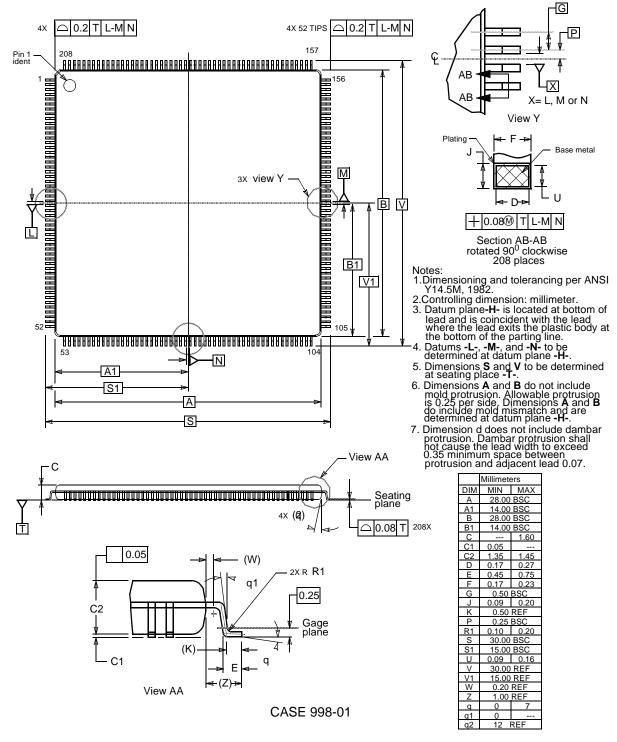


Figure 3-3. DSP56301 Mechanical Information, 208-pin TQFP Package

## 3.3 MAP-BGA Package Description

Top and bottom views of the MAP-BGA package are shown in Figure 3-4 and Figure 3-5 with their pin-outs.

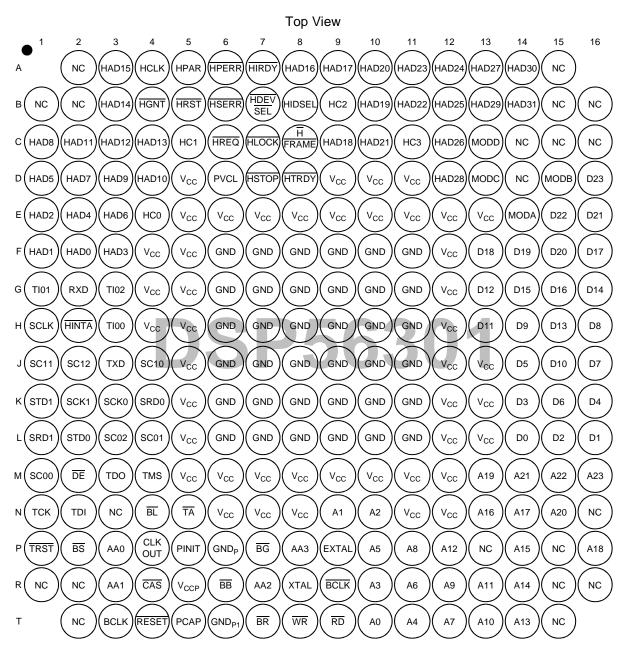


Figure 3-4. DSP56301 Molded Array Process-Ball Grid Array (MAP-BGA), Top View

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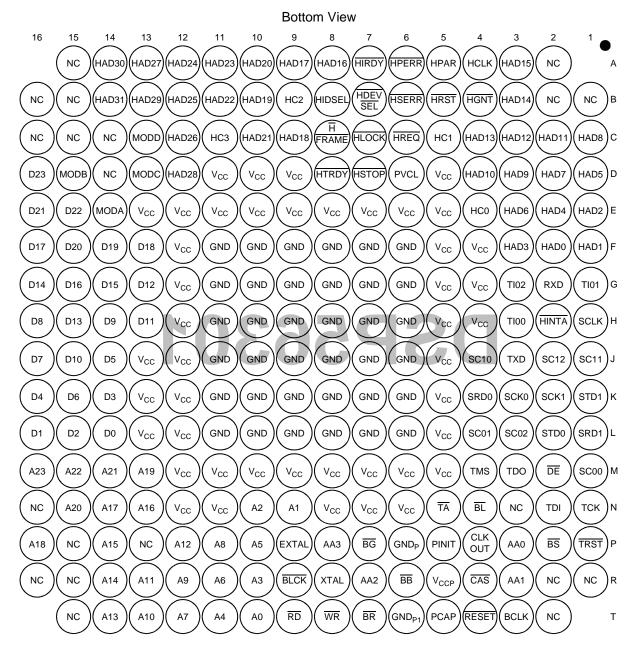


Figure 3-5. DSP56301 Molded Array Process-Ball Grid Array (MAP-BGA), Bottom View

 Table 3-3.
 DSP56301 MAP-BGA Signal Identification by Pin Number

| Pin<br>No. | Signal Name            | Pin<br>No. | Signal Name            | Pin<br>No. | Signal Name            |
|------------|------------------------|------------|------------------------|------------|------------------------|
| A2         | NC                     | B12        | HAD25 or HD17          | D5         | V <sub>CC</sub>        |
| А3         | HAD15, HD7, or PB15    | B13        | HAD29 or HD21          | D6         | PVCL                   |
| A4         | HCLK                   | B14        | HAD31 or HD23          | D7         | HSTOP or HWR/HRW       |
| A5         | HPAR or HDAK           | B15        | NC                     | D8         | HTRDY, HDBEN, or PB20  |
| A6         | HPERR or HDRQ          | B16        | NC                     | D9         | V <sub>CC</sub>        |
| A7         | HIRDY, HDBDR, or PB21  | C1         | HAD8, HD0, or PB8      | D10        | V <sub>CC</sub>        |
| A8         | HAD16 or HD8           | C2         | HAD11, HD3, or PB11    | D11        | V <sub>CC</sub>        |
| A9         | HAD17 or HD9           | C3         | HAD12, HD4, or PB12    | D12        | HAD28 or HD20          |
| A10        | HAD20 or HD12          | C4         | HAD13, HD5, or PB13    | D13        | MODC/IRQC              |
| A11        | HAD23 or HD15          | C5         | HC1/HBE1, HA1, or PB17 | D14        | NC                     |
| A12        | HAD24 or HD16          | C6         | HREQ or HTA            | D15        | MODB/IRQB              |
| A13        | HAD27 or HD19          | C7         | HLOCK, HBS, or PB23    | D16        | D23                    |
| A14        | HAD30 or HD22          | C8         | HFRAME                 | E1         | HAD2, HA5, or PB2      |
| A15        | NC                     | C9         | HAD18 or HD10          | E2         | HAD4, HA7, or PB4      |
| B1         | NC                     | C10        | HAD21 or HD13          | E3         | HAD6, HA9, or PB6      |
| B2         | NC                     | C11        | HC3/HBE3 or PB19       | E4         | HC0/HBE0, HA0, or PB16 |
| В3         | HAD14, HD6, or PB14    | C12        | HAD26 or HD18          | E5         | V <sub>CC</sub>        |
| B4         | HGNT or HAEN           | C13        | MODD/IRQD              | E6         | V <sub>CC</sub>        |
| B5         | HRST/HRST              | C14        | NC                     | E7         | V <sub>CC</sub>        |
| В6         | HSERR or HIRQ          | C15        | NC                     | E8         | V <sub>CC</sub>        |
| B7         | HDEVSEL, HSAK, or PB22 | C16        | NC                     | E9         | V <sub>CC</sub>        |
| B8         | HIDSEL or HRD/HDS      | D1         | HAD5, HA8, or PB5      | E10        | V <sub>CC</sub>        |
| В9         | HC2/HBE2, HA2, or PB18 | D2         | HAD7, HA10, or PB7     | E11        | V <sub>CC</sub>        |
| B10        | HAD19 or HD11          | D3         | HAD9, HD1, or PB9      | E12        | V <sub>CC</sub>        |
| B11        | HAD22 or HD14          | D4         | HAD10, HD2, or PB10    | E13        | V <sub>CC</sub>        |

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 Table 3-3.
 DSP56301 MAP-BGA Signal Identification by Pin Number (Continued)

| Pin<br>No. | Signal Name       | Pin<br>No. | Signal Name     | Pin<br>No. | Signal Name     |
|------------|-------------------|------------|-----------------|------------|-----------------|
| E14        | MODA/IRQA         | G7         | GND             | H16        | D8              |
| E15        | D22               | G8         | GND             | J1         | SC11 or PD1     |
| E16        | D21               | G9         | GND             | J2         | SC12 or PD2     |
| F1         | HAD1, HA4, or PB1 | G10        | GND             | J3         | TXD or PE1      |
| F2         | HAD0, HA3, or PB0 | G11        | GND             | J4         | SC10 or PD0     |
| F3         | HAD3, HA6, or PB3 | G12        | V <sub>CC</sub> | J5         | V <sub>CC</sub> |
| F4         | V <sub>CC</sub>   | G13        | D12             | J6         | GND             |
| F5         | V <sub>CC</sub>   | G14        | D15             | J7         | GND             |
| F6         | GND               | G15        | D16             | J8         | GND             |
| F7         | GND               | G16        | D14             | J9         | GND             |
| F8         | GND               | H1         | SCLK or PE2     | J10        | GND             |
| F9         | GND               | H2         | HINTA           | J11        | GND             |
| F10        | GND               | Н3         | TIO0            | J12        | V <sub>CC</sub> |
| F11        | GND               | H4         | V <sub>CC</sub> | J13        | V <sub>CC</sub> |
| F12        | V <sub>CC</sub>   | H5         | V <sub>CC</sub> | J14        | D5              |
| F13        | D18               | H6         | GND             | J15        | D10             |
| F14        | D19               | H7         | GND             | J16        | D7              |
| F15        | D20               | H8         | GND             | K1         | STD1 or PD5     |
| F16        | D17               | Н9         | GND             | K2         | SCK1 or PD3     |
| G1         | TIO1              | H10        | GND             | К3         | SCK0 or PC3     |
| G2         | RXD or PE0        | H11        | GND             | K4         | SRD0 or PC4     |
| G3         | TIO2              | H12        | V <sub>CC</sub> | K5         | V <sub>CC</sub> |
| G4         | V <sub>CC</sub>   | H13        | D11             | K6         | GND             |
| G5         | V <sub>CC</sub>   | H14        | D9              | K7         | GND             |
| G6         | GND               | H15        | D13             | K8         | GND             |

 Table 3-3.
 DSP56301 MAP-BGA Signal Identification by Pin Number (Continued)

| Pin<br>No. | Signal Name     | Pin<br>No. | Signal Name     | Pin<br>No. | Signal Name      |
|------------|-----------------|------------|-----------------|------------|------------------|
| K9         | GND             | M2         | DE              | N11        | V <sub>CC</sub>  |
| K10        | GND             | M3         | TDO             | N12        | V <sub>CC</sub>  |
| K11        | GND             | M4         | TMS             | N13        | A16              |
| K12        | V <sub>CC</sub> | M5         | V <sub>CC</sub> | N14        | A17              |
| K13        | V <sub>CC</sub> | M6         | V <sub>CC</sub> | N15        | A20              |
| K14        | D3              | M7         | V <sub>CC</sub> | N16        | NC               |
| K15        | D6              | M8         | V <sub>CC</sub> | P1         | TRST             |
| K16        | D4              | M9         | V <sub>CC</sub> | P2         | BS               |
| L1         | SRD1 or PD4     | M10        | V <sub>CC</sub> | P3         | AA0/RAS0         |
| L2         | STD0 or PC5     | M11        | V <sub>CC</sub> | P4         | CLKOUT           |
| L3         | SC02 or PC2     | M12        | V <sub>CC</sub> | P5         | PINIT/NMI        |
| L4         | SC01 or PC1     | M13        | A19             | P6         | GND <sub>P</sub> |
| L5         | V <sub>CC</sub> | M14        | A21             | P7         | BG               |
| L6         | GND             | M15        | A22             | P8         | AA3/RAS3         |
| L7         | GND             | M16        | A23             | P9         | EXTAL            |
| L8         | GND             | N1         | TCK             | P10        | A5               |
| L9         | GND             | N2         | TDI             | P11        | A8               |
| L10        | GND             | N3         | NC              | P12        | A12              |
| L11        | GND             | N4         | BL              | P13        | NC               |
| L12        | V <sub>CC</sub> | N5         | TA              | P14        | A15              |
| L13        | V <sub>CC</sub> | N6         | V <sub>CC</sub> | P15        | NC               |
| L14        | D0              | N7         | V <sub>CC</sub> | P16        | A18              |
| L15        | D2              | N8         | V <sub>CC</sub> | R1         | NC               |
| L16        | D1              | N9         | A1              | R2         | NC               |
| M1         | SC00 or PC0     | N10        | A2              | R3         | AA1/RAS1         |

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Table 3-3. DSP56301 MAP-BGA Signal Identification by Pin Number (Continued)

| Pin<br>No. | Signal Name      | Pin<br>No. | Signal Name       | Pin<br>No. | Signal Name |
|------------|------------------|------------|-------------------|------------|-------------|
| R4         | CAS              | R13        | A11               | T7         | BR          |
| R5         | V <sub>CCP</sub> | R14        | A14               | T8         | WR          |
| R6         | BB               | R15        | NC                | Т9         | RD          |
| R7         | AA2/RAS2         | R16        | NC                | T10        | A0          |
| R8         | XTAL             | T2         | NC                | T11        | A4          |
| R9         | BCLK             | Т3         | BCLK              | T12        | A7          |
| R10        | А3               | T4         | RESET             | T13        | A10         |
| R11        | A6               | T5         | PCAP              | T14        | A13         |
| R12        | A9               | Т6         | GND <sub>P1</sub> | T15        | NC          |

#### Notes:

- Signal names are based on configured functionality. Most connections supply a single signal. Some connections provide a signal with dual functionality, such as the MODx/IRQx pins that select an operating mode after RESET is deasserted, but act as interrupt lines during operation. Some signals have configurable polarity; these names are shown with and without overbars, such as HAS/HAS. Some connections have two or more configurable functions; names assigned to these connections indicate the function for a specific configuration. For example, connection N2 is data line H7 in non-multiplexed bus mode, data/address line HAD7 in multiplexed bus mode, or GPIO line PB7 when the GPIO function is enabled for this pin. Unlike the TQFP package, most of the GND pins are connected internally in the center of the connection array and act as heat sink for the chip. Therefore, except for GND<sub>P</sub> and GND<sub>P1</sub> that support the PLL, other GND signals do not support individual subsystems in the chip.
- 2. NC stands for Not Connected. The following pin groups are shorted to each other:
  - pins A2, B1, and B2
  - pins A15, B15, B16, C14, C15, C16, and D14
  - pins N3, R1, R2, and T2
  - pins N16, P13, P15, R15, R16, and T15

Do not connect any line, component, trace, or via to these pins.

 Table 3-4.
 DSP56301 MAP-BGA Signal Identification by Name

| Signal Name | Pin<br>No. | Signal Name | Pin<br>No. | Signal Name | Pin<br>No. |
|-------------|------------|-------------|------------|-------------|------------|
| A0          | T10        | AA2         | R7         | D22         | E15        |
| A1          | N9         | AA3         | P8         | D23         | D16        |
| A10         | T13        | BB          | R6         | D3          | K14        |
| A11         | R13        | BCLK        | Т3         | D4          | K16        |
| A12         | P12        | BCLK        | R9         | D5          | J14        |
| A13         | T14        | BG          | P7         | D6          | K15        |
| A14         | R14        | BL          | N4         | D7          | J16        |
| A15         | P14        | BR          | T7         | D8          | H16        |
| A16         | N13        | BS          | P2         | D9          | H14        |
| A17         | N14        | CAS         | R4         | DE          | M2         |
| A18         | P16        | CLKOUT      | P4         | EXTAL       | P9         |
| A19         | M13        | D0          | L14        | GND         | F10        |
| A2          | N10        | D1          | L16        | GND         | F11        |
| A20         | N15        | D10         | J15        | GND         | F6         |
| A21         | M14        | D11         | H13        | GND         | F7         |
| A22         | M15        | D12         | G13        | GND         | F8         |
| A23         | M16        | D13         | H15        | GND         | F9         |
| А3          | R10        | D14         | G16        | GND         | G10        |
| A4          | T11        | D15         | G14        | GND         | G11        |
| A5          | P10        | D16         | G15        | GND         | G6         |
| A6          | R11        | D17         | F16        | GND         | G7         |
| A7          | T12        | D18         | F13        | GND         | G8         |
| A8          | P11        | D19         | F14        | GND         | G9         |
| A9          | R12        | D2          | L15        | GND         | H10        |
| AA0         | P3         | D20         | F15        | GND         | H11        |
| AA1         | R3         | D21         | E16        | GND         | H6         |

 Table 3-4.
 DSP56301 MAP-BGA Signal Identification by Name (Continued)

| Signal Name       | Pin<br>No. | Signal Name | Pin<br>No. | Signal Name | Pin<br>No. |
|-------------------|------------|-------------|------------|-------------|------------|
| GND               | H7         | HA10        | D2         | HAD23       | A11        |
| GND               | H8         | HA2         | В9         | HAD24       | A12        |
| GND               | H9         | HA3         | F2         | HAD25       | B12        |
| GND               | J10        | HA4         | F1         | HAD26       | C12        |
| GND               | J11        | HA5         | E1         | HAD27       | A13        |
| GND               | J6         | HA6         | F3         | HAD28       | D12        |
| GND               | J7         | HA7         | E2         | HAD29       | B13        |
| GND               | J8         | HA8         | D1         | HAD3        | F3         |
| GND               | J9         | HA9         | E3         | HAD30       | A14        |
| GND               | K10        | HAD0        | F2         | HAD31       | B14        |
| GND               | K11        | HAD1        | F1         | HAD4        | E2         |
| GND               | K6         | HAD10       | D4         | HAD5        | D1         |
| GND               | K7         | HAD11       | C2         | HAD6        | E3         |
| GND               | K8         | HAD12       | C3         | HAD7        | D2         |
| GND               | K9         | HAD13       | C4         | HAD8        | C1         |
| GND               | L10        | HAD14       | В3         | HAD9        | D3         |
| GND               | L11        | HAD15       | А3         | HAEN        | B4         |
| GND               | L6         | HAD16       | A8         | HBE0        | E4         |
| GND               | L7         | HAD17       | A9         | HBE1        | C5         |
| GND               | L8         | HAD18       | C9         | HBE2        | В9         |
| GND               | L9         | HAD19       | B10        | HBE3        | C11        |
| GND <sub>P1</sub> | Т6         | HAD2        | E1         | HBS         | C7         |
| GND <sub>P</sub>  | P6         | HAD20       | A10        | HC0         | E4         |
| HA0               | E4         | HAD21       | C10        | HC1         | C5         |
| HA1               | C5         | HAD22       | B11        | HC2         | В9         |

 Table 3-4.
 DSP56301 MAP-BGA Signal Identification by Name (Continued)

| Signal Name | Pin<br>No. | Signal Name | Pin<br>No. | Signal Name | Pin<br>No. |
|-------------|------------|-------------|------------|-------------|------------|
| HC3         | C11        | HD9         | A9         | HWR         | D7         |
| HCLK        | A4         | HDAK        | A5         | ĪRQĀ        | E14        |
| HD0         | C1         | HDBDR       | A7         | ĪRQB        | D15        |
| HD1         | D3         | HDBEN       | D8         | ĪRQC        | D13        |
| HD10        | C9         | HDEVSEL     | B7         | ĪRQD        | C13        |
| HD11        | B10        | HDRQ        | A6         | MODA        | E14        |
| HD12        | A10        | HDS         | B8         | MODB        | D15        |
| HD13        | C10        | HFRAME      | C8         | MODC        | D13        |
| HD14        | B11        | HGNT        | B4         | MODD        | C13        |
| HD15        | A11        | HIDSEL      | B8         | NC          | A15        |
| HD16        | A12        | HINTA       | H2         | NC          | A2         |
| HD17        | B12        | HIRDY       | A7         | NC          | B1         |
| HD18        | C12        | HIRQ        | В6         | NC          | B15        |
| HD19        | A13        | HLOCK       | C7         | NC          | B16        |
| HD2         | D4         | HPAR        | A5         | NC          | B2         |
| HD20        | D12        | HPERR       | A6         | NC          | C14        |
| HD21        | B13        | HRD         | B8         | NC          | C15        |
| HD22        | A14        | HREQ        | C6         | NC          | C16        |
| HD23        | B14        | HRST/HRST   | B5         | NC          | D14        |
| HD3         | C2         | HRW         | D7         | NC          | N16        |
| HD4         | С3         | HSAK        | B7         | NC          | N3         |
| HD5         | C4         | HSERR       | В6         | NC          | P13        |
| HD6         | В3         | HSTOP       | D7         | NC          | P15        |
| HD7         | А3         | HTA         | C6         | NC          | R1         |
| HD8         | A8         | HTRDY       | D8         | NC          | R2         |

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 Table 3-4.
 DSP56301 MAP-BGA Signal Identification by Name (Continued)

| Signal Name | Pin<br>No. | Signal Name | Pin<br>No. | Signal Name | Pin<br>No. |
|-------------|------------|-------------|------------|-------------|------------|
| NC          | R15        | PB6         | E3         | RAS3        | P8         |
| NC          | R16        | PB7         | D2         | RD          | Т9         |
| NC          | T2         | PB8         | C1         | RESET       | T4         |
| NC          | T15        | PB9         | D3         | RXD         | G2         |
| NMI         | P5         | PC0         | M1         | SC00        | M1         |
| PB0         | F2         | PC1         | L4         | SC01        | L4         |
| PB1         | F1         | PC2         | L3         | SC02        | L3         |
| PB10        | D4         | PC3         | K3         | SC10        | J4         |
| PB11        | C2         | PC4         | K4         | SC11        | J1         |
| PB12        | C3         | PC5         | L2         | SC12        | J2         |
| PB13        | C4         | PCAP        | T5         | SCK0        | К3         |
| PB14        | В3         | PD0         | J4         | SCK1        | K2         |
| PB15        | А3         | PD1         | J1         | SCLK        | H1         |
| PB16        | E4         | PD2         | J2         | SRD0        | K4         |
| PB17        | C5         | PD3         | K2         | SRD1        | L1         |
| PB18        | В9         | PD4         | L1         | STD0        | L2         |
| PB19        | C11        | PD5         | K1         | STD1        | K1         |
| PB2         | E1         | PE0         | G2         | TA          | N5         |
| PB20        | D8         | PE1         | J3         | TCK         | N1         |
| PB21        | A7         | PE2         | H1         | TDI         | N2         |
| PB22        | В7         | PINIT       | P5         | TDO         | МЗ         |
| PB23        | C7         | PVCL        | D6         | TIO0        | НЗ         |
| PB3         | F3         | RAS0        | P3         | TIO1        | G1         |
| PB4         | E2         | RAS1        | R3         | TIO2        | G3         |
| PB5         | D1         | RAS2        | R7         | TMS         | M4         |

DSP56301 MAP-BGA Signal Identification by Name (Continued) **Table 3-4.** 

| Signal Name     | Pin<br>No. | Signal Name     | Pin<br>No. | Signal Name      | Pin<br>No. |
|-----------------|------------|-----------------|------------|------------------|------------|
| TRST            | P1         | V <sub>CC</sub> | F5         | V <sub>CC</sub>  | M10        |
| TXD             | J3         | V <sub>CC</sub> | G12        | V <sub>CC</sub>  | M11        |
| V <sub>CC</sub> | D10        | V <sub>CC</sub> | G4         | V <sub>CC</sub>  | M12        |
| V <sub>CC</sub> | D11        | V <sub>CC</sub> | G5         | V <sub>CC</sub>  | M5         |
| V <sub>CC</sub> | D5         | V <sub>CC</sub> | H12        | V <sub>CC</sub>  | M6         |
| V <sub>CC</sub> | D9         | V <sub>CC</sub> | H4         | V <sub>CC</sub>  | M7         |
| V <sub>CC</sub> | E10        | V <sub>CC</sub> | H5         | V <sub>CC</sub>  | M8         |
| V <sub>CC</sub> | E11        | V <sub>CC</sub> | J12        | V <sub>CC</sub>  | M9         |
| V <sub>CC</sub> | E12        | V <sub>CC</sub> | J13        | V <sub>CC</sub>  | N11        |
| V <sub>CC</sub> | E13        | V <sub>CC</sub> | J5         | V <sub>CC</sub>  | N12        |
| V <sub>CC</sub> | E5         | V <sub>CC</sub> | K12        | V <sub>CC</sub>  | N6         |
| V <sub>CC</sub> | E6         | V <sub>CC</sub> | K13        | V <sub>CC</sub>  | N7         |
| V <sub>CC</sub> | E7         | V <sub>CC</sub> | K5         | V <sub>CC</sub>  | N8         |
| V <sub>CC</sub> | E8         | V <sub>CC</sub> | L12        | V <sub>CCP</sub> | R5         |
| V <sub>CC</sub> | E9         | V <sub>CC</sub> | L13        | WR               | Т8         |
| V <sub>CC</sub> | F12        | V <sub>CC</sub> | L5         | XTAL             | R8         |
| V <sub>CC</sub> | F4         |                 |            |                  |            |

Note: NC stands for Not Connected. The following pin groups are shorted to each other:

<sup>-</sup>pins A2, B1, and B2

<sup>-</sup>pins A15, B15, B16, C14, C15, C16, and D14

<sup>—</sup>pins N3, R1, R2, and T2

<sup>—</sup>pins N16, P13, P15, R15, R16, and T15
Do not connect any line, component, trace, or via to these pins.

# 3.4 MAP-BGA Package Mechanical Drawing

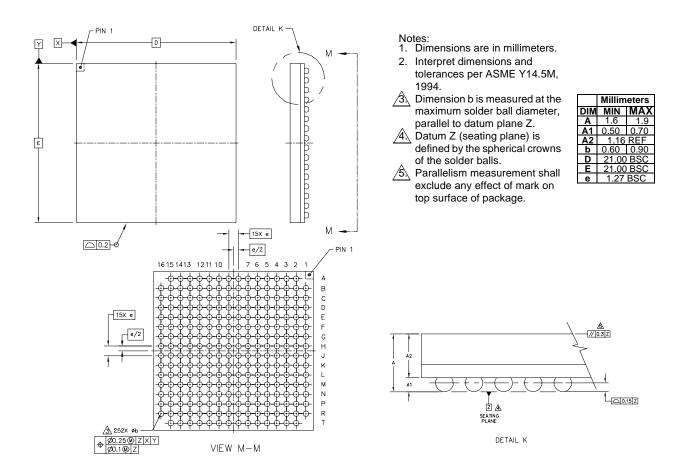


Figure 3-6. DSP56301 Mechanical Information, 252-pin MAP-BGA Package

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**Design Considerations** 

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## 4.1 Thermal Design Considerations

An estimate of the chip junction temperature, T<sub>J</sub>, in °C can be obtained from this equation:

**Equation 1:** 
$$T_I = T_A + (P_D \times R_{\theta IA})$$

Where:

 $T_A$  = ambient temperature  ${}^{\circ}C$ 

 $R_{\theta IA}$  = package junction-to-ambient thermal resistance °C/W

 $P_D$  = power dissipation in package

Historically, thermal resistance has been expressed as the sum of a junction-to-case thermal resistance and a case-to-ambient thermal resistance, as in this equation:

Equation 2: 
$$R_{\theta JA} = R_{\theta JC} + R_{\theta CA}$$

Where:

 $R_{\theta JA}$  = package junction-to-ambient thermal resistance °C/W  $R_{\theta JC}$  = package junction-to-case thermal resistance °C/W  $R_{\theta CA}$  = package case-to-ambient thermal resistance °C/W

 $R_{\theta JC}$  is device-related and cannot be influenced by the user. The user controls the thermal environment to change the case-to-ambient thermal resistance,  $R_{\theta CA}$ . For example, the user can change the air flow around the device, add a heat sink, change the mounting arrangement on the printed circuit board (PCB) or otherwise change the thermal dissipation capability of the area surrounding the device on a PCB. This model is most useful for ceramic packages with heat sinks; some 90 percent of the heat flow is dissipated through the case to the heat sink and out to the ambient environment. For ceramic packages, in situations where the heat flow is split between a path to the case and an alternate path through the PCB, analysis of the device thermal performance may need the additional modeling capability of a system-level thermal simulation tool.

The thermal performance of plastic packages is more dependent on the temperature of the PCB to which the package is mounted. Again, if the estimates obtained from  $R_{\theta JA}$  do not satisfactorily answer whether the thermal performance is adequate, a system-level model may be appropriate.

A complicating factor is the existence of three common ways to determine the junction-to-case thermal resistance in plastic packages.

- To minimize temperature variation across the surface, the thermal resistance is measured from the junction to the outside surface of the package (case) closest to the chip mounting area when that surface has a proper heat sink.
- To define a value approximately equal to a junction-to-board thermal resistance, the thermal resistance is measured from the junction to the point at which the leads attach to the case.

#### **Design Considerations**

• If the temperature of the package case  $(T_T)$  is determined by a thermocouple, thermal resistance is computed from the value obtained by the equation  $(T_I - T_T)/P_D$ .

As noted earlier, the junction-to-case thermal resistances quoted in this data sheet are determined using the first definition. From a practical standpoint, that value is also suitable to determine the junction temperature from a case thermocouple reading in forced convection environments. In natural convection, the use of the junction-to-case thermal resistance to estimate junction temperature from a thermocouple reading on the case of the package will yield an estimate of a junction temperature slightly higher than actual temperature. Hence, the new thermal metric, thermal characterization parameter or  $\Psi_{JT}$ , has been defined to be  $(T_J - T_T)/P_D$ . This value gives a better estimate of the junction temperature in natural convection when the surface temperature of the package is used. Remember that surface temperature readings of packages are subject to significant errors caused by inadequate attachment of the sensor to the surface and to errors caused by heat loss to the sensor. The recommended technique is to attach a 40-gauge thermocouple wire and bead to the top center of the package with thermally conductive epoxy.

## 4.2 Electrical Design Considerations

### **CAUTION**

This device contains protective circuitry to guard against damage due to high static voltage or electrical fields. However, normal precautions are advised to avoid application of any voltages higher than maximum rated voltages to this high-impedance circuit. Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (for example, either GND or V<sub>CC</sub>).

Use the following list of recommendations to ensure correct DSP operation.

- Provide a low-impedance path from the board power supply to each V<sub>CC</sub> pin on the DSP and from the board ground to each GND pin.
- Use at least six 0.01– $0.1~\mu F$  bypass capacitors positioned as close as possible to the four sides of the package to connect the  $V_{CC}$  power source to GND.
- Ensure that capacitor leads and associated printed circuit traces that connect to the chip V<sub>CC</sub> and GND pins are less than 0.5 inch per capacitor lead.
- Use at least a four-layer PCB with two inner layers for V<sub>CC</sub> and GND.
- Because the DSP output signals have fast rise and fall times, PCB trace lengths should be minimal. This recommendation particularly applies to the address and data buses as well as the IRQA, IRQB, IRQC, IRQD, TA, and BG pins. Maximum PCB trace lengths on the order of 6 inches are recommended.
- Consider all device loads as well as parasitic capacitance due to PCB traces when you calculate
  capacitance. This is especially critical in systems with higher capacitive loads that could create higher
  transient currents in the V<sub>CC</sub> and GND circuits.
- All inputs must be terminated (that is, not allowed to float) by CMOS levels except for the three pins with internal pull-up resistors (TRST, TMS, DE).
- Take special care to minimize noise levels on the V<sub>CCP</sub>, GND<sub>P</sub>, and GND<sub>P1</sub> pins.
- The following pins must be asserted after power-up: RESET and TRST.

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- If multiple DSP devices are on the same board, check for cross-talk or excessive spikes on the supplies due to synchronous operation of the devices.
- RESET must be asserted when the chip is powered up. A stable EXTAL signal should be supplied before deassertion of RESET.
- At power-up, ensure that the voltage difference between the 5 V tolerant pins and the chip  $V_{CC}$  never exceeds 3.5 V.

## 4.3 Power Consumption Considerations

Power dissipation is a key issue in portable DSP applications. Some of the factors affecting current consumption are described in this section. Most of the current consumed by CMOS devices is alternating current (ac), which is charging and discharging the capacitances of the pins and internal nodes.

Current consumption is described by this formula:

**Equation 3:** 
$$I = C \times V \times f$$

Where:

C = node/pin capacitance

V = voltage swing

f = frequency of node/pin toggle

Example 1. Current Consumption

For a Port A address pin loaded with 50 pF capacitance, operating at 3.3 V, with a 66 MHz clock, toggling at its maximum possible rate (33 MHz), the current consumption is expressed in **Equation 4**.

**Equation 4:** 
$$I = 50 \times 10^{-12} \times 3.3 \times 33 \times 10^{6} = 5.48 \text{ mA}$$

The maximum internal current ( $I_{CCI}$ max) value reflects the typical possible switching of the internal buses on best-case operation conditions—not necessarily a real application case. The typical internal current ( $I_{CCItyp}$ ) value reflects the average switching of the internal buses on typical operating conditions. Perform the following steps for applications that require very low current consumption:

- 1. Set the EBD bit when you are not accessing external memory.
- 2. Minimize external memory accesses, and use internal memory accesses.
- **3.** Minimize the number of pins that are switching.
- **4.** Minimize the capacitive load on the pins.
- **5.** Connect the unused inputs to pull-up or pull-down resistors.
- **6.** Disable unused peripherals.
- 7. Disable unused pin activity (for example, CLKOUT, XTAL).

One way to evaluate power consumption is to use a current-per-MIPS measurement methodology to minimize specific board effects (that is, to compensate for measured board current not caused by the DSP). A benchmark power consumption test algorithm is listed in **Appendix A**. Use the test algorithm, specific test current measurements, and the following equation to derive the current-per-MIPS value.

### **Design Considerations**

Equation 5: 
$$I/MIPS = I/MHz = (I_{typF2} - I_{typF1})/(F2 - F1)$$

Where:

 $I_{typF2}$  = current at F2  $I_{typF1}$  = current at F1

F2 = high frequency (any specified operating frequency)

F1 = low frequency (any specified operating frequency lower than F2)

**Note:** F1 should be significantly less than F2. For example, F2 could be 66 MHz and F1 could be 33 MHz. The degree of difference between F1 and F2 determines the amount of precision with which the current rating can be determined for an application.

## 4.4 PLL Performance Issues

The following explanations should be considered as general observations on expected PLL behavior. There is no test that replicates these exact numbers. These observations were measured on a limited number of parts and were not verified over the entire temperature and voltage ranges.

### 4.4.1 Phase Skew Performance

The phase skew of the PLL is defined as the time difference between the falling edges of EXTAL and CLKOUT for a given capacitive load on CLKOUT, over the entire process, temperature and voltage ranges. As defined in **Figure 2-2**, *External Clock Timing*, on page -5 for input frequencies greater than 15 MHz and the MF  $\leq$  4, this skew is greater than or equal to 0.0 ns and less than 1.8 ns; otherwise, this skew is not guaranteed. However, for MF < 10 and input frequencies greater than 10 MHz, this skew is between -1.4 ns and +3.2 ns.

## 4.4.2 Phase Jitter Performance

The phase jitter of the PLL is defined as the variations in the skew between the falling edges of EXTAL and CLKOUT for a given device in specific temperature, voltage, input frequency, MF, and capacitive load on CLKOUT. These variations are a result of the PLL locking mechanism. For input frequencies greater than 15 MHz and MF  $\leq$  4, this jitter is less than  $\pm$ 0.6 ns; otherwise, this jitter is not guaranteed. However, for MF < 10 and input frequencies greater than 10 MHz, this jitter is less than  $\pm$ 2 ns.

## 4.4.3 Frequency Jitter Performance

The frequency jitter of the PLL is defined as the variation of the frequency of CLKOUT. For small MF (MF < 10) this jitter is smaller than 0.5 per cent. For mid-range MF (10 < MF < 500) this jitter is between 0.5 per cent and approximately 2 per cent. For large MF (MF > 500), the frequency jitter is 2–3 per cent.

# 4.5 Input (EXTAL) Jitter Requirements

The allowed jitter on the frequency of EXTAL is 0.5 percent. If the rate of change of the frequency of EXTAL is slow (that is, it does not jump between the minimum and maximum values in one cycle) or the frequency of the jitter is fast (that is, it does not stay at an extreme value for a long time), then the allowed jitter can be 2 percent. The phase and frequency jitter performance results are valid only if the input jitter is less than the prescribed values.

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# **Power Consumption Benchmark**



The following benchmark program permits evaluation of DSP power usage in a test situation. It enables the PLL, disables the external clock, and uses repeated multiply-accumulate (MAC) instructions with a set of synthetic DSP application data to emulate intensive sustained DSP operation.

```
******************
;* CHECKS Typical Power Consumption
;*
      page 200,55,0,0,0
      nolist
I VEC EQU$000000; Interrupt vectors for program debug only
START EQU$8000; MAIN (external) program starting address
INT_PROG EQU$100 ; INTERNAL program memory starting address
INT XDAT EQU$0 ; INTERNAL X-data memory starting address
INT_YDAT EQU$0 ; INTERNAL Y-data memory starting address
       INCLUDE "ioequ.asm"
      INCLUDE "intequ.asm"
      list
      org
             P:START
      movep #$0123FF,x:M_BCR; BCR: Area 3 : 1 w.s (SRAM)
; Area 2 : 0 w.s (SSRAM)
; Default: 1 w.s (SRAM)
      movep #$0d0000,x:M PCTL; XTAL disable
; PLL enable
; CLKOUT disable
;Load the program
      move
             #INT PROG, r0
      move
             #PROG START, r1
      do
             #(PROG_END-PROG_START),PLOAD_LOOP
             p:(r1)+,x0
      move
      move
             x0,p:(r0)+
      nop
PLOAD LOOP
; Load the X-data
             #INT XDAT, r0
      move
             #XDAT_START, r1
      move
```

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#### **Power Consumption Benchmark**

```
#(XDAT END-XDAT START),XLOAD LOOP
               p:(r1)+,x0
       move
       move
               x0, x: (r0) +
XLOAD LOOP
;Load the Y-data
       move
               #INT YDAT, r0
       move
               #YDAT START, r1
       do
               #(YDAT END-YDAT START),YLOAD LOOP
               p:(r1)+,x0
       move
               x0,y:(r0)+
       move
YLOAD LOOP
               INT PROG
       jmp
PROG_START
               #$0,r0
       move
               #$0,r4
       move
       move
               #$3f,m0
       move
               #$3f,m4
       clr
               а
       clr
               b
       move
               #$0,x0
       move
               #$0,x1
       move
               #$0,y0
       move
               #$0,y1
       bset
               #4,omr
                               ; ebd
               #60, end
sbr
       dor
               x0,y0,ax:(r0)+,x1
       mac
                                      y: (r4) + , y1
       mac
               x1,y1,ax:(r0)+,x0
                                      y: (r4) + , y0
       add
               a,b
               x0,y0,ax:(r0)+,x1
       mac
               x1,y1,a
                                      y: (r4) + , y0
       mac
               b1,x:$ff
       move
_end
       bra
               sbr
       nop
       nop
       nop
       nop
PROG END
       nop
       nop
XDAT START
       org
               x:0
               $262EB9
       dc
               $86F2FE
       dc
               $E56A5F
       dc
               $616CAC
       dс
               $8FFD75
       dс
               $9210A
       dc
               $A06D7B
       dс
               $CEA798
       dс
               $8DFBF1
       dc
               $A063D6
```

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|             | dc  | \$6C6657 |  |  |  |  |  |
|-------------|-----|----------|--|--|--|--|--|
|             | dc  | \$C2A544 |  |  |  |  |  |
|             | dc  | \$A3662D |  |  |  |  |  |
|             | dc  | \$A4E762 |  |  |  |  |  |
|             | dc  | \$84F0F3 |  |  |  |  |  |
|             | dc  | \$E6F1B0 |  |  |  |  |  |
|             | dc  | \$B3829  |  |  |  |  |  |
|             | dc  | \$8BF7AE |  |  |  |  |  |
|             | dc  | \$63A94F |  |  |  |  |  |
|             | dc  | \$EF78DC |  |  |  |  |  |
|             | dc  | \$242DE5 |  |  |  |  |  |
|             | dc  | \$A3E0BA |  |  |  |  |  |
|             | dc  | \$EBAB6B |  |  |  |  |  |
|             | dc  | \$8726C8 |  |  |  |  |  |
|             | dc  | \$CA361  |  |  |  |  |  |
|             | dc  | \$2F6E86 |  |  |  |  |  |
|             | dc  | \$A57347 |  |  |  |  |  |
|             | dc  | \$4BE774 |  |  |  |  |  |
|             | dc  | \$8F349D |  |  |  |  |  |
|             | dc  | \$A1ED12 |  |  |  |  |  |
|             | dc  | \$4BFCE3 |  |  |  |  |  |
|             | dc  | \$EA26E0 |  |  |  |  |  |
|             | dc  | \$CD7D99 |  |  |  |  |  |
|             | dc  | \$4BA85E |  |  |  |  |  |
|             | dc  | \$27A43F |  |  |  |  |  |
|             | dc  | \$A8B10C |  |  |  |  |  |
|             | dc  | \$D3A55  |  |  |  |  |  |
|             | dc  | \$25EC6A |  |  |  |  |  |
|             | dc  | \$2A255B |  |  |  |  |  |
|             | dc  | \$A5F1F8 |  |  |  |  |  |
|             | dc  | \$2426D1 |  |  |  |  |  |
|             | dc  | \$AE6536 |  |  |  |  |  |
|             | dc  | \$CBBC37 |  |  |  |  |  |
|             | dc  | \$6235A4 |  |  |  |  |  |
|             | dc  | \$37F0D  |  |  |  |  |  |
|             | dc  | \$63BEC2 |  |  |  |  |  |
|             | dc  | \$A5E4D3 |  |  |  |  |  |
|             | dc  | \$8CE810 |  |  |  |  |  |
|             | dc  | \$3FF09  |  |  |  |  |  |
|             | dc  | \$60E50E |  |  |  |  |  |
|             | dc  | \$CFFB2F |  |  |  |  |  |
|             | dc  | \$40753C |  |  |  |  |  |
|             | dc  | \$8262C5 |  |  |  |  |  |
|             | dc  | \$CA641A |  |  |  |  |  |
|             | dc  | \$EB3B4B |  |  |  |  |  |
|             | dc  | \$2DA928 |  |  |  |  |  |
|             | dc  | \$AB6641 |  |  |  |  |  |
|             | dc  | \$28A7E6 |  |  |  |  |  |
|             | dc  | \$4E2127 |  |  |  |  |  |
|             | dc  | \$482FD4 |  |  |  |  |  |
|             | dc  | \$7257D  |  |  |  |  |  |
|             | dc  | \$E53C72 |  |  |  |  |  |
|             | dc  | \$1A8C3  |  |  |  |  |  |
|             | dc  | \$E27540 |  |  |  |  |  |
| XDAT_EN     | ID  |          |  |  |  |  |  |
| IDIE (2015) |     |          |  |  |  |  |  |
| YDAT_ST     |     | 0        |  |  |  |  |  |
| ;           | org | y:0      |  |  |  |  |  |
|             | dc  | \$5B6DA  |  |  |  |  |  |
|             | dc  | \$C3F70B |  |  |  |  |  |

| dc | \$6A39E8             |
|----|----------------------|
| dc | \$81E801             |
| dc | \$C666A6             |
| dc | \$46F8E7             |
| dc | \$AAEC94             |
| dc | \$24233D             |
| dc | \$802732             |
| dc | \$2E3C83             |
| dc | \$A43E00             |
| dc | \$C2B639             |
| dc | \$85A47E             |
| dc | \$ABFDDF             |
| dc | \$F3A2C              |
| dc | \$2D7CF5             |
| dc | \$E16A8A             |
| dc | \$ECB8FB             |
| dc | \$4BED18             |
| dc | \$43F371             |
| dc | \$83A556             |
| dc | \$E1E9D7             |
| dc | \$ACA2C4             |
| dc | \$ACA2C4<br>\$8135AD |
| dc | \$2CE0E2             |
|    |                      |
| dc | \$8F2C73             |
| dc | \$432730             |
| dc | \$A87FA9             |
| dc | \$4A292E             |
| dc | \$A63CCF             |
| dc | \$6BA65C             |
| dc | \$E06D65             |
| dc | \$1AA3A              |
| dc | \$A1B6EB             |
| dc | \$48AC48             |
| dc | \$EF7AE1             |
| dc | \$6E3006             |
| dc | \$62F6C7             |
| dc | \$6064F4             |
| dc | \$87E41D             |
| dc | \$CB2692             |
| dc | \$2C3863             |
| dc | \$C6BC60             |
| dc | \$43A519             |
| dc | \$6139DE             |
| dc | \$ADF7BF             |
| dc | \$4B3E8C             |
| dc | \$6079D5             |
| dc | \$E0F5EA             |
| dc | \$8230DB             |
| dc | \$A3B778             |
| dc | \$2BFE51             |
| dc | \$E0A6B6             |
| dc | \$68FFB7             |
| dc | \$28F324             |
| dc | \$8F2E8D             |
| dc | \$667842             |
| dc | \$83E053             |
| dc | \$A1FD90             |
| dc | \$6B2689             |
| dc | \$85B68E             |

dc

\$622EAF

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```
dc
           $6162BC
     dс
           $E4A245
YDAT END
EQUATES for DSP56301 I/O registers and ports
     Reference: DSP56301 Specifications Revision 3.00
;
     Last update:
                 November 15 1993
;
       Changes:
                 GPIO for ports C,D and E,
                 HI32
                 DMA status reg
                     PLL control reg
                 AAR
                 SCI registers address
                 SSI registers addr. + split TSR from SSISR
     December 19 1993 (cosmetic - page and opt directives)
     August 9 1994 ESSI and SCI control registers bit update
;
page 132,55,0,0,0
     opt
           mex
ioequ ident 1,0
      EQUATES for I/O Port Programming
;------
      Register Addresses
M DATH EQU $FFFFCF; Host port GPIO data Register
M DIRH EQU $FFFFCE; Host port GPIO direction Register
M PCRC EQU $FFFFBF; Port C Control Register
M PRRC EQU $FFFFBE; Port C Direction Register
M PDRC EQU $FFFFBD ; Port C GPIO Data Register
M_PCRD EQU $FFFFAF ; Port D Control register
M_PRRD EQU $FFFFAE ; Port D Direction Data Register
M PDRD EQU $FFFFAD; Port D GPIO Data Register
M PCRE EQU $FFFF9F; Port E Control register
M PRRE EQU $FFFF9E; Port E Direction Register
M PDRE EQU $FFFF9D; Port E Data Register
M OGDB EQU $FFFFFC; OnCE GDB Register
;-----
    EOUATES for Host Interface
;-----
  Register Addresses
M DTXS EQU $FFFFCD; DSP SLAVE TRANSMIT DATA FIFO (DTXS)
M DTXM EQU $FFFFCC; DSP MASTER TRANSMIT DATA FIFO (DTXM)
M DRXR EQU $FFFFCB; DSP RECEIVE DATA FIFO (DRXR)
M DPSR EQU $FFFFCA; DSP PCI STATUS REGISTER (DPSR)
```

```
M DSR EQU $FFFFC9; DSP STATUS REGISTER (DSR)
M DPAR EQU $FFFFC8; DSP PCI ADDRESS REGISTER (DPAR)
M DPMC EQU $FFFFC7; DSP PCI MASTER CONTROL REGISTER (DPMC)
M DPCR EQU $FFFFC6; DSP PCI CONTROL REGISTER (DPCR)
M DCTR EQU $FFFFC5 ; DSP CONTROL REGISTER (DCTR)
        Host Control Register Bit Flags
M HCIE EOU 0 ; Host Command Interrupt Enable
M STIE EQU 1 ; Slave Transmit Interrupt Enable
M SRIE EQU 2 ; Slave Receive Interrupt Enable
M HF35 EQU $38 ; Host Flags 5-3 Mask
M HF3 EQU 3 ; Host Flag 3
             ; Host Flag 4
M HF4 EQU 4
M_HF5 EQU 5 ; Host Flag 5
M_HINT EQU 6 ; Host Interrupt A
M HDSM EQU 13 ; Host Data Strobe Mode
M HRWP EQU 14 ; Host RD/WR Polarity
M HTAP EQU 15 ; Host Transfer Acknowledge Polarity
M HDRP EQU 16 ; Host Dma Request Polarity
M HRSP EOU 17 ; Host Reset Polarity
M HIRP EQU 18 ; Host Interrupt Request Polarity
M HIRC EQU 19 ; Host Interupt Request Control
M HM0 EQU 20 ; Host Interface Mode
M HM1 EQU 21 ; Host Interface Mode
M HM2 EQU 22 ; Host Interface Mode
M HM EQU $700000 ; Host Interface Mode Mask
        Host PCI Control Register Bit Flags
M PMTIE EQU 1 ; PCI Master Transmit Interrupt Enable
M PMRIE EQU 2 ; PCI Master Receive Interrupt Enable
M PMAIE EQU 4 ; PCI Master Address Interrupt Enable
M PPEIE EQU 5 ; PCI Parity Error Interrupt Enable
M PTAIE EQU 7 ; PCI Transaction Abort Interrupt Enable
M PTTIE EQU 9 ; PCI Transaction Termination Interrupt Enable
M PTCIE EQU 12 ; PCI Transfer Complete Interrupt Enable
M CLRT EQU 14 ; Clear Transmitter
M_MTT EQU 15 ; Master Transfer Terminate
M SERF EQU 16 ; HSERR~ Force
M MACE EQU 18 ; Master Access Counter Enable
M MWSD EQU 19 ; Master Wait States Disable
M RBLE EQU 20 ; Receive Buffer Lock Enable
M IAE EQU 21 ; Insert Address Enable
        Host PCI Master Control Register Bit Flags
M ARH EQU $00ffff; DSP PCI Transaction Address (High)
M BL EQU $3f0000; PCI Data Burst Length
M FC EQU $c00000; Data Transfer Format Control
        Host PCI Address Register Bit Flags
M ARL EQU $00ffff; DSP PCI Transaction Address (Low)
M C EQU $0f0000; PCI Bus Command
M BE EQU $f00000; PCI Byte Enables
        DSP Status Register Bit Flags
M HCP EQU 0
            ; Host Command pending
```

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```
M_STRQ EQU 1 ; Slave Transmit Data Request
M SRRQ EQU 2 ; Slave Receive Data Request
M HF02 EOU $38; Host Flag 0-2 Mask
M HF0 EQU 3 ; Host Flag 0
M HF1 EQU 4
            ; Host Flag 1
           ; Host Flag 2
M HF2 EQU 5
       DSP PCI Status Register Bit Flags
M MWS EQU 0
            ; PCI Master Wait States
M MTRQ EQU 1 ; PCI Master Transmit Data Request
M MRRQ EQU 2 ; PCI Master Receive Data Request
M_MARQ EQU 4 ; PCI Master Address Request
             ; PCI Address Parity Error
M APER EQU 5
                ; PCI Data Parity Error
M DPER EOU 6
             ; PCI Master Abort
M MAB EQU 7
M_TDIS EQU 9 ; PCT Taget Abort ; PCT Taget Abort
M_TDIS EQU 9 ; PCI Target Disconnect
M_TRTY EQU 10 ; PCI Target Retry
M TO EQU 11
             ; PCI Time Out Termination
M RDC EQU $3F0000; Remaining Data Count Mask (RDC5-RDC0)
M RDC0 EQU 16 ; Remaining Data Count 0
             ; Remaining Data Count 1; Remaining Data Count 2; Remaining Data Count 3
M RDC1 EQU 17
M RDC2 EQU 18
M RDC3 EQU 19
              ; Remaining Data Count 4
M RDC4 EQU 20
              ; Remaining Data Count 5
M RDC5 EOU 21
              ; Hi32 Active
M HACT EQU 23
;------
       EQUATES for Serial Communications Interface (SCI)
;
;-----
       Register Addresses
M STXH EQU $FFFF97; SCI Transmit Data Register (high)
M STXM EQU $FFFF96; SCI Transmit Data Register (middle)
M STXL EQU $FFFF95; SCI Transmit Data Register (low)
M SRXH EQU $FFFF9A; SCI Receive Data Register (high)
M SRXM EQU $FFFF99; SCI Receive Data Register (middle)
M SRXL EQU $FFFF98; SCI Receive Data Register (low)
M STXA EQU $FFFF94; SCI Transmit Address Register
M SCR EQU $FFFF9C; SCI Control Register
M SSR EQU $FFFF93; SCI Status Register
M SCCR EQU $FFFF9B; SCI Clock Control Register
       SCI Control Register Bit Flags
               ; Word Select Mask (WDS0-WDS3)
M WDS EQU $7
               ; Word Select 0
M WDS0 EQU 0
M WDS1 EQU 1
               ; Word Select 1
               ; Word Select 2
M WDS2 EQU 2
M SSFTD EQU 3
                ; SCI Shift Direction
M SBK EOU 4
               ; Send Break
                ; Wakeup Mode Select
M WAKE EQU 5
              ; Receiver Wakeup Enable
M RWU EQU 6
M WOMS EQU 7
                ; Wired-OR Mode Select
```

```
M SCRE EQU 8
                ; SCI Receiver Enable
              ; SCI Transmitter Enable
M SCTE EQU 9
               ; Idle Line Interrupt Enable
M ILIE EOU 10
               ; SCI Receive Interrupt Enable
M SCRIE EOU 11
M SCTIE EQU 12
                ; SCI Transmit Interrupt Enable
M TMIE EQU 13 ; Timer Interrupt Enable
M TIR EQU 14 ; Timer Interrupt Rate
M SCKP EQU 15 ; SCI Clock Polarity
M REIE EQU 16 ; SCI Error Interrupt Enable (REIE)
       SCI Status Register Bit Flags
                ; Transmitter Empty
M TRNE EQU 0
               ; Transmit Data Register Empty
M TDRE EQU 1
               ; Receive Data Register Full
M RDRF EOU 2
               ; Idle Line Flag
M IDLE EQU 3
M OR EQU 4
            ; Overrun Error Flag
M PE EOU 5
             ; Parity Error
             ; Framing Error Flag
M FE EQU 6
M R8 EQU 7
              ; Received Bit 8 (R8) Address
       SCI Clock Control Register
M CD EQU $FFF
              ; Clock Divider Mask (CD0-CD11)
              ; Clock Out Divider
M COD EQU 12
               ; Clock Prescaler
M SCP EQU 13
             ; Receive Clock Mode Source Bit
M RCM EOU 14
              ; Transmit Clock Source Bit
M TCM EQU 15
;-----
      EQUATES for Synchronous Serial Interface (SSI)
;
       Register Addresses Of SSIO
M TX00 EQU $FFFFBC; SSI0 Transmit Data Register 0
M TX01 EQU $FFFFBB; SSIO Transmit Data Register 1
M TX02 EQU $FFFFBA; SSIO Transmit Data Register 2
M TSRO EQU $FFFFB9; SSIO Time Slot Register
M RX0 EQU $FFFFB8; SSI0 Receive Data Register
M SSISRO EQU $FFFFB7; SSIO Status Register
M CRBO EQU $FFFFB6; SSIO Control Register B
M CRAO EQU $FFFFB5; SSIO Control Register A
M TSMAO EQU $FFFFB4; SSIO Transmit Slot Mask Register A
M TSMB0 EQU $FFFFB3; SSI0 Transmit Slot Mask Register B
M RSMAO EQU $FFFFB2; SSIO Receive Slot Mask Register A
M RSMBO EQU $FFFFB1; SSIO Receive Slot Mask Register B
       Register Addresses Of SSI1
M TX10 EQU $FFFFAC; SSI1 Transmit Data Register 0
M_TX11 EQU $FFFFAB; SSI1 Transmit Data Register 1
M TX12 EQU $FFFFAA; SSI1 Transmit Data Register 2
M TSR1 EQU $FFFFA9; SSI1 Time Slot Register
M RX1 EQU $FFFFA8; SSI1 Receive Data Register
M SSISR1 EQU $FFFFA7; SSI1 Status Register
M CRB1 EQU $FFFFA6; SSI1 Control Register B
M CRA1 EQU $FFFFA5; SSI1 Control Register A
M TSMA1 EQU $FFFFA4; SSI1 Transmit Slot Mask Register A
```

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```
M TSMB1 EQU $FFFFA3; SSI1 Transmit Slot Mask Register B
M RSMA1 EQU $FFFFA2; SSI1 Receive Slot Mask Register A
M RSMB1 EQU $FFFFA1; SSI1 Receive Slot Mask Register B
        SSI Control Register A Bit Flags
               ; Prescale Modulus Select Mask (PMO-PM7)
M PM EQU $FF
M PSR EQU 11
               ; Prescaler Range
M DC EQU $1F000 ; Frame Rate Divider Control Mask (DC0-DC7)
M ALC EQU 18 ; Alignment Control (ALC)
M WL EQU $380000; Word Length Control Mask (WLO-WL7)
M SSC1 EQU 22 ; Select SC1 as TR #0 drive enable (SSC1)
        SSI Control Register B Bit Flags
M OF EQU $3
              ; Serial Output Flag Mask
M OFO EQU 0
             ; Serial Output Flag 0
M_OF1 EQU 1 ; Serial Output Flag 1
M SCD EQU $1C ; Serial Control Direction Mask
M SCD0 EQU 2 ; Serial Control 0 Direction
M\_SCD1 EQU 3 ; Serial Control 1 Direction M\_SCD2 EQU 4 ; Serial Control 2 Direction
M FSL EQU $180; Frame Sync Length Mask (FSL0-FSL1)
M FSL0 EQU 7 ; Frame Sync Length 0
M_FSL1 EQU 8 ; Frame Sync Length 1
{\tt M\_FSR} EQU 9 ; Frame Sync Relative Timing
M FSP EQU 10 ; Frame Sync Polarity
M_CKP EQU 11 ; Clock Polarity
M SYN EQU 12 ; Sync/Async Control
M MOD EQU 13 ; SSI Mode Select
M SSTE EOU $1C000; SSI Transmit enable Mask
M SSTE2 EQU 14; SSI Transmit #2 Enable
M SSTE1 EQU 15 ; SSI Transmit #1 Enable
M SSTE0 EQU 16; SSI Transmit #0 Enable
M SSRE EQU 17 ; SSI Receive Enable
M SSTIE EQU 18; SSI Transmit Interrupt Enable
M SSRIE EQU 19; SSI Receive Interrupt Enable
M STLIE EQU 20; SSI Transmit Last Slot Interrupt Enable
M SRLIE EQU 21; SSI Receive Last Slot Interrupt Enable
M STEIE EQU 22; SSI Transmit Error Interrupt Enable
M SREIE EQU 23 ; SSI Receive Error Interrupt Enable
        SSI Status Register Bit Flags
M IF EQU $3
               ; Serial Input Flag Mask
              ; Serial Input Flag 0
M IFO EQU O
               ; Serial Input Flag 1
M IF1 EQU 1
               ; Transmit Frame Sync Flaq
M TFS EOU 2
               ; Receive Frame Sync Flag
M RFS EQU 3
               ; Transmitter Underrun Error FLag
M TUE EQU 4
M ROE EQU 5
               ; Receiver Overrun Error Flag
M TDE EQU 6
               ; Transmit Data Register Empty
M RDF EQU 7
                ; Receive Data Register Full
        SSI Transmit Slot Mask Register A
M SSTSA EQU $FFFF ; SSI Transmit Slot Bits Mask A (TSO-TS15)
```

```
SSI Transmit Slot Mask Register B
;
M SSTSB EQU $FFFF ; SSI Transmit Slot Bits Mask B (TS16-TS31)
        SSI Receive Slot Mask Register A
M SSRSA EQU $FFFF ; SSI Receive Slot Bits Mask A (RSO-RS15)
        SSI Receive Slot Mask Register B
M SSRSB EQU $FFFF ; SSI Receive Slot Bits Mask B (RS16-RS31)
        EQUATES for Exception Processing
        Register Addresses
M IPRC EQU $FFFFFF; Interrupt Priority Register Core
M IPRP EQU $FFFFFE; Interrupt Priority Register Peripheral
        Interrupt Priority Register Core (IPRC)
M IAL EQU $7
                ; IRQA Mode Mask
                ; IRQA Mode Interrupt Priority Level (low)
M IALO EQU 0
                ; IRQA Mode Interrupt Priority Level (high)
M IAL1 EQU 1
M IAL2 EOU 2
                ; IRQA Mode Trigger Mode
M IBL EQU $38 ; IRQB Mode Mask
                 ; IRQB Mode Interrupt Priority Level (low)
M IBLO EQU 3
                ; IRQB Mode Interrupt Priority Level (high)
M IBL1 EQU 4
                 ; IRQB Mode Trigger Mode
M IBL2 EQU 5
M_ICL EQU $1C0 ; IRQC Mode Mask
               ; IRQC Mode Interrupt Priority Level (low)
M ICLO EOU 6
                ; IRQC Mode Interrupt Priority Level (high)
M ICL1 EQU 7
M ICL2 EQU 8
                ; IRQC Mode Trigger Mode
M IDL EQU $E00 ; IRQD Mode Mask
                ; IRQD Mode Interrupt Priority Level (low)
M IDLO EQU 9
M IDL1 EQU 10 ; IRQD Mode Interrupt Priority Level (high)
M IDL2 EQU 11 ; IRQD Mode Trigger Mode
M DOL EQU $3000 ; DMAO Interrupt priority Level Mask
              ; DMAO Interrupt Priority Level (low)
M DOLO EQU 12
M DOL1 EQU 13
                 ; DMA0 Interrupt Priority Level (high)
M D1L EQU $C000 ; DMA1 Interrupt Priority Level Mask
               ; DMA1 Interrupt Priority Level (low)
; DMA1 Interrupt Priority Level (high)
M D1L0 EQU 14
M D1L1 EOU 15
M D2L EQU $30000 ; DMA2 Interrupt priority Level Mask
\label{eq:md2} \mbox{M\_D2L0 EQU 16} \qquad \mbox{; DMA2 Interrupt Priority Level (low)}
M D2L1 EQU 17
                ; DMA2 Interrupt Priority Level (high)
M D3L EQU $C0000; DMA3 Interrupt Priority Level Mask
               ; DMA3 Interrupt Priority Level (low)
M D3L0 EQU 18
M D3L1 EOU 19
                 ; DMA3 Interrupt Priority Level (high)
M D4L EQU $300000; DMA4 Interrupt priority Level Mask
M D4L0 EQU 20 ; DMA4 Interrupt Priority Level (low)
M D4L1 EQU 21
                 ; DMA4 Interrupt Priority Level (high)
```

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```
M D5L EQU $C00000; DMA5 Interrupt priority Level Mask
M D5L0 EQU 22 ; DMA5 Interrupt Priority Level (low)
M D5L1 EOU 23
               ; DMA5 Interrupt Priority Level (high)
       Interrupt Priority Register Peripheral (IPRP)
M HPL EQU $3
              ; Host Interrupt Priority Level Mask
               ; Host Interrupt Priority Level (low)
M HPLO EOU 0
M HPL1 EQU 1
               ; Host Interrupt Priority Level (high)
              ; SSIO Interrupt Priority Level Mask
M SOL EQU $C
              ; SSIO Interrupt Priority Level (low)
M SOLO EQU 2
               ; SSIO Interrupt Priority Level (high)
M SOL1 EQU 3
M_S1L EQU $30 ; SSI1 Interrupt Priority Level Mask
M_S1L0 EQU 4 ; SSI1 Interrupt Priority Level (low)
               ; SSI1 Interrupt Priority Level (high)
M S1L1 EQU 5
M SCL EQU $CO ; SCI Interrupt Priority Level Mask
M_SCL0 EQU 6 ; SCI Interrupt Priority Level (low)
M_SCL1 EQU 7 ; SCI Interrupt Priority Level (high)
M TOL EQU $300 ; TIMER Interrupt Priority Level Mask
               ; TIMER Interrupt Priority Level (low)
M TOLO EOU 8
M TOL1 EQU 9
               ; TIMER Interrupt Priority Level (high)
;-----
       EQUATES for TIMER
;-----
       Register Addresses Of TIMERO
M TCSR0 EQU $FFFF8F; TIMER0 Control/Status Register
M TLRO EQU $FFFF8E; TIMERO Load Reg
M_TCPR0 EQU $FFFF8D; TIMER0 Compare Register
M TCRO EQU $FFFF8C; TIMERO Count Register
       Register Addresses Of TIMER1
M TCSR1 EQU $FFFF8B; TIMER1 Control/Status Register
M TLR1 EQU $FFFF8A; TIMER1 Load Req
M TCPR1 EQU $FFFF89; TIMER1 Compare Register
M TCR1 EQU $FFFF88; TIMER1 Count Register
       Register Addresses Of TIMER2
M TCSR2 EQU $FFFF87; TIMER2 Control/Status Register
M TLR2 EQU $FFFF8; TIMER2 Load Req
M TCPR2 EQU $FFFF85; TIMER2 Compare Register
M TCR2 EQU $FFFF84 ; TIMER2 Count Register
M TPLR EQU $FFFF83; TIMER Prescaler Load Register
M TPCR EQU $FFFF82; TIMER Prescalar Count Register
       Timer Control/Status Register Bit Flags
              ; Timer Enable
M TE EQU 0
              ; Timer Overflow Interrupt Enable
M TOIE EQU 1
                ; Timer Compare Interrupt Enable
M TCIE EQU 2
```

```
; Timer Control Mask (TC0-TC3)
M TC EQU $F0
; Timer Restart Mode
M_DIR EQU 11 ; Direction Bit
M_DI EQU 12 ; Data Input
M_DO EQU 13 ; Data Output
M PCE EQU 15 ; Prescaled Clock Enable
{\tt M\_TOF} EQU 20 ; Timer Overflow Flag
M TCF EQU 21
              ; Timer Compare Flag
       Timer Prescaler Register Bit Flags
M PS EQU $600000 ; Prescaler Source Mask
M PS0 EQU 21
M PS1 EQU 22
      Timer Control Bits
M_TC0 EQU 4 ; Timer Control 0
M_TC1 EQU 5 ; Timer Control 1
M_TC2 EQU 6 ; Timer Control 2
M_TC3 EQU 7 ; Timer Control 3
;-----
;
       EQUATES for Direct Memory Access (DMA)
       Register Addresses Of DMA
M DSTR EQU $FFFFF4; DMA Status Register
M DORO EQU $FFFFF3; DMA Offset Register 0
M DOR1 EQU $FFFFF2; DMA Offset Register 1
M DOR2 EQU $FFFFF1; DMA Offset Register 2
M DOR3 EQU $FFFFF0; DMA Offset Register 3
       Register Addresses Of DMA0
M DSR0 EQU $FFFFEF; DMA0 Source Address Register
M DDR0 EQU $FFFFEE; DMA0 Destination Address Register
M DCOO EQU $FFFFED; DMAO Counter
M DCR0 EQU $FFFFEC; DMA0 Control Register
       Register Addresses Of DMA1
M DSR1 EQU $FFFFEB; DMA1 Source Address Register
M DDR1 EQU $FFFFEA; DMA1 Destination Address Register
M DCO1 EQU $FFFFE9; DMA1 Counter
M DCR1 EQU $FFFFE8; DMA1 Control Register
       Register Addresses Of DMA2
M DSR2 EQU $FFFFE7; DMA2 Source Address Register
M DDR2 EQU $FFFFE6; DMA2 Destination Address Register
M DCO2 EQU $FFFFE5; DMA2 Counter
M DCR2 EQU $FFFFE4; DMA2 Control Register
       Register Addresses Of DMA4
```

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```
M DSR3 EQU $FFFFE3; DMA3 Source Address Register
M DDR3 EQU $FFFFE2; DMA3 Destination Address Register
M DCO3 EQU $FFFFE1; DMA3 Counter
M DCR3 EQU $FFFFE0; DMA3 Control Register
        Register Addresses Of DMA4
M DSR4 EQU $FFFFDF; DMA4 Source Address Register
M DDR4 EQU $FFFFDE; DMA4 Destination Address Register
M DCO4 EQU $FFFFDD; DMA4 Counter
M DCR4 EQU $FFFFDC; DMA4 Control Register
        Register Addresses Of DMA5
M DSR5 EQU $FFFFDB; DMA5 Source Address Register
M DDR5 EQU $FFFFDA; DMA5 Destination Address Register
M DCO5 EQU $FFFFD9; DMA5 Counter
M DCR5 EQU $FFFFD8; DMA5 Control Register
       DMA Control Register
M DSS EQU $3 ; DMA Source Space Mask (DSS0-Dss1)
M DSS0 EQU 0 ; DMA Source Memory space 0
M DSS1 EQU 1 ; DMA Source Memory space 1
M_DDS EQU $C ; DMA Destination Space Mask (DDS-DDS1)
M_DDS0 EQU 2 ; DMA Destination Memory Space 0 M_DDS1 EQU 3 ; DMA Destination Memory Space 1
M DAM EQU $3F0; DMA Address Mode Mask (DAM5-DAM0)
M_DAMO EQU 4 ; DMA Address Mode 0
M DAM1 EQU 5 ; DMA Address Mode 1
M DAM2 EQU 6 ; DMA Address Mode 2
M DAM3 EOU 7 ; DMA Address Mode 3
M DAM4 EQU 8 ; DMA Address Mode 4
M DAM5 EQU 9 ; DMA Address Mode 5
M D3D EQU 10 ; DMA Three Dimensional Mode
M DRS EQU $F800; DMA Request Source Mask (DRS0-DRS4)
M DCON EQU 16 ; DMA Continuous Mode
M DPR EOU $60000; DMA Channel Priority
M DPR0 EQU 17 ; DMA Channel Priority Level (low)
M DPR1 EQU 18 ; DMA Channel Priority Level (high)
M DTM EQU $380000; DMA Transfer Mode Mask (DTM2-DTM0)
M DTMO EQU 19 ; DMA Transfer Mode 0
M DTM1 EQU 20 ; DMA Transfer Mode 1
M DTM2 EQU 21 ; DMA Transfer Mode 2
M DIE EQU 22 ; DMA Interrupt Enable bit
              ; DMA Channel Enable bit
M DE EQU 23
        DMA Status Register
M DTD EQU $3F ; Channel Transfer Done Status MASK (DTD0-DTD5)
{	t M\_DTD0} EQU 0 ; DMA Channel Transfer Done Status 0
M DTD1 EQU 1
                 ; DMA Channel Transfer Done Status 1
M DTD2 EQU 2
                ; DMA Channel Transfer Done Status 2
M DTD3 EQU 3
                ; DMA Channel Transfer Done Status 3
                ; DMA Channel Transfer Done Status 4
M DTD4 EQU 4
                 ; DMA Channel Transfer Done Status 5
M DTD5 EQU 5
M DACT EQU 8 ; DMA Active State
M DCH EQU $E00; DMA Active Channel Mask (DCH0-DCH2)
M DCHO EQU 9 ; DMA Active Channel 0
```

```
M DCH1 EQU 10 ; DMA Active Channel 1
M DCH2 EQU 11 ; DMA Active Channel 2
;-----
      EQUATES for Phase Lock Loop (PLL)
;------
      Register Addresses Of PLL
M PCTL EQU $FFFFFD; PLL Control Register
      PLL Control Register
M MF EQU $FFF ; Multiplication Factor Bits Mask (MF0-MF11)
M_DF EQU $7000 ; Division Factor Bits Mask (DF0-DF2)
M\_XTLR EQU 15 ; XTAL Range select bit
M XTLD EQU 16 ; XTAL Disable Bit
M PSTP EQU 17 ; STOP Processing State Bit
M PEN EQU 18
             ; PLL Enable Bit
M PCOD EQU 19 ; PLL Clock Output Disable Bit
M PD EQU $F00000; PreDivider Factor Bits Mask (PD0-PD3)
;-----
      EQUATES for BIU
;-----
      Register Addresses Of BIU
M BCR EQU $FFFFFB; Bus Control Register
M DCR EQU $FFFFFA; DRAM Control Register
M AARO EQU $FFFFF9; Address Attribute Register 0
M AAR1 EQU $FFFFF8; Address Attribute Register 1
M AAR2 EQU $FFFFF7; Address Attribute Register 2
M AAR3 EQU $FFFFF6; Address Attribute Register 3
M IDR EQU $FFFFF5; ID Register
      Bus Control Register
M BAOW EQU $1F ; Area 0 Wait Control Mask (BAOW0-BAOW4)
M BA1W EQU $3E0 ; Area 1 Wait Control Mask (BA1W0-BA14)
M BA2W EQU $1C00 ; Area 2 Wait Control Mask (BA2W0-BA2W2)
M BA3W EQU $E000 ; Area 3 Wait Control Mask (BA3W0-BA3W3)
M BDFW EQU $1F0000; Default Area Wait Control Mask (BDFW0-BDFW4)
M_BBS EQU 21 ; Bus State
             ; Bus Lock Hold
M BLH EQU 22
M BRH EQU 23 ; Bus Request Hold
      DRAM Control Register
             ; In Page Wait States Bits Mask (BCW0-BCW1)
M BCW EOU $3
M BRW EQU $C
              ; Out Of Page Wait States Bits Mask (BRW0-BRW1)
M_BPS EQU $300 ; DRAM Page Size Bits Mask (BPS0-BPS1)
M BPLE EQU 11
              ; Page Logic Enable
```

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```
M BME EQU 12
               ; Mastership Enable
              ; Refresh Enable
; Software Triggered Refresh
M BRE EQU 13
M BSTR EOU 14
M BRF EQU $7F8000; Refresh Rate Bits Mask (BRF0-BRF7)
                ; Refresh prescaler
M BRP EQU 23
       Address Attribute Registers
M BAT EOU $3
                ; External Access Type and Pin Definition Bits Mask (BATO-BAT1)
M BAAP EOU 2
                ; Address Attribute Pin Polarity
M BPEN EQU 3
                 ; Program Space Enable
                ; X Data Space Enable
M BXEN EOU 4
                ; Y Data Space Enable
M BYEN EQU 5
M BAM EQU 6
                ; Address Muxing
M_BPAC EQU 7 ; Packing Enable
M BNC EQU $F00 ; Number of Address Bits to Compare Mask (BNC0-BNC3)
M BAC EQU $FFF000; Address to Compare Bits Mask (BAC0-BAC11)
       control and status bits in SR
M CP EQU $c00000 ; mask for CORE-DMA priority bits in SR
               ; Carry
M CA EQU 0
M V EQU 1
               ; Overflow
              ; Zero
M Z EQU 2
             ; Negative
M N EQU 3
             ; Unnormalized
M U EQU 4
             ; Extension
M E EOU 5
             ; Limit
M L EQU 6
             ; Scaling Bit
M S EQU 7
              ; Interupt Mask Bit 0
M IO EQU 8
               ; Interupt Mask Bit 1
M I1 EQU 9
M SO EQU 10
               ; Scaling Mode Bit 0
               ; Scaling Mode Bit 1
M S1 EOU 11
M SC EQU 13
               ; Sixteen Bit Compatibility
M DM EQU 14
                ; Double Precision Multiply
               ; DO-Loop Flag
M LF EQU 15
               ; DO-Forever Flag
M FV EQU 16
               ; Sixteen-Bit Arithmetic
M SA EQU 17
               ; Instruction Cache Enable
M CE EOU 19
               ; Arithmetic Saturation
M SM EQU 20
M RM EQU 21
               ; Rounding Mode
M CP0 EQU22
               ; bit 0 of priority bits in SR
                ; bit 1 of priority bits in SR
M CP1 EQU 23
       control and status bits in OMR
M CDP EQU$300 ; mask for CORE-DMA priority bits in OMR
                ; Operating Mode A
M MA EQU 0
                ; Operating Mode B
M MB EQU 1
               ; Operating Mode C
M MC EQU 2
               ; Operating Mode D
M MD EQU 3
M EBD EOU 4
                ; External Bus Disable bit in OMR
               ; Stop Delay
M SD EQU 6
               ; bit 0 of priority bits in OMR
M CDP0 EQU 8
M CDP1 EQU 9
                 ; bit 1 of priority bits in OMR
M BEN EQU 10
                ; Burst Enable
                ; TA Synchronize Select
M TAS EQU 11
M BRT EOU 12
                ; Bus Release Timing
                ; Stack Extension space select bit in OMR.
M XYS EQU 16
             ; Extensed stack UNderflow flag in OMR.
M EUN EQU 17
M EOV EQU 18
                 ; Extended stack OVerflow flag in OMR.
```

```
M WRP EQU 19
            ; Extended WRaP flag in OMR.
M SEN EOU 20
           ; Stack Extension Enable bit in OMR.
;***********************************
    EQUATES for DSP56301 interrupts
    Reference: DSP56301 Specifications Revision 3.00
    Last update: November 15 1993 (Debug request & HI32 interrupts)
            December 19 1993 (cosmetic - page and opt directives)
          August 16 1994 (change interrupt addresses to be
;
               relative to I VEC)
page
         132,55,0,0,0
     opt
          mex
intequ ident 1,0
     if
        @DEF(I VEC)
     ; leave user definition as is.
I VEC equ
          $0
     endif
; Non-Maskable interrupts
;-----
I RESET EQU I VEC+$00 ; Hardware RESET
I STACK EQU I_VEC+$02 ; Stack Error
I ILL EQU I VEC+$04 ; Illegal Instruction
I DBG EQU I VEC+$06 ; Debug Request
I TRAP EQU I VEC+$08 ; Trap
I NMI EQU I VEC+$0A ; Non Maskable Interrupt
;-----
; Interrupt Request Pins
;------
I_IRQA EQU I_VEC+$10 ; IRQA
I_IRQB EQU I_VEC+$12 ; IRQB
I_IRQC EQU I_VEC+$14 ; IRQC
I IRQD EQU I VEC+$16 ; IRQD
;-----
; DMA Interrupts
;-----
I DMA0 EQU I VEC+$18 ; DMA Channel 0
I_DMA1 EQU I_VEC+$1A ; DMA Channel 1
I_DMA2 EQU I_VEC+$1C ; DMA Channel 2
I_DMA3 EQU I_VEC+$1E ; DMA Channel 3
I DMA4
     EQU I_VEC+$20 ; DMA Channel 4
I DMA5
     EQU I VEC+$22 ; DMA Channel 5
;------
; Timer Interrupts
;-----
I TIMOC EQU I VEC+$24 ; TIMER 0 compare
I TIMOOF EQU I VEC+$26 ; TIMER 0 overflow
```

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```
I TIM1C EQU I VEC+$28
                   ; TIMER 1 compare
\label{eq:continuous_section} \mbox{I\_TIM1OF EQU} \quad \mbox{I\_VEC+$2A} \quad \  ; \ \mbox{TIMER 1 overflow}
\label{eq:compare} \mbox{I\_TIM2C} \ \ \mbox{EQU} \ \ \mbox{I\_VEC+$2C} \ \ ; \ \mbox{TIMER} \ \mbox{2 compare}
I TIM2OF EQU I VEC+$2E ; TIMER 2 overflow
;-----
; ESSI Interrupts
;-----
I SIORD EQU I VEC+$30 ; ESSIO Receive Data
I SIORDE EQU I VEC+$32 ; ESSIO Receive Data With Exception Status
I SIORLS EQU I VEC+$34 ; ESSIO Receive last slot
I SIOTD EQU I VEC+$36 ; ESSIO Transmit data
I_SIOTDE EQU I_VEC+$38 ; ESSIO Transmit Data With Exception Status
I_SIOTLS EQU I_VEC+$3A ; ESSIO Transmit last slot
<code>I_SI1RD</code> EQU <code>I_VEC+$40</code> ; ESSI1 Receive Data
I_SI1RDE EQU I_VEC+$42 ; ESSI1 Receive Data With Exception Status
<code>I_SI1RLS EQU I_VEC+$44</code> ; <code>ESSI1 Receive last slot</code>
I_SI1TD EQU I_VEC+$46 ; ESSI1 Transmit data
<code>I_SI1TDE EQU I_VEC+$48</code> ; <code>ESSI1 Transmit Data With Exception Status</code>
I SI1TLS EQU I VEC+$4A ; ESSI1 Transmit last slot
;-----
; SCI Interrupts
;-----
I SCIRD EQU I VEC+$50 ; SCI Receive Data
I_SCIRDE EQU I_VEC+$52 ; SCI Receive Data With Exception Status
I_SCITD EQU I_VEC+$54 ; SCI Transmit Data
I_SCIIL EQU I_VEC+$56 ; SCI Idle Line
I SCITM EQU I VEC+$58 ; SCI Timer
;-----
; HOST Interrupts
:-----
I HPTT EQU I VEC+$60 ; Host PCI Transaction Termination
I HPTA EQU I VEC+$62 ; Host PCI Transaction Abort
I HPPE EQU I VEC+$64 ; Host PCI Parity Error
I_HPTC EQU I_VEC+$66 ; Host PCI Transfer Complete
I_HPMR      EQU      I_VEC+$68      ; Host PCI Master Receive
      EQU I_VEC+$6A ; Host Slave Receive
I HSR
I_HPMT EQU I_VEC+$6C ; Host PCI Master Transmit
I HPMA EQU I_VEC+$70 ; Host PCI Master Address
I HCNMI EQU I VEC+$72 ; Host Command/Host NMI (Default)
;-----
: INTERRUPT ENDING ADDRESS
;-----
I_INTEND EQU I_VEC+$FF ; last address of interrupt vector space
```

# **Ordering Information**

Consult a Freescale Semiconductor sales office or authorized distributor to determine product availability and place an order.

| Part           | Supply<br>Voltage          | Package Type                   | Pin<br>Count | Core<br>Frequency<br>(MHz) | Solder Spheres | Order Number  |
|----------------|----------------------------|--------------------------------|--------------|----------------------------|----------------|---------------|
| DSP56301 3.3 V | Thin Quad Flat Pack (TQFP) | 208                            | 80           | Lead-free                  | DSP56301AG80   |               |
|                |                            |                                |              | Lead-bearing               | DSP56301PW80   |               |
|                |                            |                                | 100          | Lead-free                  | DSP56301AG100  |               |
|                |                            |                                |              | Lead-bearing               | DSP56301PW100  |               |
|                |                            | Molded Array Process-Ball Grid | 252          | 80                         | Lead-free      | DSP56301VL80  |
|                | Array (MAP-BGA)            |                                |              | Lead-bearing               | DSP56301VF80   |               |
|                |                            |                                | 100          | Lead-free                  | DSP56301VL100  |               |
|                |                            |                                |              |                            | Lead-bearing   | DSP56301VF100 |

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